



Product Change Notification / LIAL-14RZLJ133

Date:

18-Jan-2021

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) and Mixed Signal and ASIC(MSA) products

Notification Text:

PCN Status: Final notification.

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

Note 1: For your convenience Microchip includes identical files in two formats (.pdf and .xls). Note 2: As part of the integration process additional products may be identified that were not part of the original list

Description of Change:

Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) and Mixed Signal and ASIC(MSA) products.

Pre Change: Using Microsemi's packing process

Post Change: Using Microchip's packing process

Pre and Post Change Summary: NOTE: See attached Packing Pre and Post Changes for the changes of the following.

Details	PRE CHANGE (MSCC)	POST CHANGE (Microchip)
Part aging Policy /Recertification Program	Refer to Pre and Post Change summary for complete details	
Combination rules	• 1 Date code • 1 Country of Origin	Commercial products: For FPGA:

		• <u>No change on combination rule.</u> For MSA: • <u>1 Device</u> • <u>3 Date codes</u> • <u>No limit to number of production lots follow date code combination rule.</u> • <u>1 Assembly Site</u> • <u>1 Test Site</u> • <u>1 Mask Revision</u>
Reel/Bag/Inner/Outer Carton Label	Microsemi Branded labels	Microchip Branded labels
Packing Material	Refer to Pre and Post Change summary for complete details	
Packing Method	Refer to Pre and Post Change summary for complete details	
CoC document	Microsemi format with Microsemi logo	Microchip format with Microchip logo

Impacts to Data Sheet:None

Change Impact:None

Reason for Change:To improve productivity by standardizing the packing method as part of the integration of Microsemi and Microchip.

Change Implementation Status:In Progress

Estimated Implementation Date: February 15, 2021 (date code: 2108)

Note: The earliest implementation date is the earliest date that we may implement any combination of the changes listed in this PCN as we will not implement any of the proposed changes prior to this date. After the earliest implementation date these changes may occur to any product over the course of many months depending on inventory levels and business conditions.

Time Table Summary:

	January 2021					February 2021				
Workweek	01	02	03	04	05	06	07	08	09	
Final PCN Issue Date			X							
Estimated Implementation Date			X					X		

Method to Identify Change:Traceability, label, inner and outer boxes

Contact Microchip:You may contact your local [Microchip Sales and Distribution](#).Contact information is also provided on the attached Frequently Asked Questions (FAQ).

If applicable, please also copy your local Microchip field sales and/or field quality representative.

Revision History:January 18, 2021: Issued final notification. Provided estimated first ship date to be on February 15, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

[PCN_LIAL-14RZLJ133_Affected CPN_FPGA Products.pdf](#)
[PCN_LIAL-14RZLJ133_Affected CPN_FPGA Products.xlsx](#)
[PCN_LIAL-14RZLJ133_Affected CPN_MSA Products.pdf](#)
[PCN_LIAL-14RZLJ133_Affected CPN_MSA Products.xlsx](#)
[Frequently Asked Questions Microsemi_FAQ.pdf](#)
[PCN_LIAL-14RZLJ133_Pre and Post Change Summary.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

PCN_LIAL-14RZLJ133
CATALOG_PART_NBR
FPGA_Products
M2S060TS-FGG676IH0274
EX64-TQG64Q310
M2S010-VFG256X486
M2S010-1FGG484
M2S050TS-1FG484M
M2S060TS-FGG484IH0032
M2S050TS-1FCSG325
M2S150TS-1FC1152I
M7A3P1000-FG484I
M2S010-TQG144X416
M2S025-VFG256Q307
M2S010TS-VFG400H0216
M2S150TS-1FCG1152H0084
M2S025-1FGG484I
M2S050-1VFG400I
M2S090T-1FG484M
M2S090T-1FGG676X416
MPF300TS-FCV484M
MPF200T-1FCG784I
M2S025TS-1FG484M
M2S150T-FC1152
M2S150-1FC1152I
M2S010-1VF400
M2S010TS-VFG400H0117
M2S010TS-VFG256H0168
M7AFS600-1FGG256
M2S010S-TQG144I
M2S050T-FCSG325
M2S060TS-VFG400IH0204
M2S025T-VF400
M2S010-FGG484I
M2S090TS-FGG676IH0279
M2S025TS-VFG256H0293
M2S010TS-VFG256IH0292
M2S090T-1FGG676S0028
AFS600-FGG484IX94
A1020B-2PL84CX3AV
A1010B-PLG68CX3AV
A1020B-PL84IX3AV
MPF300T-FCG784I
M2S150-FCG1152
M2S090TS-FCS325
M2S010TS-VFG256H0146
M2S010TS-VFG256H0082

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M2S060T-FG484I
M2S060T-FGG484
MPF300TS-FCVG484I
MPFS250TS-1FCG1152I
M2S025TS-1VFG400
M2S010TS-VFG256H0131
M2S010-1VFG256
M2S090-FG676X416
M2S060TS-FGG676IH0238
P1AFS1500-2FGG256
M2S060-1FGG484I
M2S090TS-FGG484I
M2S050TS-1FG896
M2S090T-1FGG484M
M2S010TS-VFG400S0009
M2S060TS-FGG484H0125
M2S050T-1FCS325
MPF300T-1FCG784I
M2S090TS-FCSG325IX418
MPF100T-FCG484I
M2S090TS-FGG484IX418
M2S025TS-VFG256H0056
M2S060T-VFG400I
M7AFS600-2FG256I
M2S150-FCG1152I
M2S010TS-VFG256H0022
M7A3P1000-1FG484
M2S025T-1FGG484M
M2S050T-1FGG896
M2S025-VFG256Q309
MPF300T-FCG784NI
MPF300T-FCSG536E
M2S150TS-FC1152X416
M2S025TS-FGG484H0066
M2S150TS-FCV484
MPF300XT-FCG1152I
M2S025TS-VFG400IH0147
M2S025-FCS325
M2S025-1VFG400I
MPF200T-FCVG484T2
M2S090T-1FCSG325I
M2S150TS-1FCG1152M
M2S050-FCSG325
M2S090T-1FGG676S0016
M2S060TS-FGG676H0171
M2S090T-FGG676X416
M2S090T-FG676I

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M2S090T-1FGG484MX399
M2S060TS-FGG676IH0272
M2S090TS-1FG484IX416
M7AFS600-FGG484
M2S050TS-FCS325
MPF300T-1FCSG536E
M2S090T-FGG484IX417
MPFS250TL-FCVG784I
M2S150T-1FC1152I
M2S060T-1FCS325
M2S150TS-1FCVG484I
M2S150T-1FC1152M
M2S010-VF256I
M2S050T-1FGG484I
M2S010TS-1FGG484
M2S060TS-FGG676IH0179
M7A3P1000-PQG208
M2S025TS-1FCSG325I
M2S150TS-1FCG1152X416
MPF300TS-1FCG784NI
M2S010TS-VFG256H0159
M2S010-1VF400I
MPFS250T-FCVG484EENG
MPF300XT-FCG784I
M2S150TS-1FCG1152X417
M2S010-FGG484IX416
M2S025T-VF400I
M2S010TS-VFG256H0052
M2S010TS-1VF400
M2S060T-FG676I
M2S150-1FCS536I
M2S090T-FGG484I
M7AFS600-2FGG484
M2S010T-1FGG484
M2S090TS-1FCSG325IX418
M2S060TS-1FGG484T2
M2S010-1VFG400IZ227
M7A3P1000-1FG256
M2S090TS-FGG676IH0258
MPF300TL-FCG484I
M2S060TS-FGG676IH0085
MPFS250T-FCVG784E
MPF200T-FCSG536I
M2S060TS-FGG676H0192
MPF200T-1FCVG484E
M2S025TS-FGG484H0249
M2S010T-1FGG484I

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M2S150-FCSG536I
M2S060T-1VFG400I
M2S050-FCS325I
M2S090-FG484X456
M2S060T-FGG484X486
M2S025TS-1FGG484I
M2S010-FGG484IX414
M2S010S-1TQG144
M2S050T-1FCSG325
M2S090-FCS325
M2S010T-1FG484M
MPF300TL-FCVG484I
M2S060TS-1VFG400I
M2S025-1VF400I
M2S025TS-1VFG400T2
M2S010-VFG400IX416
M2S150T-1FCG1152IX417
M2S090-1FG484
M2S150-1FCG1152I
M7AFS600-FG256
MPF100T-1FCG484T2
M2S090-FCS325I
M2S060TS-FGG484IX486
M2S150TS-1FCG1152H0195
M2S090-FGG484X417
M2S060TS-1FG484
M2S025-1FG484I
MPF500TS-1FCG784I
M2S025T-1FG484I
M2S060TS-FGG676IH0108
M2S060TS-1FCS325
M2S150T-FCV484I
M2S050T-VFG400I
M2S090T-FGG484IX418
M2S090T-1FGG676S0007
A3P060-WAFERLOT
M2S090TS-FG484I
M7A3P1000-FGG256I
M2S010TS-1FGG484T2
MPF300T-FCG1152I
M2S150-1FCV484I
M2S090T-1FGG676S0006
M2S060TS-1FCS325I
MPF500TLS-FCG1152I
M2S150T-FCG1152I
MPF200TS-FCG484I
MPF200TLS-FCG784I

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MPF200TLS-FCSG325I
MPFS250T-FCVG484EES
M2S050TS-VF400
M2S150T-1FCV484
MPF200T-FCSG325T2
M2S060TS-1FGG676T2
M2S010-TQG144
MPFS250T-1FCG1152E
MPF200TL-FCG484I
M2S010T-VFG256
M7AFS600-1FG256
M2S090-1FG676IX417
M2S050-VFG400
M7A3P1000-FG144
M2S090-FGG676X416
P1AFS600-2FG484
M2S025TS-VFG400I
M2S150T-FCSG536I
M2S060-FG676I
M2S060TS-FGG676
M2S050TS-FGG896I
M2S050-FGG484X417
MPF100T-1FCVG484T2
M2S010TS-VFG256H0214
M2S090TS-1FCS325IX418
MPFS250T-FCG1152EENG
M2S060T-1FG484I
M2S090T-FGG484
M2S060TS-FGG676IH0239
M2S050TS-1FG484
MPF300TS-1FCG784I
M2S090T-1FGG676S0012
M2S025-1VF256I
MPF200TS-1FCG784I
M2S060TS-FGG484IH0118
M2S090-FCSG325I
M2S090TS-FCS325IX416
MPFS250T-FCG1152E
M2S090-1FGG484IX418
M2S050T-1FG484I
M2S025TS-FGG484
M2S060T-FGG676I
MPF300XT-FCG484I
M2S060TS-VFG400IH0248
M2S010-TQG144X486
M2S090T-1FG484I
M2S090TS-1FCSG325IX416

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M2S050-FGG896
M2S010TS-1VFG256T2
M2S090TS-FGG676IH0076
M2S050-VF400
M7A3P1000-1PQG208I
M7A3P1000-1FG144
MPFS250TS-FCG1152I
M2S090-FGG676ORT
M2S050-1VFG400
P1AFS1500-2FG484
MPF100T-FCSG325E
MPF100TL-FCG484I
P1AFS600-2FGG484
M2S090TS-1FGG676H0090
M2S150TS-1FCG1152I
M2S010TS-VFG256H0259
M7AFS600-2FGG256
M2S050T-1FGG484
M2S010TS-1FG484M
MPFS250T-FCG1152EX52
M7A3P1000-2FGG484I
M2S060T-1FG676
M2S050-1VF400I
M2S025TS-FGG484IX486
M2S010-1VFG256X416
MPF100TL-FCVG484I
M2S060TS-FGG676H0095
M2S090T-1FG484IX416
M2S025T-VFG256
M7A3P1000-1FGG144
MPF300XT-1FCG784I
M2S090-1FG676I
MPF500TS-FC1152MX167
M2S150-FCVG484I
M2S090TS-1FG484
M2S060TS-FGG676IH0222
MPF300XT-1FCG1152I
M2S010-VF400I
M2S060TS-FGG676IH0166
MPF100T-FCSG325EX524
M7A3P1000-FGG256
M2S060T-1FGG676S0015
M2S060TS-FGG676IH0218
M2S090T-FG484
M2S010TS-VFG256H0201
M2S150-FC1152
MPF300TL-FCG784E

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M2S060TS-1FGG484M
MPF100TL-FCVG484E
MPF300TL-FCVG484E
M2S060TS-FGG484H0246
M2S010TS-FGG484IH0235
M2S010TS-VFG256H0212
M2S025T-VFG400I
M2S010-TQG144I
M2S060-FCS325I
M2S060TS-FGG676IH0263
MPFS250T-FCSG536I
MPF100T-FCVG484E
M2S025T-1VFG256I
M2S010TS-VFG256H0063
M2S150TS-FCVG484
MPF300T-1FCG784E
M2S025T-1FG484M
M2S090-FG676IX416
M2S050TS-FG896
M7A3P1000-1FGG256I
M2S050TS-1FGG484
MPF300XT-FCG784E
MPF200T-FCVG484I
M2S025T-1FCSG158H
M2S010T-1VFG256I
M2S090T-1FGG676I
M2S090-FCSG325
M2S060TS-FCSG325
M2S025TS-FGG484H0182
MPF500T-1FCG1152E
M2S150T-1FCS536I
MPF300T-FCG1152E
M2S090-1FG484I
M2S060-FGG484IX486
M2S050-1FGG896I
M2S010TS-1VF256
M2S025TS-FGG484H0167
M2S090TS-WAFERLOT
M2S050TS-1FCSG325I
M2S050-1VF400
M2S050T-1VFG400I
M2S090T-1FCSG325
MPF200T-1FCSG325T2
M2S010T-FGG484I
MPF200TS-1FCVG484I
M2S010TS-VFG256H0026
M2S025TS-VFG400IH0101

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M2S090T-FGG676S0006
M2S060TS-FGG676H0198
M2S025T-VFG400
MPFS250T-1FCG1152EES
M7A3P1000-2FG256I
M2S150TS-1FCVG484
M2S025TS-FGG484H0015
M2S025-VFG256
MPF500T-FCG1152I
M2S050TS-1VFG400
M2S090-FGG484I
M2S060-1FGG676I
M2S010TS-VFG256IH0112
M2S050T-1VF400
M2S010-TQG144Z228
M2S090T-1FGG676
MPF200T-1FCG784E
MPFS250TLS-FCG1152I
M2S010TS-VFG256H0097
M7A3P1000-2FGG144
M2S025T-1VFG256
M2S090T-FGG676Q189
MPF200T-FCSG536E
M2S010TS-VFG256H0086
M2S050TS-FGG484I
M2S090T-1FGG676Q149
M2S150TS-FCV484I
M2S025TS-FGG484X486
M2S090TS-1FG676IX417
M2S090TS-1FGG676H0017
P1AFS1500-2FG484I
M2S025-VFG256Q256
M2S150T-1FCG1152M
MPF500T-FCG784E
MPF300TL-FCG784I
M2S025T-FGG484I
M7A3P1000-1FGG144I
MPF100TLS-FCVG484I
M2S090TS-1FGG484T2
MPF300TL-FCG1152E
MPF300T-1FCVG484I
M2S050TS-FCSG325
M2S025-1FCSG325
M2S010T-1VFG400
M2S025T-1FCSG325I
M2S150T-1FCS536
M2S150TS-WAFERLOT

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M2S025T-FGG484X417
M2S010-VFG256X456
M2S010TS-VFG400I
M2S010TS-VFG256H0140
MPF200TS-1FCSG325I
M2S150TS-1FCSG536I
M2S060-FG484
M2S025TS-VFG256H0123
M2S025T-1VFG400
M2S010TS-FG484
M2S010TS-VFG256H0106
M2S010T-VF256
M2S050TS-1VF400
M2S010TS-VF256I
M2S025T-FCS325
M2S050-FCSG325I
M2S090TS-1FGG676H0223
MPF300T-1FCSG536I
M2S060-FGG484GW
M2S050-FG896I
M2S060TS-1VFG400T2
M2S025TS-VFG400IH0173
M2S010TS-VFG256X416
MPFS250TS-FCVG784I
MPF200TL-FCSG325I
M2S090-FGG484X456
M2S050-VF400I
M2S090TS-FG484
MPF300XT-FCG484E
M2S025TS-1VF256I
MPF200TS-WAFER
M2S150TS-1FC1152M
MPF500TS-WAFER
M2S010T-1VF256I
M2S090T-1FG676
M2S025TS-1FCSG158H
M2S010TS-VFG400H0155
MPF500TL-FCG784E
M2S025T-1VFG400I
M2S050-1FG484I
M2S090TS-1FCSG325I
M2S025T-1FG484
M2S060-FG484I
M2S090TS-1FG484MX3
M2S090T-FCSG325I
MPFS250T-FCG1152EFS
M2S090TS-1FGG676H0144

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M2S060-1FCS325
M2S090T-1FGG676S0003
M2S060-1FCS325I
M2S150TS-1FCG1152H0012
MPF300TL-FCSG536I
M2S010TS-VFG256H0104
M2S025-VFG400IX413
M2S090-1FGG676
M2S010TS-FG484I
MPF200T-1FCSG536E
M2S090TS-1FG484MX471
MPF200TLS-FCG484I
M2S010TS-VF400
M2S090TS-1FGG484IX418
M2S150T-FCG1152
M2S010-TQG144Q143
M2S060T-FGG484I
M2S090TS-FGG676IH0145
M2S050TS-1VF400I
M2S025TS-FCSG325
M2S010TS-VFG256IH0230
M2S060TS-FCS325
M2S060T-1VF400
M2S060TS-1FG484I
M2S050-1FCS325I
M2S025-1VFG400IX416
M2S060-1VF400
MPF300TL-FCG1152I
M7A3P1000-2FGG484
MPF300TS-FCG484I
M2S090-1FCSG325I
M2S060TS-FG676
MPF500T-FCG1152T2
M2S025TS-1FG484I
M7A3P1000-2FGG256I
MPFS250TL-FCVG484I
M2S090T-FGG676I
M2S150-1FCV484
M2S050TS-1FG484I
MPF200T-1FCG484T2
M2S090-FG484
MPF300TS-FCG784I
MPF300T-FCG784E
M2S060-FGG484
M2S025T-1VF256
M2S060-1FG484
M2S050-VFG400I

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MPF100TS-1FCVG484I
M2S150TS-FCVG484I
M2S050TS-1VFG400I
M2S010TS-VFG256H0135
M2S060TS-1FG676I
M2S090TS-FGG676IH0053
M2S060T-1FG484
M2S025T-1VF400I
M2S060TS-1VFG400
MPF200TS-1FCSG536I
M2S060TS-1FGG484
MPF100T-1FCSG325T2
M2S060TS-FGG676I
M2S025TS-1FG484
M2S060-1FCSG325
M2S060TS-VFG400
M2S060-VF400
M2S010-1VFG400I2202
M2S050T-FG484I
M2S090TS-1FGG484X416
M2S060TS-FGG484IH0039
M2S025T-FGG484X416
M2S050TS-FGG896
M7AFS600-1FGG256I
M2S090TS-1FGG484
M2S050T-FG896I
MPF200T-FCG784I
MPF300T-FCG784NE
MPF200T-1FCSG325I
M2S050TS-VF400I
M2S060-FG676
MPF200T-FCSG325I
M2S060T-1FGG676S0013
M2S150TS-1FCG1152H0186
M2S150T-1FCV484IX259
M2S060TS-FGG484IH0043
M2S060-FCSG325I
M2S060-FGG676X456
MPF300T-FCSG536I
M2S010-1VFG400X416
M2S025-1FCS325I
MPFS250T-FCG1152ESS
M2S090TS-1FGG676H0044
M2S050TS-WAFERLOT
M2S010S-1TQG144I
M2S060TS-VFG400I
MPF200T-FCG484T2

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M7A3P1000-2FG256
M2S010TS-VFG256H0208
M7AFS600-1FGG484I
M2S150T-FCS536I
M7A3P1000-1FGG256
M2S150-FC1152I
M2S010TS-VFG256H0035
MPF300TS-FCG1152I
M2S090TS-1FG484M
M2S090T-1FGG484
M2S060TS-FGG484IH0020
M2S090TS-FGG676IH0107
M2S090TS-FGG484X416
MPF100TS-1FCG484I
M2S025-VFG400I
M2S150TS-1FCS536I
M2S050T-FCS325
M2S090TS-FCSG325
M2S090TS-FGG676H0137
MPFS250T-1FCVG484I
MPF500TS-1FCG1152I
M2S050TS-VFG400I
MPFS250T-FCG1152I
M2S060TS-FG676I
MPFS160TS-WAFERLOT
P1AFS1500-2FGG256I
M2S050T-VF400
M2S010TS-FGG484X418
MPFS250T-FCVG484I
M2S150TS-1FCG1152H0038
M2S150-1FCS536
M7A3P1000-FG256I
M2S090-FGG484X416
M2S050T-FCSG325I
M2S025TS-FGG484H0070
M2S150TS-FCSG536
M2S090-FGG484IX416
MPF100TS-WAFER
M2S050T-VF400I
M2S060TS-FGG484H0028
M2S060TS-FGG676IH0102
M2S025TS-VFG400IH0069
MPF200TS-FCVG484I
M2S150T-1FC1152IX3
M2S025TS-VFG400IH0184
M2S050-1FCSG325
P1AFS1500-2FG256

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M2S050-1FCSG325I
M2S010TS-VFG256H0129
M2S060TS-1FGG676
MPF100TS-FCG484I
M2S025T-1FCSG325
M7AFS600-FGG484I
M2S090TS-1FGG676H0132
M2S025-VFG256I
MPF500TS-FCG784I
M2S150T-FC1152I
M2S025-1VFG400I2288
MPF300TS-1FCG484I
M2S090TS-FCSG325I
MPFS250TS-1FCVG484I
M2S010TS-VFG256H0188
MPFS250T-FCVG484EX52
MPFS250T-1FCSG536I
MPF200T-1FCSG536I
M2S050-FGG484
MPF200TL-FCSG536E
M2S150TS-1FC1152
M2S090TS-1FG676I
M2S025TS-VF256
M2S150-1FCSG536I
M2S050T-FG484
M2S060TS-FGG676IX486
M7A3P1000-FGG144
M2S090-FG484IX416
M2S010-1VFG400I
M2S090T-1FGG484IX417
M2S060TS-FGG676H0161
M2S090TS-FGG676I
M2S090T-FG676IX417
M2S050-1FGG896
M2S010T-VFG400I
M2S025T-FCS325I
M2S010TS-VFG256H0134
M2S150T-FCSG536
MPFS250T-FCG1152EFF
M2S010T-VFG400
M2S090TS-1FGG676
M7A3P1000-2FGG144I
M2S050-1FG896I
M2S050T-VFG400
M2S090-FCS325X339
M2S010TS-1VFG400
M2S060-VFG400

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M2S025-1VF400
M2S060-FGG676
M2S090-FGG484X418
MPFS250T-1FCVG784EES
M2S090-1FCSG325
M2S010-TQG144Q179
M2S060T-VFG400
M2S025-VFG400IX416
M2S010-VF400
M7A3P1000-FG144I
M2S010-1VFG256I
MPFS250T-1FCVG484EES
M2S060TS-FGG676IH0250
M2S025TS-1FCSG325
M2S010TS-VFG256H0029
MPF300TLS-FCG1152I
M2S060T-1FGG676
M2S025TS-1VF400
M2S025-VF400
MPF200TL-FCVG484E
M2S060T-FGG676X486
M2S150T-1FCV484M
M2S060TS-FGG676IH0042
M2S025-1FG484
M7A3P1000-2PQG208
M7A3P1000-1FG256I
M2S025TS-VF400I
M2S025TS-VFG400IQ270
M7A3P1000-2FG484I
M2S150TS-1FC1152IX167
MPF300TLS-FCSG536I
M2S060-1FG484I
M2S150TS-FCSG536X416
M2S025-FGG484I
M2S025TS-VFG256H0025
M2S010TS-1FGG484I
M2S025TS-1FCS325
M2S050TS-1FGG484I
P1AFS600-2FG256
MPF300T-1FCG1152I
M2S150TS-FCG1152I
MPF200TLS-FCVG484I
M2S025TS-FGG484H0096
M2S060-1FGG484
MPF100T-FCSG325T2
M2S090T-FGG676
M2S010T-1FG484

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M7AFS600-FGG256I
M2S090TS-FG676
M2S050T-1FCSG325I
M2S060TS-FGG676IH0252
M2S010TS-1FG484
MPF100T-FCG484T2
M2S010TS-VFG400S0010
M2S090T-1FG484IX399
M2S010TS-FGG484IX416
M7A3P1000-PQG208I
M2S010TS-VFG256
M2S050T-1FGG484M
M2S025TS-VFG400IH0241
M2S060T-FG484
M2S025TS-1VF256
M2S050T-FG896
MPFS250TS-FCSG536I
M2S060-1FG676I
M2S050TS-VFG400
M2S025-FGG484
MPFS250T-FCVG784EES
M2S010TS-FGG484IS0005
M2S090TS-FGG676IS0004
M2S025TS-FGG484H0013
M7AFS600-2FG484I
M2S150-1FCSG536
MPF200T-1FCG484E
M2S010TS-VFG256H0034
MPF300TLS-FCVG484I
M2S060T-FCS325I
M2S050-FG896
M7AFS600-2FG484
M2S150T-FCVG484IX94
M2S025T-1FGG484I
M2S010TS-FGG484
M2S090-FG676
MPF300TS-1FCSG536I
M2S060T-1FGG484M
MPF100T-FCSG325I
M2S010-TQG144Q159
M2S050TS-1FGG896
M2S060T-VF400I
M2S060-FGG676X486
MPFS250TL-FCSG536I
M2S010T-VFG256I
P1AFS600-2FGG484I
M2S060TS-FGG676IH0092

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M2S060TS-FCSG325I
M2S010S-TQ144
M2S150T-1FCSG536
M7AFS600-1FGG484
M2S025T-VFG256I
M2S150TS-FCG1152
M7A3P1000-1FG144I
MPF300TS-FC484M
M2S010T-1VF400
M2S090TS-1FGG676X416
M2S010-1VF256
M2S060T-FCS325
M2S050TS-FCS325I
M7AFS600-FG484
M2S090T-1FG676I
MPFS250T-1FCVG484E
M2S060-FG484X456
M2S010TS-VFG256H0119
M2S010-VFG400I
M7A3P1000-1FGG484I
M2S010T-VF400
M2S150T-FCG1152X416
M2S050TS-FCSG325I
M2S090-1FGG484X418
M2S010TS-VFG256H0024
MPF200TL-FCG784E
MPF300TS-1FCG1152I
M2S010-VFG400X416
M2S010TS-1VF400I
P1AFS1500-2FG256I
M2S010TS-VFG256H0114
M2S010T-1VFG400I
MPF300T-1FCVG484T2
M2S050T-FGG896
M2S060TS-FG484I
M2S025TS-1FGG484M
M2S050T-FCSG325X416
M2S060TS-VF400
M2S050-FG484IX11
M2S060TS-FGG676H0093
M2S150TS-1FCG1152H0261
M2S060TS-FGG676IH0089
M2S010TS-VFG400
M2S090TS-1FGG676T2
MPFS250TS-1FCSG536I
M2S025TS-1FGG484T2
M2S060T-1FGG484I

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MPFS250T-1FCG1152I
P1AFS1500-2FGG484
MPF300T-FCVG484T2
M2S010TS-VFG256H0060
M2S010T-VF400I
M2S025-FCS325I
M2S010TS-1VFG400I
M2S090TS-1FCS325
M2S050T-FGG484I
M2S150TS-1FCS536
MPF100T-1FCG484I
M2S025TS-VFG400IH0256
M2S060T-1FCSG325I
M2S050TS-FG484I
M2S025T-FG484
M2S050-FCS325
M2S090-1FGG484
M2S060TS-1FCSG325
M2S050-FG484I
M2S010TS-1VFG400T2
MPF300TS-WAFER
P1AFS600-2FGG256I
M2S025TS-FGG484H0079
M2S150T-1FCSG536I
MPF300T-FCG484E
M2S060-1FCSG325I
M2S010-1FGG484I
M2S150T-FCVG484I
M2S025TS-FCS325I
M2S010TS-VFG256H0209
M2S025TS-VFG256H0206
M2S090-FGG676I
M2S010TS-VFG400S0008
MPF500TL-FCG1152E
M2S060TS-FGG484IH0067
M2S090-1FCS325
M2S060TS-FGG484IH0205
M2S050-FGG896I
M2S010TS-VFG400S0011
MPF300TS-FCS536M
MPF200TS-FCSG325I
M2S060TS-1VF400I
M2S010S-1TQG144T2
M2S060TS-FGG484IH0169
M2S060-FCSG325
M2S025TS-FCSG325I
M2S050-FG484

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M2S010S-TQG144
M2S010-TQG144X52
M2S025T-1FCSG158HZ221
M2S025TS-FGG484H0100
M2S010TS-FGG484I
M2S025TS-FGG484H0058
M2S025TS-VFG400IH0162
M2S025-1VFG400
M2S010TS-1VF256I
MPF100TL-FCG484E
M2S025-1VFG256I
MPFS250T-FCSG536EX52
MPFS250T-1FCVG784I
MPF300TLS-FCG784I
M2S050TS-1FG896I
MPF300XT-1FCG484I
M7A3P1000-FGG484
M2S090TS-1FGG484X418
M2S060T-1FGG676I
M2S060TS-FGG484IH0220
M2S010T-1FGG484M
M2S150TS-FC1152I
M2S060TS-WAFERLOT
MPF200T-FCG484E
M2S090TS-FGG676
M2S150TS-1FCG1152
M2S010TS-VFG256H0077
M2S025-FCSG325
M2S090TS-1FGG676I
MPFS095TS-WAFERLOT
M2S060-FG676X456
MPFS250T-FCSG536E
M2S090T-1FG484
M2S060TS-1FCSG325I
M2S025-VFG256Z279
M2S050TS-1FGG484M
M2S090-FGG484IX417
MPF200TS-FCS325M
M2S025TS-FG484
M2S050T-1FGG484IX416
M2S090T-FG484I
M2S010-TQ144I
M2S090TS-1FGG676IX418
M2S025TS-FGG484H0059
M2S025TS-FGG484IH0257
M2S050-1FG896
M2S150-1FCVG484I

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M2S060TS-1FGG676I
M2S090TS-1FGG484M
M2S050T-1VF400I
M2S010TS-VFG256H0174
M2S060TS-FGG484
M7AFS600-FGG256
M2S050T-FGG484
M2S010-TQG144X417
MPF500TS-FC1152M
M2S090T-1FGG484MX416
M2S150TS-1FCG1152H0105
MPF100T-1FCG484E
M2S090T-1FCS325I
M2S010T-1VFG256
M2S010T-FGG484IX418
M2S025-VF256I
M7A3P1000-2FG484
M2S150T-1FCVG484
M2S010TS-FGG484IX418
M7AFS600-FG484I
MPFS250T-1FCSG536EES
M2S150-FCVG484
M2S150T-1FC1152
M2S010TS-1VFG256I
M2S090-FGG484IX418
M2S050-FG896ESX423
M7AFS600-2FG256
M2S060T-1VF400I
M2S010-VFG256I
MPFS250TLS-FCVG784I
M2S010TS-VF256
M2S150-FCS536I
M2S150-1FCG1152
MPFS250T-FCVG484E
MPF300TL-FCSG536E
M2S150TS-1FC1152IX130
M2S010-TQ144
M2S060TS-FGG484IH0229
MPF200TL-FCSG325E
M2S025T-FCSG158IZ222
M2S010TS-FGG484IH0199
M2S025TS-VF256I
M2S050-FGG484IX417
M2S060TS-FCS325I
M7A3P1000-1PQG208
M2S025TS-FGG484X416
M2S010T-FGG484

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MPF300T-1FCG1152E
M2S150-FCV484I
M2S025T-VF256
M2S090-1FGG676I
M2S010-1VFG400IX416
M2S060-FGG484X486
M2S090TS-1FGG484IX416
M2S060T-FGG676IX486
M2S025-1VF256
P1AFS600-FGG256
M2S060TS-VF400I
M2S150TS-1FCG1152H0121
M2S025TS-FCS325
MPF100T-FCVG484T2
M2S025TS-VFG256I
M2S060-1VFG400I
M2S025TS-FGG484H0080
M2S050TS-1FCS325I
M2S025-VF400I
M2S025TS-1FCS325I
MPF200TS-1FCG484I
M7AFS600-2FGG256I
M2S010TS-1FGG484M
M2S010T-1VF256
M7AFS600-2FGG484I
M2S025TS-FGG484H0253
M2S025TS-FGG484H0236
M2S060T-FG676
M2S010-VFG256
M2S060TS-FGG676X486
MPFS250TL-FCVG784E
M2S090TS-FGG484IX416
MPF300T-1FCG784NI
M2S025TS-VFG400IX417
M2S025TS-VFG256H0152
M2S090-1FCS325I
M7A3P1000-FG256
M2S150TS-1FCG1152H0061
M2S010T-1FG484I
M2S150T-1FCV484I
M2S010TS-VFG256H0210
MPF200TLS-FCSG536I
M2S010-FGG484IX417
MPF100TL-FCSG325I
M2S060TS-FGG676IH0019
MPF200TS-1FCSG536IQ302
MPF200TL-FCSG536I

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M2S060TS-FG484
M2S150TS-1FCG1152IX417
M2S150T-FCVG484
MPF300T-FCSG536T2
MPF300T-1FCSG536T2
M2S010-1VFG400
MPF300T-1FCG484IPP
M2S090T-FGG484X417
MPFS250TL-FCG1152E
M2S090TS-1FGG676H0046
M2S010TS-1FG484I
M2S090TS-1FCS325I
M2S090TS-FG484IX416
MPF200TS-FCG784I
M2S090T-FGG484X416
MPF200T-FCVG484E
MPF100T-1FCSG325E
M2S060TS-FGG484IH0158
M2S060TS-FGG676IH0240
M2S025TS-VFG256H0010
MPF300T-1FCG484I
M2S025TS-FGG484H0103
M2S050T-FCS325I
M2S150TS-1FCV484M
M2S025TS-FG484I
MPF300TS-1FCVG484I
MPF200T-FCSG325E
M2S025-VFG256Q177
MPF300XT-1FCG1152E
M2S090TS-FG676I
MPFS025TS-WAFERLOT
M2S025-1FCS325
M7A3P1000-2FGG256
M2S025T-FCSG325
M7AFS600-1FG484I
M2S025-VF256
MPFS250T-FCSG536EES
M2S010TS-VFG400X416
M2S150TS-FCS536
M2S050TS-1FCS325
MPF200T-FCG784E
M7A3P1000-2FG144I
M2S090T-1FGG676S0001
MPF500TLS-FCG784I
M2S025-FCSG325I
M2S010T-1FGG484MX417
M2S025TS-WAFERLOT

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M2S010TS-VFG256H0228
M2S010-VFG400
M2S010TS-VFG256H0227
P1AFS600-2FGG256
M2S010TS-VFG256H0088
M2S060-VF400I
M2S090TS-1FCSG325
M2S025-VFG256H0049
M2S060TS-FGG676IH0242
M2S150T-FC1152X416
M2S090T-FCS325I
MPFS250TLS-FCSG536I
M2S090TS-1FG484I
M2S010TS-WAFERLOT
M7AFS600-1FG484
MPF500TS-FC784M
M2S150-FCV484
M2S010-VFG256X416
MPF300XT-1FCG784E
M2S025TS-1FGG484IX416
MPFS250TS-FCVG484I
M2S025-1FGG484
M2S150T-1FCG1152X416
M2S010TS-1VFG400X416
MPF500T-FCG1152E
M2S025TS-VFG400IH0262
M2S025T-VF256I
M2S025T-1VF400
M2S090TS-1FG484IX418
M2S025-FGG484IX417
MPFS250TL-FCG1152I
M2S090T-1FGG484MX417
M2S025T-1FCS325I
M2S010-VFG256Q178
M2S060-1VFG400
M2GL050-VF400I
M2GL090T-1FGG484M
M2GL050-1FG484I
M2GL005-1FGG484I
M1A3PE1500-PQG208I
M1A3P1000-2FG144I
AX1000-2FG484I
M2S005S-TQG144I
M1A3PE3000-2FG896
AGLP125V5-CSG289
M1A3P600L-FG484I
M2S005S-TQG144H0185

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M1AFS600-2FGG256
M2S005S-TQG144H0127
M2GL060TS-1FGG484T2
M2GL010TS-1FGG484I
M2S005S-TQG144X486
M2GL060T-FG676
M2GL050T-1FGG896I
AGLP125V2-CSG281
M2GL005S-1VF400I
M2GL005-1FG484I
AX125-FG256I
M1A3P1000L-1FGG144I
M2GL050T-FCSG325
M1A3PE3000-PQG208I
M2GL150TS-FCS536
M2S005S-VFG256H0233
M1AGL1000V2-FGG144I
M2GL060TS-1VFG400T2
M2GL025-1FCS325
AX250-FG484M
M2GL150T-FCVG484I
M2GL060-FGG676IX399
M2GL050-1FCS325I
M2GL005S-1VFG256I
AX2000-1FGG896M
M1A3P1000-PQG208I
M2GL025T-1VF256
M2GL050TS-FG484
APA600-FG484IX95
M2GL090-1FG676I
M2GL150TS-1FCG1152
AX500-PQ208I
M2S005S-TQG144H0003
M2GL150-1FCG1152X417
M2GL025T-1FG484MX130
M2GL060-FGG484
M1A3P600-1FGG484I
M2GL025-FCSG325I
M2S005S-VFG256IH0143
AX1000-1FG484MX3
M1A3PE1500-FG676I
M1A3P1000L-1FG256
M2GL150-FCSG536I
M2GL050TS-1FG484I
M2GL090T-FGG676IX416
M2GL060T-1FG676I
M1A3P250-FG144

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AX250-1PQG208M
M1AGL250V5-VQ100I
M1AFS600-2FG256
M2GL060T-1FGG484
APA750-PQG208
APA600-BGG456I
M2S005S-VFG256H0219
M2S005-1VFG400I
M2S005-1VF256
M2GL090-1FGG484IX417
AGLP060V5-CSG201I
M2GL010T-1FG484IX418
APA600-FG256A
M1A3PE3000-1PQG208I
M2GL060T-FCS325
M2GL050T-FG484I
M1AFS250-1FGG256
M1A3PE3000L-1FG896
M2GL025T-1FGG484
EX128-FTQ100
M2GL010-1VFG256
M2GL010T-1FG484MX417
M1AGL600V2-FG144
M2S005-VFG256X416
M2GL090-FGG676X416
M2GL090-1FGG676IX441
M2GL025-1VF400I
M2GL025TS-FCSG325
M2GL010S-1TQG144I
M1A3PE3000-FGG484I
M2GL025T-1FG484I
M2GL090TS-1FCSG325
M1A3P1000-1PQG208I
M1A3PE3000L-1FG896MX323
M2GL025-VFG256I
M1AFS250-2FGG256I
M1AFS1500-2FG256
M2GL050TS-1FGG896
M2GL150TS-1FC1152M
M1A3PE3000L-1FGG484
M1A3P400-FGG144
APA075-PQG208A
M1AFS600-FG256
M2GL090-FCS325I
M1A3P600-2PQG208I
M1AFS1500-1FG256I
M1A3P600-FGG256

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M2GL025TS-FCS325
M2GL150TS-1FCS536I
M2S005S-TQG144IH0057
M2GL060T-1FGG676I
M1A3PE1500-2PQG208I
M2GL010-1VFG400
M2GL090-1FG676
M2GL005S-1VF256
AX2000-FG896I
M1A3PE3000-FGG896I
EX128-FTQG64
M2S005S-VFG256H0126
M2GL090T-FCS325
M2GL050TS-FGG484I
M2GL025TS-1VF400I
M1AGL250V2-VQG100I
M2GL060TS-1VF400I
M2S005S-FG484I
APA075-PQG208IQ161
M2GL150-FCS536
M2GL090-FGG484X505
M2GL010-VF400IX416
M1A3PE1500-PQG208
M1AFS600-2FG256I
EX256-TQG100A
M1A3P600L-1FGG484
M1AGL1000V2-FG256I
M2GL025T-FGG484I
M2GL025T-VFG256I
APA075-FG144A
APA150-PQG208
M2S005S-1VF256
M2GL060-1VF400
M2GL050T-1FGG484I
M2GL060T-FG484I
M1A3PE3000L-1FG484I
AGLP060V2-VQG176I
M1A3P400-FGG256I
M2GL010TS-1FG484I
M1A3PE1500-2FG484I
M2GL010TS-FGG484I
M2GL060TS-1FGG484
APA300-PQG208I
M1A3P600-1FG256
M2GL025T-1FGG484IX417
M2GL060TS-1VFG400I
M1A3PE3000L-1FG896I

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M2GL005S-VF256I
M1AFS1500-FG484K
M1A3P250-1VQG100I
M2GL090-FG484X416
M2GL060TS-FGG676I
M1A3P1000-2FG484I
M1A3P1000L-FGG144I
M2S005S-TQG144IH0065
EX64-TQG64
M2GL025-FCS325
M2GL050-1FGG484
EX128-TQG64IX3
M2GL010-TQG144Q046
M1AFS250-1FGG256I
APA450-PQG208A
M2GL010-1VF256
M2GL060TS-1FCSG325
M2S005S-TQG144H0075
AX2000-1FG896I
APA450-FGG144
M1AGL600V2-FG256I
M2GL010T-1FGG484X417
M2GL150-1FCS536I
M2S005S-VFG256H0176
M2GL150T-1FC1152M
M2GL010-1FG484
M2S005S-1FGG484T2
APA150-FGG144
APA600-FGG256IXR03
EX256-PTQG100I
AGLP060V5-CSG289
M2GL025T-VF400I
M1A3PE3000L-FG896
M2S005-1VF400
APA150-FG256IPM61
M2GL005-1FGG484
AX500-1PQG208
M2S005S-VFG256H0047
M1AFS1500-1FG484
M2GL025T-1FG484M
M2GL010TS-VFG256
M2GL060-1FCSG325I
M2GL060TS-VF400I
M2GL150TS-FC1152
M2GL060-1FCS325I
M1A3PE3000-2FGG484I
M2GL025-FG484IX417

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M2GL025T-FGG484IX416
M2S005S-VFG256IH0094
M1A3P1000-1FGG256
AX250-FG256M
M1AFS600-FGG484K
AX1000-1FG484
M2S005S-TQG144H0005
M2GL050TS-1FGG896I
M2GL005-1TQG144I
M1A3P250-VQG100
M1AGL1000V5-FGG144
M2GL090TS-1FCS325I
AX1000-FGG896M
M2GL025T-1FCS325
APA450-BGG456
M2GL090T-1FCSG325I
M1A3PE1500-2PQG208
M2GL025TS-FG484
M2GL050-1FG896I
APA150-TQG100A
M2GL050-1FG896
M2GL060-1FGG484T1
M1A3P600-2FGG256I
M2GL150-1FC1152IX441
M2S005S-VFG256H0124
M2S005S-VFG256IH0098
M1A3P1000-FG256I
M2GL025TS-VFG256
M2GL090TS-FCS325
M1AGLE3000V5-FG484I
M2GL060TS-FCS325
M2S005S-TQG144H0008
M2S005S-VF400I
APA600-PQG208M
M2S005S-VFG400I
M2GL025TS-VFG400I
M2GL150-1FC1152IX520
M2GL050-FGG896
M2GL010T-1FGG484M
M2GL060TS-1FCS325
M1A3P250-PQG208I
M1AGL250V5-VQG100I
M1A3P400-1FG144I
M2GL005-1VF256
M2GL060TS-FGG484I
M2GL005S-FGG484
M1A3P600-1FGG484

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M2GL060T-1VFG400
APA300-FG256X354
AX1000-FG676IX218
M1AGLE3000V2-FGG484
M2GL090TS-FG484I
M2S005S-VFG256H0113
M1AGL1000V5-CS281
M1A3P400-2FG256I
M2GL050-FGG896I
M2GL010-1FG484I
M1A3PE3000-2FGG324
M2GL050T-FG896
M1A3P1000-2FG144
AGLP030V5-VQG128I
M2S005S-FG484
AGLP125V5-CSG289I
APA150-FG144
EX64-PTQG64I
M2GL090TS-1FVG484I
M2GL010S-TQG144
M2GL050-1FVG896
M1A3PE3000-2FG896IX94
EX64-TQG64PQ83
APA150-FG144IX94
M1AGL1000V2-FG144
M1AGL250V5-FG144
M1AFS1500-2FGG256
M2GL050-1FCSG325
M1A3P250-VQ100I
APA1000-FGG896I
M2GL010TS-VF400I
M2GL050-FGG484
AX1000-FGG484
M1A3P600-FG144
M2GL025TS-1FCS325
M2GL150TS-FCV484
M2S005S-VFG256H0197
M2S005-1VF256I
M2GL050-VFG400
M2GL025T-FG484
APA150-PQG208IX95
AX1000-FGG676M
APA075-TQG100
AX2000-FG1152M
M2GL025-VF256IX417
M2S005-1VFG400IX416
M2S005S-VFG400

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M2GL090T-1FGG484
M2GL010-VF256X456
APA450-FGG256IXN10
M1A3P400-1FGG256
AX250-FG484I
APA1000-FG896
M1A3P600L-FG144
M1AGL250V5-FGG144
M2GL010-FG484I
M2GL150-1FC1152I
M1A3PE3000-1FG484I
M1A3P1000-FGG144M
M2GL025-FG484X417
M2GL090TS-1FGG484T2
AX250-2FG484I
APA450-FGG144I
M2S005-TQG144
M2GL090-FG484IX3
M2GL005S-1VF400
M2S005S-VFG256IH0211
M2S005S-1FGG484I
M2S005S-TQG144H0251
M2GL060-1FGG484I
M1AFS600-FG484K
APA1000-BGG456M
AX1000-1FG676MX157
M2S005-FGG484IX3
M1AFS250-2FG256
AGLP030V5-VQG128Z239
M2S005S-VFG256H0260
M2GL090-1FG484I
M1A3P600-2FG256I
M2GL050-1FG484IX417
M2GL025-1FCSG325
EX256-FTQ100
M2S005S-TQG144H0141
M1AGLE3000V5-FGG484
M2S005S-VFG256H0130
M2GL090T-1FG484IX417
AX500-FG484I
APA450-FG256I
M1A3P1000-PQG208M
M1AGL1000V2-FG144I
M2GL010-VF256I
M1A3P1000-FGG144I
AX1000-FG676I
M2GL050T-1FGG484X417

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M1A3P1000-2FGG484
M2GL060-VFG400X456
M1AFS1500-1FGG256K
M2GL150T-1FCVG484I
AGLP125V5-CS289I
M2GL025TS-1VFG400I
M2GL010-1FGG484
M2S005S-WAFERLOT
M2GL090TS-1FG484
M2GL005-1VFG400
M2GL090T-1FG484M
M2GL010-1VFG400I
M2GL060TS-1VFG400
APA600-FGG484
M2GL050T-VF400I
M1AGL1000V2-CSG281I
M2GL150T-1FCG1152IX417
M1A3P600-1FGG256I
M2GL050-1VFG400
M1AGL250V5-FGG144I
M1AFS600-FGG256I
M2GL150TS-FCS536I
M2GL060T-FCSG325I
APA150-FGG256IX95
AGLP030V5-VQG128Q135
APA1000-FG896M
M1A3P400-1FGG256I
M1A3P600-FGG484I
AGLP125V5-CS289
M2GL025TS-1FG484M
M1AGL250V5-FG144I
M2GL060-FGG484X456
APA600-PQG208I
M2GL090TS-FCSG325
M2S005S-TQG144H0001
M2GL010T-1VFG400
M1AGL250V2-VQG100
M1AFS1500-1FG256
M2GL005-VFG256X456
M1AGL1000V5-FG484I
M2GL060T-1FGG676
APA600-PQG208MX462
M1A3PE3000L-FG484
M2GL060TS-FGG484
M2GL060TS-1FCSG325I
M2GL150T-FC1152I
M1A3P1000L-1FG256I

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M2S005S-TQG144H0237
M2GL005-1VFG400I
M1A3P250-FGG144
EX64-TQ100
M2S005-VF256X416
M2GL025-FG484
M1A3P600-2FGG144I
M1A3PE1500-1FGG484
M2S005S-TQG144H0217
APA300-BG456IPM98
M2GL025T-1VF400
M2GL060TS-1FG676I
EX256-TQG100
EX128-PTQG64
M2S005S-VFG256IX416
M2GL025TS-1FGG484T2
EX128-TQ100I
M1AGL1000V2-FG484I
AX2000-FGG896IX218
M2S005S-VFG256H0016
AX1000-1FGG484I
M2S005S-TQG144H000
M1A3PE3000-1FG896
M1A3P400-1FG256I
M1A3P1000-FG256
M2GL010T-1VF400I
M2GL150-FC1152I
EX128-TQG64
M2GL010T-VFG400I
M2S005-VFG400X416
M1A3P600-PQ208I
M2GL060TS-1FGG676I
M2GL090TS-1FGG484
M2GL090-FGG484X416
M2GL025TS-1VF256I
M2GL150T-1FC1152MX520
M1A3P250-1FGG144I
M2GL025TS-VFG400
M1A3PE1500-2FG676I
M2GL005-VFG256Q134
M1AGL250V2-VQ100
M2GL025TS-1VFG256I
APA600-FG256
M2GL150T-1FCV484
M2GL010T-FG484I
APA150-FGG144IX94
M2GL010TS-VFG400I

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M2GL010-VFG400I
APA150-FG256
M2GL050-FCSG325
M2S005S-VFG256H0014
M1A3P600-1FGG144
M1AFS600-FGG256K
M1A3P600-2FG144
M2GL005-VF400
M2GL005-VFG400
M2GL010T-1VF256I
M2GL090-FGG484X418
APA1000-FGG896
M2GL010-TQG144IX418
M1A3P600-1FG484I
M1AGL250V5-VQ100
M2GL050TS-1FG896
M2GL005-1VF400
APA150-FG256IX95
AX1000-FG676M
M1A3PE3000-1FGG324
M2S005S-TQG144IH0068
APA1000-BG456
AGLP060V5-CSG201
M2GL050-FG484
M1A3PE3000-2FG484
AX500-2PQG208
M2GL025T-1FCS325I
APA1000-FG896I
M1A3P250-2VQG100I
M2GL060TS-FG676I
M2GL025-VF256I
M1A3PE3000-FG484
M2S005-1VF400I
M2GL005-VF256
APA450-FGG256IXN11
M2GL090-FCSG325I
M2GL010-1VFG256I
M2GL090-1FG676IX441
M2GL050T-1FG484MX471
M2GL025TS-FCS325I
APA150-FG144I
M1A3PE3000L-1FG484MX259
M1A3PE3000L-1FG484M
M2GL150T-FC1152
M1AFS1500-FG484
M2S005S-1TQG144I
M2S005-VFG256X456

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M2S005S-VFG256H0200
M2GL090T-1FG484
M1A3P1000-PQ208M
APA450-BGG456I
M2GL010-1FGG484T1X7
M2GL060-FCS325I
M2GL150T-FCG1152IX417
APA600-FGG484X354
M2GL010-FGG484
M2GL010-1VF256I
M2S005-VF400
M2GL005-1VFG256
M2GL150T-FCG1152I
M2GL150-FC1152X417
M1A3P1000-FGG256I
M1AGL600V5-FG144
M2GL060-1VF400I
M1AFS250-2FGG256
APA450-FG144I
M2GL050TS-VF400I
M2GL060T-FCSG325
M2GL090TS-FCSG325I
M2GL050-1FGG896I
M2GL025T-1FG484
APA450-FGG484
M2GL010T-1FGG484X418
M2GL025T-VF400
M1A3P600-1FGG256
M2GL025T-1FCSG325I
M2GL025TS-1VF256
M2GL010T-1FG484M
M1A3PE1500-2FGG484
APA600-PQG208A
M2GL150TS-1FCVG484I
M2S005S-TQG144H0133
AX500-1FG484
M1AFS1500-2FGG484
M2GL150TS-1FC1152
M2GL150-1FCG1152
M2GL150T-1FCV484I
M2GL010TS-1FGG484
M2GL090T-FGG484IX416
M1AGL1000V2-CSG281
M1A3PE3000L-FGG484M
APA150-TQG100I
M1A3P1000-2PQG208I
M1A3PE3000-2FG324

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M2GL060TS-FCSG325I
AX2000-FGG896MXY70
AX250-2FG484
M2GL005-1VF256I
M2GL060TS-FCSG325
M1AGL1000V5-FGG256
M2S005S-VFG256H0170
M1A3P400-2FGG144
M2GL050TS-1VF400I
M2GL025T-FCSG325I
APA450-FG484I
M1AFS1500-1FGG484K
APA600-PQG208IX95
APA450-WAFERLOT
AX1000-2FGG676I
M1AFS600-FGG484I
M1A3PE3000L-FGG484
M2GL025T-VF256
M2GL050-FCS325I
M2GL090TS-FCS325I
M2S005S-1VFG400I
M2GL050-FG896I
M2GL010-FGG484X456
M2GL025-FGG484I
M1AGL1000V2-CS281I
M2GL060TS-1FG484M
M2GL060TS-1VF400
M1A3PE3000-2FG896I
M1A3P400-2PQG208
M2GL060TS-FGG676
M2GL010TS-VF400
M2S005-1TQG144
M2GL090-1FCS325I
M1A3P400-2PQG208I
M2GL005S-1TQG144I
M2GL150-FCS536IX3
M1AFS1500-1FG256K
M2GL010T-1FG484MX399
M2GL060T-VFG400I
EX128-TQG64I
M1A3PE3000-1FGG484
M2GL150TS-1FCV484M
APA150-FG144A
M2GL150TS-1FC1152I
M2GL090TS-1FG484I
M2GL025TS-1FGG484M
M1AGL1000V2-FGG256

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M2GL090-1FCSG325I
M2GL010T-1FG484I
M1AGL600V5-FGG256
M1AFS1500-FG484I
APA150-FGG144X95
M2GL005S-1FGG484
AX1000-FG896
APA600-BG456M
M1A3P400-FGG256
M1AFS250-1FG256
M2GL090T-FCSG325
AX2000-1FG896
M2GL060T-FGG676
M2GL150TS-FCSG536
M2GL010-FG484X456
M2GL150TS-1FCG1152M
M1AFS250-FG256I
M2GL025TS-FGG484I
M2GL050-1FCSG325I
M1A3P1000-2FGG144
M2GL060T-1VFG400I
M1A3PE3000-FGG484
M1A3P600-FG484I
M1AFS600-1FG256
M1A3P1000-PQG208
M1A3PE3000-FG324I
M1AFS1500-FGG484I
M2GL150TS-FCVG484I
M2GL010T-1VF256
M2GL010-1TQG144
M1AGL600V2-FG256
M1A3P600-PQG208
M1A3PE3000L-FGG896I
EX64-TQ64I
M2GL025T-1FCSG325
M2GL025T-1FG484IX417
M1AGL600V2-FGG144I
APA600-FGG676I
EX256-TQG100I
M1A3PE3000L-1FGG484I
M1A3PE3000L-FGG896M
M2GL090-FGG676X456
M1A3P250-FG144I
M2GL005S-1VF256I
APA300-FG144
M1A3P1000-1FGG144
M2GL025-FG484I

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APA600-FGG484A
M2GL060TS-FG676
M2GL025-VFG400I
M2GL150TS-1FCV484I
M2S005-FGG484X486
EX256-TQG100IX94
M2GL050TS-1FCSG325I
M2GL010-1VF400
M1A3P600L-FGG144
M1A3P1000L-1FG144I
APA750-PQG208I
APA300-FGG256IX95
M2GL150TS-1FCS536
M2GL090-FG484IX417
M2GL060T-FGG484
M2GL050-FGG896X399
APA450-PQG208IX95
M2S005S-TQG144H0023
M2GL090-1FG484
M1A3PE1500-2FG676
M2GL090TS-1FG484M
M2GL050-FG484X456
M2GL010-FGG484I
APA450-FGG256IXV52
M1A3PE3000L-1FGG896
M1AGL1000V5-FGG484I
M2GL025-1FGG484T1X7
EX256-TQG100X376
M2GL150TS-1FCG1152I
APA075-PQG208
M2GL025TS-1VFG256T2
M1AGL600V2-CSG281
M1AGL1000V2-FG484
M1A3P600-FGG144I
M2GL060T-1FCSG325
APA075-TQG100I
M2GL010TS-1VFG256T2
M2S005S-VFG256H0245
AX500-FG484
M2S005S-1VF400
M2GL090TS-1FCSG325I
M1A3PE1500-1FGG676I
M2GL150-FCS536I
AX1000-1FGG484M
APA450-FG256IX458
M2GL025T-VFG256
M1A3PE3000L-FG484M

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M1AFS250-FGG256I
M2GL060-VF400I
M2GL050TS-FGG896I
M2GL025TS-1FG484I
AX250-FGG484
M2GL025-1VFG400
M2GL150-1FCV484
M2GL005-VFG256X416
M1A3P1000-1PQG208M
M2GL010TS-VFG400
AX1000-FG676
M2GL010T-1VFG256I
AX2000-1FG896M
M1A3P1000L-FGG256I
M2GL050T-1FCS325
M1A3PE3000-1FG484
M1A3P1000-1FG144M
EX64-PTQG64
M2GL150T-1FCG1152
M2GL060T-FGG484I
M1A3P600-1PQG208
M2S005-FGG484IX417
M1A3PE3000-FGG896
M2GL025T-1FG484MX417
M1AGL600V5-FGG144
M2GL005S-TQG144
M2GL010-FG484MX399
M1A3PE3000L-1FG484MX3
M2S005S-VFG256H0018
M1AGL1000V5-CSG281
M2S010-1FG484I
M2GL150T-1FCG1152M
M2GL060-1FCS325
M2GL090TS-1FG676I
M2GL025T-1VF256I
APA450-FG256A
M2GL060-1FGG676
M2GL010TS-1VF400I
M1A3P400-1FGG144I
M2S005-FG484I
M2S005S-TQG144H0037
M2GL090-FGG484
M1A3PE3000-1FG324
M2S005S-TQG144IX416
M2S005S-1VF256I
M1AFS600-1FG484K
M1A3PE3000L-PQG208I

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M2GL090-FG676X416
M1A3PE1500-1FG676I
M2GL050T-1VF400
M2GL090-1FGG484I
M2GL060TS-1FGG676T2
M2GL010-VFG256I
M2GL060-FGG676
M2GL010T-1VFG256
M2GL010-FGG484X416
M2S005S-VFG256X416
M2GL005-VFG256
APA150-FGG256A
M2GL010-VFG256X456
M2GL150T-1FC1152IX417
M1AFS600-FG484
M1AFS600-1FGG484I
AX250-PQ208I
M2GL010S-1TQG144T2
M1A3P1000L-1FG144
AX2000-2FG896I
M2GL090-1FCSG325
M2S005-TQG144X486
APA1000-BGG456
APA075-FGG144
M2S005S-VFG256H0154
M2GL050-1FCS325
M2S005S-TQG144H0232
M2GL090TS-FGG484I
M2GL050TS-1VF400
APA075-TQG144I
AX1000-1FGG676I
M2GL090-1FGG676
M2S005S-TQG144H0187
APA450-FG144
M2GL090TS-FG676
M2GL090-FGG484IX418
EX128-PTQG100I
M2GL060-1VFG400I
M2S005S-TQG144IH0055
AX500-1PQG208I
M1A3P1000L-FG144I
AX2000-1FGG896I
M2GL025T-1FGG484IX416
M1A3P400-2FG144
M2S005S-VFG256H0004
M2S005S-1VFG400
M1A3P1000-2FGG256I

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M2GL060TS-FCS325I
M2GL050T-FCS325I
M2GL010-VFG256
M2GL010TS-1FG484M
M2GL060TS-1FGG676
AX2000-1FG896IX6
AX250-FG256I
M1A3P400-2FG256
M2S005S-VFG256H0148
M1AGL600V5-FG144I
AX500-PQG208IX3
M2GL050T-1FGG896X417
AX250-FGG484I
AGLP060V2-CSG289
M1A3PE1500-1FG484I
M2S005S-TQG144H0225
AX500-FG484M
M1A3PE3000-2FG484I
M1A3P600-FGG144
M2GL025-VFG400X456
M1AFS600-2FGG484I
M2GL090TS-1FGG676T2
M2S005S-VFG256IH0116
APA075-FG144I
M2GL005S-1VFG256T2
M1A3P400-1PQG208I
AX1000-2FGG484
M2S005S-TQG144X416
M2S005S-VFG256H0190
M1A3P600-2FGG144
APA450-FGG484X354
M2S005S-VFG256H0189
AX500-FGG484I
APA450-BG456I
M1A3PE3000-1FGG484I
APA300-WAFERLOT
M2GL005-1FG484
APA300-FG256I
M2GL010-1FGG484T1
M1AGL1000V5-FG144
M2GL090T-FG484
M2GL050T-1FGG896IX417
M2GL090TS-FGG484
AX500-1PQG208M
M1AGL250V2-FGG144I
AX250-1FG484
M1A3P600-2PQG208

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M2GL150-1FCS536
M2GL090-1FGG676I
AGLP060V2-CSG201I
M2GL150-1FC1152
APA600-FG484
M1A3P1000L-FGG256
M2GL090T-FG676
M2GL060T-VF400I
M1A3PE3000-2FGG484
M1AFS600-FGG256
M2GL010-FGG484X417
M2GL150TS-FCV484I
APA600-FG256I
M2GL050TS-1FGG484M
M2GL025T-1VF400I
M2S010-1FG484
EX64-TQG64A
M2GL025-FGG484X456
M2GL025TS-FCSG325I
M2S005S-VFG256IH0194
M2GL010T-VFG256
M1AGL1000V2-CS281
APA1000-PQG208A
M2GL005-VFG400I
APA450-FGG256IQ303
M2GL150-FCVG484IX475
M2GL025-VF400IX3
M2GL005S-VFG256I
M2GL005S-VF256
M2GL050T-1FG484MX440
AX1000-1FG676
M2S005S-VFG256H0083
M2GL005-1VF400I
APA300-PQG208
EX128-PTQG64I
M2GL060-1VFG400
M2GL010T-VF256
M2GL005S-VF400I
M2S005-VFG400
M2GL050TS-FCSG325I
M2GL090T-1FCS325I
M2GL010-VFG400IX413
M1AGLE3000V5-FG484
M2S005S-TQG144IH0054
M1AGL250V2-VQ100I
M2GL010-VF400I
M2GL025TS-VF256

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M2GL060TS-1FCS325I
AX500-2PQG208I
AX500-PQG208I
AGLP125V5-CSG281I
M2S005-1FG484I
M2GL025T-FGG484
M2GL005-1VFG256I
M2GL025TS-1FCSG325
M2S005S-VFG256H0177
M1A3P1000L-FG144
AX250-1FGG256
AX500-PQG208
M2GL050TS-VF400
M2GL060TS-FG484
M2GL025-VFG400IX416
M1A3PE1500-1PQG208
AX1000-FGG484M
M2GL010T-VF400
APA750-BGG456I
M2GL090T-1FG484MX6
M2GL090TS-1FCS325
APA300-BGG456I
M2GL010T-FGG484X416
M1A3P1000-FG144
APA450-FGG484I
M1A3P1000-2FG256I
APA1000-BG456M
M2GL060T-1FG676
M1A3P1000L-1FGG256
M2GL010-1FG484IX417
M2S005S-VF256
M2GL025T-1FGG484M
M2GL150-1FCG1152IX417
APA300-BG456I
M1AFS1500-1FG484K
AX2000-FGG896M
APA300-FGG144
M1AFS1500-FGG484
M2S005S-TQG144H0040
M2GL025-VFG400
M2S005S-VFG256H0149
APA300-FG256
M1AGL600V5-CS281
APA300-BGG456
AX250-FG484
M2GL050TS-1FG484
M2S005-1VFG400

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M2GL025-1FCSG325I
APA600-BGG456M
M1AGL1000V2-FG256
EX128-TQG64A
APA300-FG144I
M2GL090TS-FGG676I
APA600-BG456I
M1A3P250-1FGG144
M2S005S-TQG144H0006
M2GL060T-1FG484M
M1A3P250-2VQ100
M2S005S-TQG144H0002
M1A3P600-2FG484I
AX500-2FG484I
AGLP125V2-CS281I
M2GL010TS-1FGG484M
APA150-TQG100
M1A3P600-FG144I
M2GL005-FGG484IX399
M2S005-VF256I
M2GL050TS-FCS325
M2GL025TS-1FCS325I
M1AGL1000V2-FGG256I
M2GL150T-1FCSG536I
M2GL010T-VFG256I
M2GL025T-1FG484MX471
M2GL010T-VFG400
M1AGL250V5-VQG100
M2S005-1FGG484
M2GL025T-FCS325I
AX2000-FGG896I
M2GL090-FG676I
M2S005S-1VFG256I
APA450-FGG144A
M2S005S-1FG484I
M1A3P1000-2FGG256
M2S005S-TQG144
M2GL050T-VF400
M1A3P600-2FGG484
M1A3P1000-1FG144I
M1A3P250-VQ100
M1AGL600V2-FGG256I
M2GL025-VF256X456
M1A3PE3000L-1FGG484M
M2GL010TS-VF256
M1AGL600V5-CS281I
M1A3P400-FGG144I

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M2GL025-1VFG256I
M1A3P600-2FGG484I
M2GL050T-1FG896
M1A3P400-FG256
AX500-PQG208M
M2GL025TS-VF256I
M1A3PE1500-2FGG676
M2GL150T-FCV484
M2S005S-VFG256IS0014
APA300-FGG256
M2GL010-VFG400
M1A3P600L-FGG484
M2GL005S-1TQG144T2
M2GL010T-1FG484
M2GL050TS-FG896
M1A3PE3000L-FG484I
M2GL090TS-1FG676
M2GL150-1FCSG536
AX1000-1FGG676
M1A3P400-1FG144
M1AFS600-2FGG484
EX64-FTQG64
M2GL150T-1FCVG484
M1A3P600L-1FGG144I
AX250-2FGG256I
APA300-FG256IX94
M1AFS1500-2FGG256I
M1A3PE1500-FGG484
APA450-BG456
M1AGL1000V5-FGG144I
M2GL050T-FG896I
M1AFS1500-FGG256K
M1A3PE3000-1PQG208
AGLP060V2-CS289I
M2GL150-1FCV484I
M1A3PE1500-FGG676
AGLP125V5-CS281
M1A3P600-FGG484
M2S005S-VFG256H0234
M2GL150T-FCS536I
EX128-TQ100
M1A3P250-PQG208
M2GL005-TQG144X417
M2GL050TS-FCS325I
M2S005-VFG256I
M2GL060-FG484X456
M2GL090T-1FGG484I

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M1AGLE3000V2-FG484I
M2S005-VFG256
M2S005S-FGG484I
M2GL010T-1VFG400I
M2GL025T-FGG484X417
EX256-TQG100PJ31
M1AGL600V5-CSG281I
M2GL090T-1FG676
M1A3P600-1FG484
M2GL010TS-1VFG400
M2GL060-FCSG325
M2GL025TS-VF400
M1A3PE3000-2FGG896
M2S005S-TQG144H0033
AX1000-2FG676
M1A3P400-1FGG144
AX250-1FG256
M1A3PE3000-FG896I
M2GL005S-VFG400
M1A3P400-1PQG208
APA450-PQG208
M2GL010TS-FGG484
APA450-FG256
M2GL010-VF400
M2GL050T-FGG484
M1A3P250-2PQG208I
M1AGL1000V5-FG256
M1A3PE3000-2FG324I
M2GL005S-VF400
APA075-PQG208I
M2GL005-FGG484IX416
M2GL150T-1FC1152MX441
M2GL025TS-VF400I
M2S005S-1FG484
M1AFS1500-FG256
M1A3PE1500-FG676
M1A3P1000-1FG144
AX1000-FGG676I
APA300-BGG456M
APA300-FGG256A
M2GL150T-1FCG1152I
M2GL090-1FCS325
M2GL025TS-1VFG256
M2GL090T-1FGG676
M2GL090T-FCS325I
APA300-FG144IX3
M2GL010-FG484

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AGLP125V5-CSG281
M1A3P250-VQG100I
M1A3P600L-FG144I
M1A3PE1500-1FGG484I
M1A3P1000-FG484I
M1AFS600-1FGG256I
M2GL060-FG484
M1A3P250-1FG144
M2S005-1VFG256
AGLP060V5-CS289I
M1A3P1000-1FG256
APA075-FGG144I
M2GL150T-FCVG484
AGLP060V5-CSG289I
M2GL050T-1FGG484
APA300-FG144M
M1A3PE3000-FG324
M1A3P1000-FG144M
M1A3P1000-1FGG144M
M2GL060T-1FCSG325I
M2S005S-VFG256H0120
M2GL060T-1FG484MX399
AGLP030V5-CSG201I
M1A3P1000-FGG484I
M1AFS600-2FG484I
APA750-BG456IX95
M2GL090TS-FGG676
M2GL010S-1TQG144IX28
M2GL025-FGG484
M1AFS600-2FG484
M2GL060-VFG400I
M2GL150TS-FCG1152I
M2GL090T-1FGG676IX418
M1A3P600L-1FGG484I
M2GL005-VF256X456
M2GL050T-FG484
M2GL090TS-1FGG484M
M2GL005-FGG484
M2GL050TS-1VFG400I
M2GL010T-1FGG484IX418
AX1000-FG484
AX1000-1FG676I
M1A3P400-FG256I
M1A3P250-FGG144I
M1A3PE3000L-PQG208
M2GL150T-1FCS536
M1A3P400-FG144I

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APA450-FGG256IQ300
APA600-FG484I
M2GL005S-1VFG400
APA075-FGG144A
M1A3PE3000-2PQG208
M2S005S-VFG256IH0048
M1A3PE1500-2FGG484I
M2GL090-1FGG676IX417
M1A3P600-FGG256I
M2GL060-1FGG484
APA300-FGG256I
M1AGL1000V2-FGG484
M1AFS1500-FG256K
M1A3P600-1FG144I
M2GL010-TQG144I
APA600-PQG208
M2GL090T-FGG484
M1A3P250-2PQG208
APA300-PQG208IX95
M2GL025T-1VFG400
M2GL050-VF400
M2GL050T-1FG484
AX250-2FG256
AGLP030V5-VQG128
M2S005S-VFG256H0030
M2GL050T-1FCS325I
M2GL090-FGG676I
M2GL025-VFG256
M2GL150-FCV484
AGLP125V5-CS281I
M1A3P250-2VQG100
M2GL010TS-1VF256I
M1A3P600-FG256
AX1000-1FGG484
M1A3P1000-1FG484I
M2GL025TS-1VFG400T2
EX64-TQG64I
AGLP125V2-CS281
APA1000-FG896A
M2GL150T-1FC1152MX3
M2GL060T-1VF400I
M2GL060-1FG676I
M1AFS1500-1FGG484
M1A3P600-2FGG256
APA1000-FGG896M
M1A3P600-2FG484
M2GL050T-1FG484MX512

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M2GL150TS-1FCSG536
AX1000-2FGG676
M2GL050-1FG484
M1AGL600V2-CSG281I
M2GL025T-VFG400
M2GL150-1FCG1152I
M2GL150T-1FC1152
M2GL025-FG484X456
M2S005S-VF256I
M2GL060-FG676
M1AFS1500-FGG256I
APA450-FG484
AGLP060V2-VQG176
M2GL090-FG484X456
M1A3PE3000L-FGG484I
M2GL010-VF400X416
M2S005-FGG484X456
M2GL010TS-FG484
M2GL025-FCS325I
M2GL005-FGG484IX377
M2GL005S-FG484I
M2GL090T-FGG676I
AX250-PQG208
M1A3PE3000-1FG324I
APA150-FGG144I
M2S005S-TQG144H0247
M2S005S-VFG400I
M1A3P600-1PQG208I
AX250-FGG256I
M2GL025T-1FGG484I
M1AGL600V2-FGG256
AX250-1FG484I
M2GL025-1VFG400I
M2GL005S-1FG484I
M2GL010S-1TQG144
AX2000-FG896
M2GL005-1FG484IX417
AX125-FG256
M1A3P1000-1FG256I
AX1000-2FG676I
APA1000-PQG208M
M2GL005-VF256I
M2GL025-FG484IX456
AGLP060V5-VQG176I
M2GL050T-FGG896I
M2GL060-FG484I
M2GL150-FCG1152I

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M1A3P1000-2FGG484I
M1A3P1000L-FG256I
M2GL005-VF256IX417
M2GL090T-1FCS325
M2GL025-1FGG484I
M1A3P600-2FG144I
APA300-FG144A
AX250-2FGG256
M1AFS600-FG484I
M2S005S-TQG144IH0078
AX2000-1FG896IX218
M2GL025T-FCS325
M1A3PE3000-1FGG324I
M2S005-VF256X456
APA075-FG144
M2S005-FGG484X417
M2S005S-VFG256H0045
M2GL150TS-FCG1152
M2GL025-1FG484I
APA600-FGG256
M2GL150TS-FCVG484
M1A3P1000-FGG484
M2S005S-TQG144IH0064
M1A3P600L-1FG484I
M2GL060TS-VFG400
M1AFS250-FGG256
M2S005S-VFG256IH0156
APA300-PQG208MX462
M2GL025TS-1FGG484I
M2GL050T-1FGG896X453
M2GL060-1FG676
M2S005-1VFG256I
M2GL060T-FGG676I
AX1000-1FG676M
APA600-WAFERLOT
M1A3PE3000L-1FGG896I
M2GL005-VFG256I
M1AGL1000V5-FG144I
M1A3P600L-1FG144I
M2GL005-FG484
M2GL060-1FCSG325
M2GL150TS-FCSG536I
AX250-FG256
M2GL150-FCVG484I
M2GL010T-1FGG484I
M1A3P400-PQG208I
M2GL050-FGG484I

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M2GL050T-1FG484I
M2GL050TS-FGG484
M2S005S-VFG256H0099
M2GL010-VFG400X416
M1A3PE3000L-1FG484
M1AGL600V2-CS281
M2GL050-FG484X413
M2GL025-1VF256
M1A3PE1500-1FGG676
M2GL010-1VFG256IX418
M2GL090T-FGG484I
M2GL010-VFG400IX416
M1A3P250-1VQ100
M2S005S-1VFG400T2
M1AFS1500-1FG484I
M2GL010T-FG484
APA075-TQG144
M2GL060T-1FG484I
M2S005S-VFG256H0051
M1AFS1500-2FG484I
APA600-FG676
M2GL060TS-1FGG484I
M2GL150-1FCVG484
APA450-FGG256IQ305
M1A3P1000-1FGG484I
M2GL090-1FGG484T1
APA300-PQG208A
AX250-1FGG256M
AX1000-FGG484I
APA300-FG256IX95
M2S005S-VFG256H0109
M2GL025-1FGG484
AX1000-FGG896
M2GL150T-1FCSG536
M1AFS600-1FGG484
M2GL060TS-1FGG484M
M2GL050-1VF400I
APA300-FG256M
M2GL025T-1FG484MX3
M2GL025-1VF256I
APA300-FG144IX6
M2GL150T-FCSG536I
APA600-FG484A
M2GL050TS-1FG896I
M1AGL600V2-FG144I
M2GL050-FG484I
M2S005S-VFG256H0021

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M2GL005S-VFG400I
M1A3P600L-FG484
M2GL090TS-1FGG676
M2GL090T-1FGG676I
APA1000-FGG896A
M2GL025TS-FGG484
M2GL090-1FG484IX417
M1A3PE3000-FGG324
M2GL090-FGG484IX417
M2GL090-FGG484X456
AGLP060V5-CS289
M2S005S-VFG256H0221
M2GL050T-1FGG896X416
M2GL025T-1FG484MX488
M1AFS600-FG256I
M2GL150-FCSG536
M2GL150TS-1FCSG536I
M2S005S-VFG256I
M2GL060TS-VFG400I
APA450-FGG484A
M1A3P600L-1FGG144
M1AFS600-1FG256I
M1A3PE3000-PQG208
APA1000-BGG456I
M2GL025TS-1FG484
APA300-BG456M
AX500-2FG484
M1A3P250-1PQG208I
APA1000-BG456IX95
M1A3P250-1PQG208
M1A3P600L-FGG144I
M2GL060T-1VF400
M1AGL1000V2-FGG484I
M2GL050TS-1FCSG325
M2GL010-1FGG484I
M2GL050TS-1FGG484
M1AFS600-FGG484
M1A3PE3000-2FGG324I
M2GL025-1FG484IX417
M2GL050TS-FGG896
M1AGL250V2-FG144
M2GL005S-1VFG256
M2GL050TS-FCSG325
AX250-2FGG484
M1AFS1500-FGG484K
M1A3PE3000-FG896
M1A3P600-1FGG144I

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M2GL050TS-1FCS325
M2GL050T-1VF400I
M2GL025T-VF256I
APA300-PQG208M
EX64-FTQG64PL56
M2S005-VFG400IX516
M2S005S-VFG256H0243
EX128-TQ64I
M2GL010S-TQG144I
AX250-1FGG484M
M2GL060-FGG676I
M2S005S-TQG144IH0062
M2GL050T-1FGG484X452
M1A3PE3000L-1PQG208I
M1A3P1000L-1FGG256I
M2S005S-1VFG256
M2GL060-FGG484I
M2GL025TS-FG484I
M2GL060-VFG400
M2GL005-1FGG484T1
M1A3P250-1VQG100
M2GL010-TQG144
M2GL050TS-VFG400I
AGLP125V2-CS289I
M2GL060-1FG484I
APA600-FGG256M
AX1000-FGG676
M2GL060T-1FGG484I
M2GL050T-1VFG400
M1A3P400-PQG208
APA075-PQG208IX3
M2GL005S-1VFG400I
APA600-FG676I
M2S005-VFG400X456
M2GL050-VFG400I
M2GL090-FG484
M2GL025-FCSG325
AX2000-FG896IX218
M1AFS600-1FG256K
M2GL010T-VF400I
M2GL050T-1VFG400I
M2S005S-FGG484IX417
AX250-1FG256I
M2S005-VFG256X486
AGLP060V2-CSG289I
M2GL150T-FCS536
M2GL005S-FGG484I

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M2S005S-1VF400I
AX1000-2FG484
AX250-1FGG484I
EX128-FTQG100
M1A3P400-1FG256
AX1000-FG896M
M2GL050T-FGG896
M1A3P250-2FGG144
APA750-BG456I
M1A3PE3000-2PQG208I
AGLP060V2-CSG201
M1AFS1500-2FG484
M2S005-TQG144IX416
M1A3P400-2FGG256I
AX250-FGG256M
M2GL090T-1FCSG325
M1A3P250-1FG144I
M2GL090-FGG676
M1A3PE1500-2FG484
APA300-FGG144A
M2GL010T-1FGG484
M1AGL1000V5-FGG256I
M2GL090T-1FG484I
M2GL150-FC1152
M1AGL600V5-FG256I
M2S005S-VFG256H0215
M1A3P250-2FG144I
APA600-FGG484I
M2GL050TS-1FG484M
AX2000-2FG896
M2GL060T-1FGG484M
M2GL050T-FGG484I
M2GL060T-FG676I
M2GL025T-1VFG400I
M2GL060TS-1FG484I
M2GL090T-FG676I
M2GL025-VF400
M2GL025-1FG484
M1AGL1000V2-FGG144
M2GL005S-1FG484
EX128-TQG100
EX128-TQG100A
M2GL010T-1VF400
AGLP125V2-CSG281I
M2GL010T-1FGG484X416
APA300-FGG256M
APA750-BG456

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M1AFS600-1FGG256K
M2GL025TS-VFG256I
M1A3P400-FG144
M1A3PE3000L-FGG896
M1AFS1500-1FGG256
M1AGL600V5-FGG144I
M2GL050-1FGG484I
M2GL010TS-VF256I
M2GL010T-VF256I
AX250-FGG256
M2GL090T-1FG484MX418
M1A3P1000-2PQG208
M1AFS600-1FGG256
M2GL010-FGG484X440
M1A3PE1500-FGG676I
M1AFS1500-FG256I
M2GL025T-FG484I
M1A3P600-1FG144
AGLP030V5-VQG128Z231
M2GL010TS-1VFG400T2
M2GL090-FG676
APA600-FGG256IX95
AX1000-1FG484I
AGLP030V5-CSG201
M1AGLE3000V2-FG484
AX250-2FG256I
M2S005S-1VFG256T2
M1A3PE1500-1FG676
M2GL150-FCV484I
M2S005S-TQG144IH0073
M2GL150-FCG1152
M1AFS250-2FG256I
M2GL050TS-FG896I
M2GL025-1FGG484X417
M2GL150-1FCVG484I
M2GL060T-1FCS325
APA600-FGG256I
M1A3P250-2FG144
M2S005S-TQG144H0191
M1A3P600-FG484
APA150-TQG100PJ87
APA750-BGG456
M2GL090TS-1FGG676I
M1A3PE3000L-FG896M
EX128-FTQ64Q187
M1AFS600-1FG484I
M2GL060TS-FG484I

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M2GL025TS-1VF400
M2S005-FGG484I
M1A3PE1500-FG484
M2GL025TS-1FCSG325I
AX500-1FG484M
M2S005S-VFG256H0007
EX256-PTQG100
APA075-FGG144IXN42
M1A3P600-2FG256
M2GL050T-FCSG325I
M2GL150TS-1FCV484
APA150-FG256A
M1A3P600-PQG208I
M2S005S-VFG256
AX1000-1FG896M
M2GL005-FG484IX416
EX128-PTQG100
M1AFS250-1FG256I
M1AGL250V2-FG144I
M2GL050TS-1FCS325I
M1A3P1000-1FGG144I
M2S005S-VF256X416
M2GL005-VF400I
M2GL010TS-1VF400
APA450-FGG256A
M1A3P400-2FGG256
M1A3PE1500-FG484I
M2GL025TS-1VFG400
M1A3P1000-FG484
M2GL060T-1FCS325I
M1AFS1500-1FGG484I
M1A3PE3000L-1PQG208
APA600-BGG456
M2GL050TS-FG484I
M1A3P1000-1PQG208
M2GL090T-FCSG325I
AX250-1FGG484
M1A3P1000-2FG256
M2S005S-FGG484
M1A3PE3000L-1FGG896M
M2GL025-FG484IX399
M2GL060-1FG484
M2S005-VFG256IZ049
M2GL005-TQG144
M2GL050T-1FCSG325
M2GL050T-1FG896I
M1AGL1000V5-FG484

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M2GL050-1VF400
APA150-FGG256
M2GL050-FG896
M2GL025-1VF400
M2GL060-1FGG676I
M2S005S-1FGG484
EX128-TQ64
M2GL025-VF256
APA150-FGG144A
M1A3PE1500-FGG484I
APA450-PQG208I
M2GL090TS-FG484
M2GL050-FCSG325I
APA600-BG456IX95
M2GL010TS-1VFG256
M1AGL250V2-FGG144
M2GL050T-1FG484MX399
M1A3PE1500-1PQG208I
M2GL090T-FGG676
APA450-FGG256I
M1A3PE3000L-FG896I
M2GL060-VF400
M2S005S-TQG144H0091
AX1000-FG484M
AX2000-1FGG896
M2S005S-TQG144H0050
M2S005S-VFG256H0224
M1A3P1000-1FGG484
APA150-PQG208I
AX250-1FGG256I
M1A3P600-1FG256I
M1A3P1000L-FGG144
M2S005-VF400I
APA150-FG256I
M1A3P400-2FGG144I
M2S005S-TQG144IH0074
M2GL025-1FGG484T1
M2GL005S-1FGG484T2
M2GL005-FGG484I
M2GL005-1TQG144
M2GL060-FGG676X456
M2GL060TS-1FG484
M2GL060-FCSG325I
M2GL025T-1VFG256
M2GL150T-FCG1152
AGLP125V2-CS289
M2GL050T-1FGG484M

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APA300-FG256A
AGLP125V2-CSG289I
M2GL150T-FCV484I
M2GL010TS-1VFG400I
AX500-1FG484I
M2GL025-1VFG256
M2GL025-1FCS325I
M1AGL1000V5-FGG484
M2S005S-1TQG144
M2S005-FGG484
APA075-TQG100A
APA075-PQG208IPN15
M1A3P1000-1FGG256I
M2S005-VFG256IX416
M2GL010TS-1FGG484T2
M1A3PE3000-1FG896I
M1A3P1000-1FG484
M1AFS1500-2FGG484I
AX1000-FG484I
M2S005S-1TQG144T2
M2GL060TS-VF400
M2GL060T-FCS325I
APA150-FGG256I
M1A3PE3000-1FGG896I
M2GL090-FGG484I
M1AGL600V2-CS281I
APA600-FG256IX95
M2GL050T-1FG484M
M2GL090TS-1FGG484IX416
M1A3P250-1VQ100I
M1AFS600-1FG484
M2GL050-1VFG400I
APA300-FGG144M
M1AFS250-FG256
AX2000-1FGG896IX218
M1A3PE1500-1FG484
EX64-TQ64
M2GL005S-VFG256
M1AFS1500-2FG256I
M2GL150-1FCSG536I
APA750-PQG208A
M1A3P250-2VQ100I
M2GL005-TQG144I
M2GL025T-FCSG325
M1AFS600-2FGG256I
M2GL060TS-1FG676
M2GL005-TQG144IX6

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APA600-FG256M
AX250-1FG256M
M2GL010-FGG484X413
M2S005S-VF400
M2GL090TS-FG676I
M2S005-VF256
APA450-FGG256IQ301
M2GL150T-FCSG536
M2GL005S-TQG144I
EX128-TQG100I
M1AGL600V5-FGG256I
M1A3P600L-1FG144
M1A3P1000-FGG144
M2GL010T-FGG484
M2GL025TS-1FGG484
M2GL060T-1FG484
M2S005-TQG144I
M1A3P1000-2FG484
AX2000-2FGG896
M2GL025-VFG256X456
M2GL005S-1VFG400T2
AX250-FGG484M
AX250-2FGG484I
M2GL150-FCVG484
M1AGL1000V5-CS281I
M2GL005S-1FGG484I
AX2000-FGG896
M2S005-1FGG484I
M2GL010TS-1VFG256I
EX256-FTQG100
M2GL050T-1FGG896
M2GL005S-FG484
AX1000-1FG484M
APA1000-PQG208I
M2GL050T-VFG400I
M1AGL600V5-FG256
M2GL050-FGG896X377
M2S005S-VFG256H0244
M2GL010-VF256
M2GL010TS-FG484I
APA1000-PQG208
M1A3P1000-FG144I
M2GL010T-1FG484MX418
APA300-FGG144I
APA450-FG484A
AX1000-2FGG484I
M2S005S-VFG256H0175

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M2GL060-FG676I
AGLP060V5-VQG176
AX250-1FG484M
M1AFS600-1FGG484K
APA300-BG456
M2GL010-1TQG144I
M1AFS600-FG256K
M2GL050TS-1VFG400
M1A3PE3000-2FGG896I
M2GL060-FCS325
M1A3P400-2FG144I
M2S005S-VFG256H0011
M2GL150T-1FC1152I
AGLP125V2-CSG289
M2GL050-FCS325
AX1000-1FGG896M
M2GL025T-VFG400I
APA300-FG144IX94
M2GL005S-1TQG144
M2GL090-FCS325
M2GL090T-1FG676I
M1A3PE3000-1FGG896
M1AFS1500-FGG256
M1A3PE3000-FG484I
M2GL090-FCSG325
M1A3P600L-FGG484I
APA450-FG144A
M2GL150TS-FC1152I
M2S005S-VFG256H0128
APA450-PQG208X354
M1A3PE1500-2FGG676I
AX1000-1FGG676M
M2S005S-TQG144H0027
M1AFS1500-1FGG256I
M1A3P600-FG256I
M1A3P1000L-1FGG144
M2GL150TS-1FCVG484
M1A3PE3000-FGG324I
M2GL010T-FGG484I
M2GL050T-VFG400
M2GL060T-VF400
APA600-FGG676
M2GL150T-1FCS536I
M1AGL600V5-CSG281
M1A3P1000-2FGG144I
M1AGL1000V5-CSG281I
M2S005-1TQG144I

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M2S005-1FG484
M1AGL600V2-FGG144
M1A3P1000L-FG256
M2GL050TS-1FGG484I
M2GL090-1FGG484
APA600-BG456
M2GL025T-1VFG256I
M2GL050TS-VFG400
M1AGL1000V5-FG256I
APA600-FGG256A
M1A3P250-2FGG144I
M2GL025-VF400I
AX250-PQG208M
M1AGLE3000V5-FGG484I
M2GL010TS-1VF256
M1A3P600L-1FG484
M2GL050T-FCS325
EX256-TQ100I
M2S005S-VFG256IS0020
M2GL010T-FGG484IX377
APA1000-BG456I
M2GL060T-FG484
M2GL090-FG484I
M2GL010TS-1FG484
M2GL010-1VF400I
APA150-PQG208A
M2GL150T-1FCV484M
APA450-FGG256IQ304
M2GL050T-1FCSG325I
M2GL010TS-VFG256I
M2S005-FG484
AX2000-FG896M
APA600-FG256IXK91
M2GL090T-FG484I
AX2000-2FGG896I
AGLP060V2-CS289
M1A3P1000-FGG256
M1A3PE3000L-1FG896M
M1AGLE3000V2-FGG484I
M2GL060-FG676X456
APA450-FGG256
M2GL005-FG484I
M2GL060T-VFG400
A3P250-2FGG144
A40MX02-PQG100A
A42MX09-2PQG160
AGL1000V5-CS281I

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A42MX16-PLG84
A54SX32A-TQG100I
A3P400-1FG144I
A54SX72A-PQG208
AGL400V5-CSG196IX45
A3PN060-2VQG100Q117
A42MX09-3PQG100I
A40MX02-FPQG100
A42MX24-PL84I
AFS250-1FG256I
A54SX32-1PQG208
AGL1000V5-FG256
A3PE600-1FG256
A40MX04-2PQG100
A42MX09-PLG84A
A3PE3000L-PQ208I
A3PE600-1FG484I
A54SX32-1BGG329
A3PE1500-FG676I
A42MX09-3PLG84I
AFS1500-1FGG256I
AGL1000V2-FG144
A3P250-1VQG100
A3P125-2FG144
A54SX16P-TQG176
A3P125-FG144
AGLN010V2-QNG48IX11
A54SX16-1TQG176
A3P250-FGG256T
A3PE600-2FG256
AGLN250V2-VQG100PZ03
A3PE600-1FGG256
A3PN125-VQG100IQ153
A42MX09-WAFERLOT
A3P600-1PQG208I
AGL600V2-FG256
A54SX16A-PQG208A
AGL030V2-VQ100
AFS1500-2FGG256
A42MX36-PQG208
A42MX16-PQG208A
A3PN020-QNG68
A3PN060-VQG100IX94
A54SX32A-1BGG329I
AGLN250V2-ZCSG81I
A54SX32A-2PQG208IX94
A42MX24-3PQG160

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A40MX04-FPL44
A3P250-PQG208I
AFS1500-FGG256X52
A54SX32-1PQG208M
A54SX72A-FG484M
A3PE3000-2FGG324I
A3PE3000L-FG484M
A3PN125-VQ100
A42MX36-PQG240IQ041
A3P250-WAFERLOT
AGL060V5-VQ100
A3P250-VQG100T
A54SX32A-1BG329I
A3P400-1PQG208IX3
A42MX16-PQG100M
A40MX04-PQG100I
A40MX04-3VQG80I
A42MX16-2VQG100
AGL125V2-FGG144I
A54SX16A-2TQG100
AGLN125V2-CSG81
A3PE1500-1PQG208I
A3PE3000-2FG324ID
A40MX04-3PLG68
A3P600L-1FG484I
A54SX16A-TQG144
A3PE3000L-1FG324I
A54SX32A-2BG329
A54SX16A-FTQG144
A3PN125-WAFERLOT
A42MX16-VQG100
AGL400V5-FGG144
A3P125-1VQ100
A42MX09-VQ100M
A54SX32A-BG329M
A54SX32A-PQG208
A40MX04-1PLG84M
AGLN010V5-UCG36
A3PE1500-2FGG676
A3P400-PQ208
A3PN250-VQG100ORT
A54SX32A-PQG208IX45
AGL125V5-CSG196I
A3PE600-FG256I
A3P250-PQG208X277
A42MX16-PQ100M
A40MX02-2VQG80I

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A54SX08A-TQG100
AGLN060V2-CSG81I
A3P250-VQ100I
A40MX02-1PLG44I
A3PE3000-2PQ208I
A42MX09-1TQG176I
A3PE3000L-1FG896M
A3PE3000-FGG896I
AGL030V5-QNG48IX94
A40MX04-1PQG100
AGL1000V5-FGG256I
AGL600V5-FGG256
AGL600V5-WAFERLOT
A40MX04-PL44M
A42MX24-2PLG84I
A3P600-2PQ208I
AGL125V2-FGG144
A3P600-2FG256I
A3PN125-1VQ100I
AGLE600V5-FGG484
A42MX24-1PQG160
A54SX72A-1FGG484M
A42MX24-1PLG84M
A3P600-2FGG484
AGLN060V2-WAFERLOT
AGLN060V2-ZVQG100I
A54SX72A-FGG484A
A3PE3000L-FG896I
A54SX32-PQG208
A54SX32A-1TQG144
A42MX24-FTQG176
AGL400V5-WAFERLOT
A42MX09-VQG100I
AGL600V2-CSG281
AFS600-1FG484I
A3PE3000L-1FGG484IX3
A40MX02-1PLG44
A54SX72A-1FG256M
A54SX32A-FPQG208
AGLE3000V5-FG484I
A54SX32A-2TQG100
A42MX09-2PQ100I
AGL125V5-FGG144
A3PN060-WAFERLOT
AGLN250V2-ZCSG81
A42MX09-PQG160A
A3PN030-ZVQG100I

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A54SX32A-1BG329
A3PE1500-1PQ208I
A3PE3000-FGG896IX218
A40MX04-PLG68
A3PE1500-PQ208
A3P600L-1FG484
A54SX32A-BG329I
A3P250-1FGG144T
A42MX16-3PQG160I
A3P600-2PQG208I
A40MX04-PL68I
A3PN015-QNG68
AGL015V2-QNG68
A40MX02-PLG44
A3PN125-1VQ100
A42MX24-TQG176M
AGLN060V5-ZVQ100I
A40MX02-PLG68A
AGLN250V5-CSG81I
A3PN125-1VQG100I
A40MX04-FPLG44
A3PN010-QNG48I
A54SX32A-FGG256M
A3PN125-VQG100IQ157
AFS1500-FG256
A54SX32A-1FGG256I
AGL400V5-CSG196I
A42MX16-1VQ100I
A3PE3000-1FGG896
A42MX24-3PLG84I
AGL250V5-WAFERLOT
A54SX08A-1TQG100I
AGL1000V2-FGG484I
AGL125V5-CSG196
A42MX16-PQG160
A3P250-FGG256GW
A40MX02-PQG100
AGL060V5-CSG121I
A3PE3000L-1FGG324I
A3PE3000L-1FG324ID
AFS1500-FGG256IW
A3PE600L-1FGG484M
A3PE3000L-1FGG484ID
A54SX32-BGG329I
A40MX04-1VQG80
AGL600V2-CS281
A42MX36-PQG208IPY73

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A42MX16-2PQG208I
A3PE3000-1PQG208IX507
AFS1500-FGG256I
AGL400V2-FGG144
A40MX02-1PLG68M
AGLN250V2-CSG81I
A3PN250-ZVQG100I
A3P400-1FG256I
AGL060V2-VQ100
A3P125-VQG100T
A40MX04-PLG84IPW61
AFS1500-1FGG484I
AFS1500-FG256I
A3PE1500-PQG208IX6
A3PN060-VQ100
AFS250-2FG256
A40MX02-PL68
AGLN250V2-VQG100
AGL030V2-QNG68
A3PN125-VQ100I
A40MX04-1PLG44
A42MX36-1BG272
A3PE3000L-1FG484MX23
AGL1000V5-CSG281
A42MX09-1PL84
A54SX72A-FFGG256
A54SX72A-FFG484
AGL1000V5-FGG144
A40MX04-PQ100
A3P400-1FG144
AGLN250V5-CSG81
A54SX16P-2TQG176I
A3PN010-1QNG48I
A40MX04-2VQG80I
A42MX16-3VQG100
A3P125-VQ100I
A3PE1500-PQG208I
A40MX04-PLG84IPW59
A3PE3000-FGG484
A3PE1500-FG484
A54SX32A-1TQG100M
A3P600-FGG144
AGLN020V2-CSG81I
A3PN250-1VQ100
A3PE600L-FGG484M
AGLN060V5-VQ100IX28
A54SX16A-1TQG144I

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A54SX72A-FGG256M
AGL060V5-VQG100I
A42MX36-BGG272M
A3P250-VQ100
A3P600-FGG256I
A3PE1500-FGG676
A3PE600-2FG256I
A3P600-2FG256
A54SX16P-1PQG208
A3P400-PQ208I
A42MX09-FPQG160
AFS250-2FG256I
A3P600-1FGG256I
AGL250V2-FGG144I
A3PN250-ZVQG100
A42MX16-3PLG84
A3P250-FG256I
A3PN125-ZVQG100I
A3PN015-QNG68I
AFS1500-2FG256I
A3P125-VQG100
A3P250-2VQG100I
AFS1500-2FG256IX94
A3PN250-VQ100
AGLN010V5-UCG36I
A42MX16-1PLG84M
A3PN060-2VQ100I
A3PE3000-2FG896ID
A3PE3000L-1FGG484I
A3PN015-1QNG68
A3PE3000-2FGG324
A40MX04-1PLG68I
A42MX24-PLG84
A3PE3000L-1PQG208IX259
A54SX32A-FGG256
AFS1500-FGG256K
A3P600-FGG256IPR23
AGL400V2-CS196
A54SX72A-1FGG484I
A42MX16-1TQG176
A40MX04-1PLG68
A42MX36-PQG208M
A3PN125-Z2VQG100I
A54SX72A-1PQG208I
A3PE3000L-1FG896
A42MX24-1PLG84
A40MX04-PLG44M

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A40MX04-1PQG100I
A42MX36-3PQG208
A3P400-1FGG256
A42MX24-PQG208IX94
AGL030V5-QNG48I
A54SX16P-PQG208M
AGLN125V5-ZVQG100I
A40MX04-1PQG100M
AGL015V5-QNG68
A40MX04-PLG84A
A54SX32A-2BG329I
A54SX72A-2PQG208
AGLN020V5-WAFERLOT
AGLE3000V2-FG484
A42MX36-1PQ208I
A3PE3000L-1FG484MX46
A3PE1500-1FGG484
A54SX08A-2TQG144
A3P125-TQ144
A54SX72A-1FGG484IX220
AFS250-2FGG256
A42MX16-3PQG100
AFS1500-FGG484K
A40MX04-PLG68X4
AGLP030V2-CSG201
A3PE3000L-FGG484I
A54SX72A-FGG484
A3P400-FGG144I
A54SX16-1TQG176I
A42MX09-3PQG100
A42MX09-1TQG176IX218
A3P600L-FG484
AGLN010V5-QNG48
A40MX04-PLG68I
A54SX32A-1FGG256
A40MX02-1VQG80I
A3P250-FG144IX53
A54SX16A-2TQG100I
A40MX02-1PLG68
A40MX04-FPLG68
AGL030V2-VQG100I
A3PE3000-FG896I
A54SX72A-1PQG208IX53
A42MX36-1PQG208I
A42MX09-3TQG176I
AGL250V5-FGG144IX94
AGL250V2-CS196I

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AFS600-2FG484I
A42MX09-1TQG176
A42MX16-TQG176M
A3PE3000-PQG208I
AGLN250V5-WAFERLOT
A54SX16A-TQG100
A3PN125-2VQ100
A3P250-PQG208
A3PE3000L-PQG208
A42MX36-FBGG272
A42MX09-1PLG84
A40MX04-3PLG44
A3P600-FG256I
A54SX32A-BGG329
A3PE1500-PQG208
A54SX32A-2BGG329
AFS600-2FG256I
A42MX24-2PQG160I
AGLN250V5-ZVQG100I
A3PE3000-2FG324I
A42MX16-3PLG84I
A3PE3000L-FGG484M
AGL1000V2-FG484I
A3PE600-1FGG484
A40MX02-FVQ80
A42MX24-PL84
A54SX32A-TQG100Z198
A54SX16P-2TQG176
A54SX72A-FG484
AFS600-1FG256
A3PE3000L-FGG324IX6
AGLN015V5-QNG68IPZ88
A54SX72A-1FGG256M
A3P600-1FGG256
A42MX16-TQG176I
A40MX04-2PLG68I
A42MX36-2PQG208
A42MX16-2VQG100I
AGL600V5-CS281I
A54SX32-2BGG329I
A54SX72A-1FGG484MX167
AGL1000V2-FG484
A40MX02-1VQG80
A42MX24-1PLG84I
A54SX16A-TQG144M
A54SX08A-TQG144A
A3P600L-FG144

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A3PE3000L-1FGG324
A3PN060-2VQG100I
A3PE1500-FGG484ID
A3P250-1VQ100M
A42MX36-BG272
A3PE600-FGG484
A3PN250-1VQG100I
A54SX16A-FTQG100
A42MX24-FPQG160
A54SX72A-1FGG484
A3P600-2FGG144I
A3P125-2VQ100
A40MX04-VQG80
AFS250-1FGG256
A54SX72A-FG256A
A42MX16-1PQG208M
A3P250L-VQ100I
A40MX02-1VQG80M
A42MX24-PQG160
A54SX16-TQG176
AGL250V5-FGG144IX130
A40MX04-2PLG44I
A54SX32-1BG329I
AGLE3000V2-FG484I
AGLN030V2-ZCSG81
A42MX24-1TQG176
A3P250-FG256
A3P600-FG484I
A3PE3000-1FG324I
AGL125V5-FG144
AFS600-1FGG484I
AGL600V5-FGG144
AGLN250V2-CSG81
A3PE3000-2FGG484
A3P250-1FG144
A42MX24-3PQG160I
A42MX09-1PQG160
AFS250-1FGG256I
AGL125V5-VQ100
AGLN030V2-ZCSG81I
A54SX16-2TQG176
A42MX24-2PQ160I
A40MX04-PLG84IPW60
A42MX16-1PQG160M
A3PN060-VQG100X376
A3P250-FG256IX94
A3PN250-VQ100I

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A54SX16A-TQG144A
AGL250V2-FGG144
A3P600-1FG144
AGL030V2-UCG81
A3PE600-1FGG256I
AGL600V2-FG144
A54SX16A-1TQG100I
A40MX04-FPLG84
A3P125-FG144T
A54SX72A-FGG256
A3P400-FG144I
A42MX16-TQG176
A3PE3000-PQG208
A42MX16-2TQG176I
A54SX32A-2BGG329I
AFS1500-FGG256
A40MX04-1VQG80M
A54SX32A-PQG208PQ01
A42MX16-3PQG160
AGL600V2-FGG256I
A42MX36-3BGG272
A3PN020-QNG68I
A3PE600-1FG256I
A3P600L-PQ208I
A54SX32A-1FG256M
A3P600-2FG144
A3P600L-1FGG484I
A42MX16-2PQG100
AGLN125V5-VQG100IX94
AGLN015V5-QNG68I
A42MX24-3PLG84
A54SX16P-PQG208I
A40MX02-PL44I
AFS600-FG256
A42MX16-3TQG176I
A42MX09-FPQG100
A3P600-1FGG144
A40MX02-1PQG100M
A42MX16-1PQG208I
A42MX09-3VQ100IX39
A3P125-VQG100I
A40MX02-VQ80
A54SX72A-FG256
A3P250-1FG256T
A3P600-2FGG484I
AGL250V5-VQG100I
A42MX16-1PLG84I

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A3PN250-2VQ100I
A54SX72A-PQG208M
A54SX32-2BG329I
A3P400-1FGG144
AFS250-FGG256
AGLN060V2-VQG100I
A3P250-FG256T
AGLN020V5-CSG81I
A54SX32A-1BGG329
A42MX09-PQG160
A3P400-2FGG144I
AGL400V5-FGG484
A3PE3000-FG896IX3
A3P600-WAFERLOT
A3P125-PQ208I
A42MX09-PLG84
A3P600-2FGG144
AGLN060V5-ZVQG100I
A42MX16-PQ160I
A42MX36-PQG240I
A42MX16-PQG100
A54SX72A-FGG484I
A3PE3000-2FGG896
A40MX04-VQG80A
A3P125-2VQ100I
A3P250-1FGG256T
A40MX02-PLG44I
AGL060V2-VQG100I
A42MX09-PQG144M
AFS1500-FGG484IW
AGLN250V5-VQ100I
A42MX36-2BGG272I
A42MX16-1PL84I
AGL1000V2-FG144I
AGLN060V5-WAFERLOT
A54SX16A-PQG208I
A3P600L-FGG144
A40MX02-1PQG100I
A42MX24-3PQG160IX94
A40MX04-VQG80I
A3PE1500-1FG676IX3
A3P125-TQG144IX53
AGLN060V5-VQ100I
AGLN060V2-ZVQG100
A3PE3000-PQ208I
A3PE1500-2PQG208I
A3P250-FG144

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A42MX36-PQG208IPY75
A42MX24-FPLG84
A3PE1500-1FGG676
A42MX16-3PQG100I
A54SX08A-TQG144
A3P600L-1FGG144
A3PE600L-FG484M
AGL030V5-QNG68
A3P250-2PQG208
A42MX24-1PQG208M
AFS1500-2FG484
A54SX32A-TQG144M
A3P400-2PQG208I
A3PN060-VQG100
A42MX09-3TQG176
A42MX16-FPLG84
A40MX04-PLG68M
A42MX24-2PQG160
AFS1500-1FG256K
A54SX16A-2TQG144
A3PE1500-1PQG208IX259
A3PN010-QNG48
A40MX02-1VQ80M
A3P600-1FGG484I
A54SX32A-FBGG329
AGL600V5-FGG484I
A42MX16-PQG208
A40MX02-FPLG44
A54SX72A-2FG484
A42MX16-2PQG160
A3P250-2FG144
A3P600-PQ208I
A40MX04-1PL44M
A54SX08A-FTQG100
AGL400V5-FGG256I
A3P125-FGG144X277
AGLN010V5-QNG48Z204
AGLN015V2-QNG68I
A42MX24-2PQ208XC45
A40MX02-3VQG80I
AGL125V2-VQG100I
AFS600-1FGG256
A3PE1500-PQG208X3
AFS600-2FG484
AGL400V5-FG256
AFS600-2FGG256I
A3P125-1VQG100

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A40MX02-1PLG68I
A54SX32A-TQG100IPU56
A54SX72A-1FG484
A3P250-FG144I
A40MX02-3PQG100
A42MX09-PQ144
AFS1500-2FGG484I
A3PN060-VQG100Q129
A3PE1500-2FG484
A40MX04-PQG100
A3P250-1FG256I
A3P600-PQG208
AGLN125V2-ZVQG100I
A3P250-PQ208
AGL030V2-UCG81I
AGL030V2-VQG100
A3PE3000L-1FG484IX6
AGLN125V5-VQ100I
A40MX02-PLG44Z194
A54SX32-1BGG329I
A3PE3000-1FGG324
AFS1500-FG256IDX402
A40MX02-FPL44
A42MX36-1BGG272
A3P250-VQG100M
A40MX04-1PLG84
A3PE3000L-1PQG208
A3PE600-2FGG256I
A40MX04-WAFERLOT
AFS090-FGG256
A3P400-FGG256
A3P125-FGG144GW
A54SX72A-FGG484M
A54SX72A-1PQG208M
AFS600-FGG256X297
AGL125V2-FG144
A3P250L-FG256I
A54SX32A-2TQG144I
A54SX08A-TQG100I
AGL030V2-CSG81I
A3PE1500-1FGG676I
A3PE1500-1FG676
A42MX16-FPQG100
AGLN020V2-QNG68I
AGL250V2-VQG100
A40MX02-3PLG68I
A40MX04-2PLG84I

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A3P125-1VQG100T
AGL600V2-FGG256
A54SX72A-1FG484MX259
A54SX32A-FGG256I
A3P600-FGG256IPZ69
AGL400V5-CS196
A3P250-VQG100IX60
A54SX32A-1PQG208M
A3PE600-FG256IX6
AGL600V2-CSG281I
A40MX04-2VQG80
A42MX09-TQG176I
A3P250-FGG144I
A3PN060-ZVQG100
A42MX09-PL84
A42MX16-1TQG176M
AGL1000V2-FGG484
A3PE1500-2FGG484I
A54SX32A-TQG144IX53
AFS600-1FG484
A3P600-FGG484I
A42MX24-2PQG208
A42MX16-1PLG84
A54SX32-2BGG329
A54SX32A-2FGG256
A42MX09-PLG84PK56
A3PN060-2VQG100
A40MX04-PLG44Z196
A54SX72A-1PQG208
A3P125-FGG144PR85
A54SX72A-FG484I
A42MX16-PQG100A
A42MX09-TQG176
A54SX32A-FG256A
A42MX16-PQ100IX39
A3P600L-1PQ208IX402
AGL400V2-CSG196I
AGLP030V2-CSG201I
AGL250V5-VQG100
A3P125-1VQG100I
A3PN030-ZQNG68I
A42MX09-1TQG176M
A54SX32A-FBG329
AGLN020V2-CSG81
A3P250-VQ100M
A3P250-VQ100M
A3PE3000-PQG208X3

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A54SX32A-2TQG144
AGL1000V2-FGG144I
A3PN020-2QNG68I
A54SX16A-TQG144I
A3PE3000-2FG484
AGLN125V5-VQG100
A3PE3000-1FG484
AGL400V2-CSG196
A3P600-FGG484
AGLE3000V5-FG484
A3PN250-2VQG100I
A3PE3000L-FGG324I
A40MX04-1PLG84I
A3PN030-ZQNG48
AGL125V2-VQ100I
A42MX36-3BG272
A3PN060-1VQG100I
A54SX72A-1FG484I
A42MX16-TQG176IX218
A3PE600-FGG484I
A42MX24-PQG160A
AGL1000V5-CS281
A54SX32-1PQG208I
A3PE3000L-FGG896M
A3PE3000L-FG896
AFS1500-FGG484
A40MX02-VQG80
AGLN125V5-CSG81
A3PE3000-1FG896I
A3PN060-2VQ100
AFS600-2FGG484I
A3PE3000L-FG484
AGL125V2-VQ100
A42MX09-2VQG100I
AFS1500-FG256K
A40MX04-VQ80
A3PE3000L-1FGG896M
AGL250V5-VQ100
AFS1500-FGG484I
A42MX16-1PQG100M
A3P400-FG144
A3PE3000-PQ208
A3PE3000-FG324
A42MX09-1PQG160I
A3PE3000L-FGG484MX6
A54SX72A-2FG484I
A42MX16-PLG84A

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A42MX36-1BG272I
A3P600-FGG256
A3P400-2FG256I
AFS600-FG256I
A3PN060-1VQ100
A42MX09-2TQG176I
AGLN060V5-ZVQ100
A42MX36-2BGG272
A3PE1500-2FG676I
AGLN010V2-QNG48I
A42MX36-1BGG272I
A3PN125-Z2VQG100
A3PE3000L-FG324
A54SX16A-1PQG208I
A54SX72A-FFG256
A3P250-FGG144T
A3P600-2FG144I
A54SX72A-2FG256
AFS600-FGG484I
AFS1500-1FG484I
AGLE3000V5-FGG484
AGL125V5-VQG100
A3PE3000-1PQ208I
A42MX09-FVQ100
A3P600-1FG256
A54SX32A-1TQG144M
A3PN125-VQG100
A42MX16-VQG100M
A42MX16-1PQG100I
A42MX36-FBG272
A54SX32-2BG329
AGLN060V5-VQ100
A3PN015-1QNG68I
A42MX09-PQG160I
A42MX16-2PQ100I
A3P250-VQG100I
A3P400-2FGG144
A54SX08A-TQG100A
A3P600-1FG144I
A3P400-2FGG256
A3P400-2FG256
AGL125V2-CSG196
A42MX09-PQ100I
AGL060V2-VQG100
A3P600L-1FGG484
AGL250V2-VQG100I
AGL030V2-QNG48

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A42MX16-2PQG208
AFS600-2FGG484
A54SX32A-1TQG144I
A42MX16-PL84
A3P125-PQG208
A42MX24-2TQG176
A54SX32A-TQG100A
A40MX04-3PLG84I
A42MX36-2BG272I
A54SX08A-TQG144I
A42MX16-TQG176A
A3P125-2FGG144I
AGL400V5-FG256I
A54SX72A-1FG484IX220
A40MX02-PLG68I
A3PN010-2QNG48
AGL600V2-FG256I
A3PE3000-2FGG896I
AGLN125V5-ZVQG100
A54SX08A-2TQG144I
A54SX16A-1TQG144
AGL030V2-QNG68I
A54SX72A-2FG256I
A54SX72A-1FGG256I
AGL1000V5-FGG484I
AGL030V2-CSG81
A40MX02-2PLG68
AGL125V5-VQG100I
A42MX16-PQG208I
A3PE3000L-1FG484
A42MX16-3PQG208
A40MX04-1PLG68M
A42MX36-2BG272
A42MX24-PQG208I
A54SX16A-1PQG208M
AGL250V2-CSG196
A3P400-PQG208IX218
A42MX16-1VQG100
AGLN020V5-CSG81
A42MX09-PQG100A
A42MX36-PQG208IX39
AGL1000V2-CSG281
AGL400V2-FG256I
A42MX16-1VQG100I
A3PN125-VQG100IQ162
AGLN250V2-CSG81ORT
A40MX02-3PLG68

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A3P125-2VQG100I
A3PE3000-1FG896
A3P125-FGG144T
AFS1500-1FGG256
A42MX24-1PQG208
A42MX09-FVQG100
A40MX04-1PLG44M
A3P250-2VQ100
A42MX24-3PQG208I
AGL1000V2-FG256
A40MX04-FPL68
A42MX16-2TQG176
AGL1000V2-FGG144
A40MX02-2PQG100
A42MX36-1PQ208M
A42MX09-VQ100I
A3PE3000-1PQG208I
A3P125-TQG144I
A3PN030-Z1QNG68I
AGL400V5-CS196I
A54SX16P-1PQG208I
A3PE3000L-1FGG896
A3PE600-1FG484
A3PE1500-1FG676I
A3P400-1PQG208
AGLN010V2-QNG48PU33
A40MX04-1VQG80I
A3PE3000L-FG484I
A42MX09-1PLG84I
A3P600-2FG484
A42MX36-2PQ208IX39
A42MX09-PQG100IPC92
AGLN020V5-QNG68
A3P250-2FGG256
AGL030V5-CSG81I
AFS600-FG484I
A3PE1500-FG676
AGL030V5-VQG100I
A3P600-2FG484I
A42MX16-2PQG100I
A3P250-FGG256I
A3PE1500-1FGG484I
A3PE1500-WAFERLOT
A42MX16-PQG160IPU48
A42MX09-PLG84I
A54SX32-BG329I
A42MX36-FPQG208

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A42MX16-FPQG160
A3PE600-FG484I
A42MX24-PLG84M
A54SX16A-TQG100M
A54SX72A-FGG256I
A3P250-FGG256X365
A3P125-PQG208I
A42MX16-1PQG208
A54SX32A-2FGG256I
A40MX04-2PL44I
AFS600-FGG256
A3P250-FG144T
A3PE1500-2FGG676I
A3P600L-FGG484
AGLN125V5-CSG81I
A54SX16A-TQG100I
A3P125-2TQG144I
A3PE3000-2FG896IDX402
AFS1500-2FGG484
A42MX16-VQ100M
A3PE3000L-FGG896
A3P400-FG256
A3PE3000L-1FG484M
A3PE3000-2FGG484I
A42MX09-3VQG100I
AGL400V2-FGG256
A54SX16P-2PQG208I
A54SX32A-2PQG208
A42MX24-PLG84IX339
AGLN250V5-VQ100
A54SX08A-2TQG100I
A3P600-FG144
AGL400V2-FGG256I
AGL030V5-QNG68I
A3PN030-Z1QNG68
AGLN020V5-QNG68I
A3P250-1PQG208
A54SX32A-TQG144A
A42MX09-2PLG84
AFS600-FGG484K
A54SX72A-2PQG208I
AGL600V5-FGG144I
AGLN250V2-VQG100I
AGL125V5-FGG144I
A42MX36-PQ208I
A3P250-PQG208X365
A42MX24-PQG208

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A3PE1500-2PQG208
A42MX09-1VQ100I
A3P600-PQG208I
A54SX72A-2FGG484I
A3PE3000L-1FGG484
A40MX02-FVQG80
A3PN125-VQG100X376
A3P400-1FG256
A42MX09-VQG100M
A40MX04-3VQG80
A42MX16-PQG208M
A3PN125-2VQ100I
A40MX04-3PLG84
A3PE3000-FG324I
A54SX16A-TQG100A
AGL600V5-FG144
AGL600V5-FG144I
A3P125-2FGG144
A3PE3000-1FGG484
A40MX02-2PLG68I
A54SX32A-1BGG329M
A42MX16-3TQG176
A54SX32A-FFG256
A3P250-2FG256I
A42MX09-TQG176A
A42MX09-VQ100
A3P250-2VQG100
A3PN125-ZVQG100
AFS250-FGG256I
A3PE1500-FGG484I
A42MX16-1PQ160
A40MX04-PLG44Z197
A54SX16A-PQG208M
A3PE600L-1FG484M
A54SX16P-1TQG176I
A3PN010-2QNG48I
AFS1500-2FG484I
A40MX04-2PLG44
AGLN020V2-QNG68
A42MX09-PQG100I
AGLE3000V5-FGG484X500
A54SX32A-TQG144IPN03
A42MX16-PLG84M
A42MX09-PLG84IX39
A3P600L-1FGG144I
AGL1000V5-FG144
A40MX02-3PLG44I

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A3P250-1FGG256I
A54SX16A-2PQG208
A3PE600-2FG256IX7
A42MX24-PQ208M
A40MX02-2PQG100I
AFS1500-FG484
A42MX09-1PQG100I
AGL1000V5-FG256I
AGL250V2-VQ100
A3PN015-2QNG68I
A54SX16A-1TQG100
A42MX24-PQG160I
AGL250V5-CSG196I
A54SX32A-TQG100M
AGLE600V2-FGG484
A42MX36-1PQG208
AGL250V5-VQG100IX377
A54SX32A-2TQG100I
A42MX16-PQ208I
A54SX72A-PQG208IX220
A42MX36-BG272I
A3P400-2FGG256I
AGL060V5-VQG100
AGL030V5-VQ100I
A3PE3000L-FG324I
A3P250-PQG208GW
A3PE600-FG484
AGLE3000V5-FGG484I
A54SX72A-1FG256
A3P250-1FG144M
AGL600V2-FGG144
A3PE3000L-1FG324
AGL250V2-FG144
A40MX04-3PLG44I
A3P600-1FGG484
A40MX04-PL68
A40MX04-PLG84
A3P250-FGG144IX7
A3PE3000L-1FG484I
AGL250V2-CSG196I
A54SX72A-FG484A
A3PE3000L-1FGG896I
A3P600-2PQG208
AGLN060V5-CSG81
A42MX09-PQG100M
A3PE3000L-1PQG208I
AGLN015V2-QNG68

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A42MX36-2PQ208I
A42MX16-FVQG100
A54SX32A-1TQG100I
A42MX16-TQG176X4
A40MX02-PL44
A3PE3000-1PQG208
AFS1500-2FGG256I
A42MX16-PQ100
A3P600-1PQG208
A3P400-1PQG208I
AGL600V5-FGG256I
A3PN060-ZVQG100I
A42MX09-PQG100
AGL600V5-FG256
A42MX24-PQ208
A42MX16-2VQ100I
A42MX16-2PLG84I
A3PN030-ZVQG100
A3PN250-2VQ100
A42MX09-FPLG84
A54SX32-PQG208IX218
A3PN060-1VQG100
A3PN030-ZQNG68
A42MX09-TQG176M
A42MX36-2PQG208I
A42MX24-PQ160IX339
A54SX32A-PQG208IX220
A3PE3000-2FG484ID
A3PE1500-1FG484I
A42MX16-1PQG160
A3PE3000-1FG484I
A42MX16-2PL84I
AGL030V5-UCG81I
A3P250-2FGG144I
A42MX16-PQG160I
A3P600L-1FG144
A42MX24-2PL84I
AGL250V5-CS196
A42MX24-PQG160M
A3P250-FGG256
A42MX09-FPL84
A42MX09-1PQG100
A42MX36-PQG208I
A3PE3000-2FG484IX3
A3PN250-VQG100
A3P250-PQ208I
AGL1000V2-CS281

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A42MX36-2PQG240I
A42MX09-PQG100IQ247
A3P250-1VQG100T
A3P400-FG256I
A3PE600-2FGG484
A3P250L-PQ208I
A40MX04-2PLG68
A40MX04-PLG68Z192
A42MX09-VQG100A
A3P250-2FG144I
A3PE600-FGG256I
AGL400V5-CSG196
AGL250V5-CSG196
A42MX09-1PQG160M
A3P600-FG256
A3P600-FG144I
A42MX24-PLG84I
A54SX72A-1FGG256
A40MX02-PQ100
A42MX09-3VQ100I
A3P250-2FGG256I
A3PN125-2VQG100I
A42MX09-PQ100
AGL1000V2-FG256I
A42MX24-FPQ208
A3PE3000-FGG896
A54SX08A-1TQG100
A42MX24-2PQG208I
A42MX09-2PQG100
A54SX72A-2FGG484
A3P125-1VQ100I
A3PE3000L-PQG208I
AGL030V5-CSG81
A3PE1500-FGG676I
AGLN060V2-VQ100
A3P250L-VQG100I
A3PE3000-2FG896I
A3PE600-FGG256
A42MX24-1PQG160M
A3P250-1FGG256
A42MX16-3VQG100I
AGLN125V2-VQG100
AGL125V5-FG144I
A3P250-1FGG144
AGL060V2-VQ100I
A40MX02-1PLG44M
A42MX24-1TQG176M

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A40MX02-PL68I
A3PE3000-FG484
A3P250-1VQ100
A40MX04-FVQG80
AGL030V5-QNG48
A3P400-FG256IX94
AFS600-2FGG256
A40MX02-FPL68
A42MX09-2PQG160I
A3P400-PQG208
A54SX32A-1BG329M
A42MX09-PQ100M
A54SX72A-PQG208PS95
AGL600V2-FGG484
A3P600L-1FG144I
A3P250-FGG256X399
AGL1000V5-FGG256
A3PE600-PQG208IX218
A3P600-PQG208M
A54SX72A-FFGG484
AGLN015V5-QNG68IPU88
A42MX36-1PQG208M
A3PN020-2QNG68
A42MX09-PL84I
AGLN250V5-VQG100I
AFS1500-FG256IX456
A42MX16-PLG84X4
AGL250V5-FGG144I
A42MX24-1TQG176I
A54SX32A-FG256
A3P400-1FGG256I
A3PE3000L-1FGG484MX167
A42MX24-PQ160I
A3PN250-1VQ100I
AGL250V2-FG144I
A3P600-PQ208
AGL030V5-UCG81
A3P600L-FGG484I
A54SX72A-PQG208A
AFS600-FG256K
A42MX09-PQG144I
AGLN060V5-VQG100I
AFS1500-FG484K
A3P400-2FG144I
A40MX02-PLG44Z195
A42MX09-PQ100IQ120
A42MX09-2VQG100

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A40MX04-FPQG100
A54SX16P-1PQG208M
A42MX16-PL84M
A42MX16-PQG160A
A42MX16-3VQ100I
A40MX04-VQ80M
A54SX72A-2FGG256
A3PE3000L-1FG484IX3
A54SX32A-FG256M
A3P125-TQG144X277
AFS600-1FGG256K
AGL060V5-WAFERLOT
A54SX16P-PQG208
A3PE3000-2FGG484D
AFS1500-1FGG484
AFS600-1FG256I
A42MX36-1BG272M
A40MX02-2VQG80
AGLN250V2-VQ100
AFS600-1FGG256I
A3PE3000-2FG324
A3P400-PQG208I
AFS1500-1FG484
A3PE3000L-1FG484MX3
AFS600-2FG256
A54SX72A-1FG256I
A54SX72A-FG256M
A42MX09-VQG100
AGLN060V2-VQG100
A42MX24-PQG208A
A42MX09-FPL84PE95
AGLN125V5-VQG100I
AGL1000V5-FGG484
A42MX36-3BGG272I
A54SX72A-FG256I
AFS600-FGG484
A3PE3000-FGG324I
A42MX09-3PLG84
A42MX09-3PL84I
A3P600-1FG484
AGL250V5-FGG144
A3P250-VQG100
A54SX08A-2TQG100
A42MX24-3TQG176
A3PN010-1QNG48
A42MX24-2PQ208XC01
A42MX36-BGG272I

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A54SX72A-FPQG208
A3P125-2PQG208
A3PE3000-2FG896IDX499
A42MX09-FPQ100
A40MX02-VQG80A
A3P400-FGG144
AFS1500-1FGG484K
A3PN125-2VQG100
A40MX04-1PL68
AGL600V5-CS281
AGL125V2-VQG100
A42MX36-PQG208IPY74
A42MX24-2TQG176I
A40MX02-PLG68M
A3PN015-2QNG68
AGLN125V5-VQG100IX6
AFS1500-1FG256I
A40MX02-PLG44M
AGLN125V2-VQ100I
A42MX24-1PQG160I
A3PE600-PQ208I
AGL1000V5-WAFERLOT
AFS250-1FG256
A3P125-2PQG208I
AGLN060V5-ZVQG100
A42MX16-VQG100A
A42MX36-PQ208M
A42MX36-PQG208IQ122
A3PE3000-FG896
A3PN060-VQG100I
AGL600V5-CSG281I
AGLN250V5-VQG100
A3P125-VQG100IPT72
A54SX72A-PQG208I
A42MX36-BG272M
A42MX24-FPQG208
A54SX32A-PQG208M
A54SX32A-2FG256
AGLN020V2-CSG81IX94
AFS1500-1FG484K
AGL400V2-FG256
A42MX16-1PQG100
A42MX09-VQG100X90
A3P400-1FGG144I
A54SX16A-1TQG100M
A3P600-2FGG256I
A3P600L-1PQG208I

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A54SX32-1BG329
A40MX04-PLG84M
A42MX36-BGG272
A54SX16A-TQG144IQ247
A54SX32A-FTQG100
A40MX04-1PLG44I
A3P250-1PQG208I
A3P600-FG484
A54SX16P-TQG176I
A42MX24-2PLG84
A42MX16-3PQG208I
AGLN010V5-QNG48I
A3P600L-FGG144I
AFS250-2FGG256I
A3P600-1FG256I
A3P250-2PQG208I
A40MX04-3PQG100I
A42MX09-PQG160M
A42MX09-1VQG100
A40MX04-PLG84I
A3PN250-1VQG100
A54SX32A-BG329
A3P125-1TQG144
A54SX32A-TQG144I
A54SX72A-PQG208IPF62
A42MX24-3TQG176I
A40MX02-FPLG68
A54SX32A-BGG329M
A40MX02-PLG68Z191
A54SX72A-1FG484M
A3P600-1FG484I
A54SX72A-FGG256A
A42MX09-2TQG176
A3P250-2VQ100I
AFS600-FG484
A3PE1500-FG484I
AGL250V5-FG144I
A54SX72A-2FGG256I
A54SX16-2TQG176I
AFS600-FG484K
A40MX02-3VQG80
AGL030V5-VQG100
A40MX02-2PLG44
AFS1500-1FGG256K
A40MX02-3PQG100I
AGL030V5-VQ100
AGLN125V5-VQ100

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A42MX16-2PQG160I
AGLN060V5-VQG100
AGLE3000V2-FGG484I
AGL1000V5-CSG281ID
AGL400V5-FGG256
A42MX16-VQG100I
A54SX32A-1FG256I
A3PN060-1VQ100I
A40MX04-PL44
AGL250V5-CS196I
A54SX32A-1PQG208
A3PN020-1QNG68
A3P600L-FG484I
A42MX09-1PQG100M
A42MX16-1PQ160M
A54SX32A-PQG208X507
AGL125V2-FG144I
A42MX24-1PQG208I
AGLN015V5-QNG68
AGL1000V5-FGG144I
A54SX32A-FG256I
AGL600V5-FG256I
A3PE1500-PQG208IX3
A42MX24-2PQ208I
A3PE1500-FGG676IX218
A3P250-VQ100MX45
A54SX16P-2PQG208
A42MX09-PQG144
A42MX09-PLG84IX218
A42MX09-3VQG100
A3PE3000-1FGG324I
A54SX32-2PQG208I
A3PE3000L-FG484MX6
AGLN060V5-CSG81I
A42MX09-VQG100IQ156
A42MX09-PLG84M
A3PE3000-2FG484I
A42MX36-PQG208A
AGLP030V2-CSG201IPV40
A42MX16-1PQG160I
A42MX09-1PQG100IPW46
A3PE3000L-FGG484
A3PE600-2PQ208I
A3P400-2PQG208
A42MX16-PQ160M
A40MX04-PQG100M
A42MX36-3BG272I

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A3P125-FG144I
A40MX02-PQG100I
A42MX09-VQ100X90
AGL1000V5-FG144I
AGLN010V2-UCG36I
A42MX36-1BGG272M
A54SX32A-2PQG208I
AFS600-1FGG484K
A42MX09-1PL84I
A3PE3000-1FG324
A54SX08A-1TQG144
A40MX02-VQ80M
A3P125-FGG144IPW48
A40MX02-3PLG44
A3PE3000-2PQG208
AGL600V2-CS281I
A3P250-1VQ100I
A3PE3000L-FG896ID
A54SX32A-FGG256A
A42MX09-2PLG84I
AGL125V5-WAFERLOT
A3PE3000L-1FG484MX6
A3PE3000L-1FGG484M
A3PE3000-1FGG896I
A42MX09-FTQG176
A54SX16A-PQG208
A3PE600-FG256
A3P125-2VQG100
AGL030V2-QNG48I
A42MX16-FTQG176
A42MX36-3PQG208I
A3PN060-VQ100I
A3P250-1FG144T
A3PE3000-1FGG484I
AGLN060V2-VQ100I
AGLE3000V5-FG484X500
A3PE3000-2FG896
AGL060V5-VQ100I
A54SX32-PQG208I
A3PE600-WAFERLOT
AGLN125V2-CSG81I
A54SX32-2PQG208
A40MX04-3PLG68I
A3PE3000L-1PQG208IX6
A42MX09-3PQG160
A3P250-1FG144IX94
A3PE3000L-FG896M

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A3PE600-2FG484
AGL1000V2-CSG281I
A3P125-FGG144I
AGL250V2-CS196
AFS600-FG256IX3
A3P250-1VQG100I
A54SX16A-FPQG208
AGLN010V2-QNG48IX94
AGLN125V2-ZVQG100
A54SX32-TQG144M
A54SX16A-1PQG208
A3PE600-2FG484I
AGL400V5-FG144I
A42MX09-2PQG100I
A42MX16-WAFERLOT
AFS600-FGG256I
A42MX16-FPQG208
AGL600V2-FG144I
AFS600-1FGG484
A42MX24-2PL84
A54SX32A-1TQG100
AGLE600V5-WAFERLOT
A3P600-1FGG144I
AGLN125V2-VQ100
A40MX02-PLG68
A3PN250-2VQG100
A42MX09-PL84M
A54SX32A-TQG144
A40MX04-VQG80M
A3P250-1FG144I
A42MX09-1VQG100M
AGL1000V2-CS281I
AFS600-FGG256K
A42MX16-PQG100I
A40MX04-PQ100M
AFS1500-2FG256
A3PN125-1VQG100
A3PN125-VQG100I
A42MX16-PQG160M
A3P600-FGG144I
AGLN010V2-UCG36
A42MX09-TQG176IX218
A3P125-1TQG144I
A54SX08A-1TQG144I
A3PE3000L-1FG896I
A3PE1500-2FG676
A54SX32A-1FG256

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A3PE1500-1PQG208
A3P125-PQG208PS53
A54SX32-BGG329
A40MX04-PQG100A
AGL1000V2-FGG256
A40MX04-2PLG84
A42MX16-PL84I
A3PE3000-FGG324
A42MX24-PQG208IX4
A3PN250-VQG100I
A54SX32A-FTQG144
A54SX16A-1TQG144M
A40MX02-VQG80M
A3P600-PQ208M
AFS1500-FG484I
A3PE600-2FGG484I
AGLN020V2-QNG68PS16
A54SX32A-1FGG256M
A42MX16-1VQG100M
AGLN250V5-ZVQG100
A54SX32A-FFGG256
A3PE3000L-FGG324
AGL030V2-VQ100I
A40MX02-1PQG100
A54SX32A-PQG208A
A42MX24-3PQG208
A54SX16P-1TQG176
A54SX16A-2PQG208I
AGLP030V2-VQG128
A54SX32-PQG208M
A42MX16-PLG84I
A3P600L-FG144I
AGL125V5-CS196
A3P125-TQG144
AGLN010V2-QNG48
AGL1000V5-FG484I
A3P400-FGG256I
A42MX24-PQ208I
A42MX16-PQ160
A42MX16-2PLG84
A42MX09-3PQG160I
A40MX02-PQ100M
AGLN250V2-VQ100I
A54SX32A-PQG208I
A54SX32-BG329
AFS250-FG256I
AGL1000V5-CSG281I

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A3P125-FGG144
A40MX02-2PLG44I
AGLN060V5-CSG81IX94
AGL600V5-FGG484
A3PE3000L-FGG896I
AGLP030V2-VQG128I
A54SX32A-2FG256I
AGLE3000V2-FGG484
A42MX24-TQG176I
A3P125-2FG144I
A3PN020-1QNG68I
A3P600-2FGG256
A42MX24-PQG208M
A3PE600-2FGG256
A54SX72A-PQ208I
A42MX16-PQG160MX323
AGL250V2-VQ100I
AGL1000V5-FG484
A42MX24-TQG176
A3P125-VQG100IX94
A3PE3000-FGG484I
AGL600V2-FGG144I
A3P250-2FG256
AGLN060V2-VQG100IX11
A3P125-VQ100
A54SX16A-2TQG144I
AFS600-1FG256K
AGLN125V2-VQG100I
A3P250L-FGG256
A42MX16-1TQG176I
A40MX04-2PQG100I
A40MX02-PLG68Z193
A3P400-2FG144
AGL1000V2-FGG256I
AGL600V5-CSG281
A40MX02-VQG80I
A40MX04-PLG44I
A3P250-1VQG100M
A54SX32A-BGG329I
A40MX04-3PQG100
A42MX09-1PLG84M
AFS250-FG256
A3PN060-ZVQG100X300
A42MX24-3PQ208I
A54SX32A-TQG100
A40MX04-PLG44
A3PE600-1FGG484I

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A3PE1500-2FG484I
A54SX16-TQG176I
A3P250-1FG256
A3PE1500-FGG484
A3PE1500-1FG484
A40MX02-PQG100M
AGL125V5-VQ100I
A3PN030-ZQNG48I
A42MX16-PQ100I
A54SX32A-1PQG208I
A40MX04-1VQ80I
A3PE3000-FG484I
A3P250-1FGG144I
A3PE1500-2FGG484
AGL250V5-VQ100I
A42MX09-PQ144I
AGL400V2-CS196I
AGL250V5-FG144
AFS1500-1FG256
A42MX09-1VQG100I
A54SX32A-TQG144IX510
AGLN060V2-CSG81
A40MX04-PLG68Z190
A42MX24-TQG176A
AFS600-1FG484K
A3P125-2TQG144
A54SX08A-FTQG144
A3PE3000-2PQG208I
AGL250V5-VQG100IX52
A3P250-FGG144
AGL125V2-CSG196I
A2F200M3F-FGG256IQ150
A3P1000-FGG144T
A3P1000L-1FG256
A3P1000L-1FGG484I
A2F500M3G-1CS288
A3P1000L-FGG256
A3P030-QNG68
A2F200M3F-1FGG256I
A3P030-QNG68I
A3P1000-1PQG208M
A3P1000-FG484
A3P1000-FG484AX359
A2F500M3G-FG256I
A2F200M3F-FGG256IQ169
A3P1000-1FGG256
A3P1000L-1FG256I

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A2F500M3G-1FG256
A3P060-1FG144T
A3P1000-FGG256
A3P1000-FGG256X53
A3P030-1QNG68
A3P1000-FGG256I
A2F500M3G-FGG256
A3P030-1VQ100
A2F500M3G-PQG208
A3P1000-FGG144Q175
A3P060-1VQ100
A2F200M3F-FGG484I
A3P030-QNG48I
A3P1000-WAFERLOTX53
A2F500M3G-PQG208I
A3P1000-FGG484IX399
A3P1000-1FGG144T
A2F200M3F-FGG256IQ116
A3P1000-1PQ208
A2F500M3G-1PQ208I
A3P060-TQG144
A3P1000-FG144IX94
A2F500M3G-1CSG288IZ091
A3P060-2FGG144
A2F200M3F-1PQG208
A2F500M3G-FGG484Q154
A3P060-2TQG144
A3P1000-PQG208
A2F200M3F-PQG208I
A2F500M3G-CSG288X52
A3P1000L-FGG144I
A3P060-1FG144I
A2F200M3F-FG256I
A3P1000-FG144M
A3P030-2VQ100I
A2F500M3G-1FGG484M
A2F200M3F-1FGG256
A3P030-2QNG48I
A2F500M3G-FGG484Q220
A2F500M3G-1FGG256M
A3P1000-FGG484I
A3P060-VQG100IX277
A2F200M3F-FGG256IQ123
A3P1000-FG484IX277
A3P1000-2FGG484IX94
A3P030-1QNG68I
A3P1000-1FG256I

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

A3P030-VQG100
A3P1000-2PQG208
A3P1000-FG256M
A2F500M3G-FGG484I
A3P1000-2FGG256I
A3P1000-FGG144
A3P060-VQG100I
A3P1000-1FGG484
A3P030-VQG100X376
A2F500M3G-1CS288I
A2F500M3G-FGG484
A3P1000-2FGG256
A3P1000-FGG144I
A3P030-VQG100IX94
A3P1000-1FGG144I
A3P1000-1FGG484I
A2F500M3G-1FG256IX94
A3P1000-FGG256IX277
A3P1000-FGG484AX359
A3P1000-FG256I
A2F200M3F-FG256IX94
A3P060-VQG100T
A3P060-VQ100I
A3P1000-1FGG144M
A2F200M3F-1FG484I
A3P1000-1FGG484M
A3P1000L-1FGG256
A3P1000-1PQG208
A3P060-2TQG144I
A3P1000-FG484M
A3P1000-1FG484T
A2F500M3G-1FGG484
A3P030-QNG48
A2F200M3F-CS288I
A3P1000-FG256
A3P030-VQG100I
A2F500M3G-1FG256I
A3P060-2VQ100
A3P1000-FGG484ID
A3P1000-PQG208I
A1020B-PLG44IAV
A3P060-VQG100IGW
A2F500M3G-1FGG256
A3P1000-2PQG208I
A3P1000-2FG256
A2F200M3F-1FG256I
A3P060-1FGG144T

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

A2F200M3F-FGG484Q098
A3P1000L-FG256
A3P1000-1FG256T
A3P1000-1FGG256I
A2F500M3G-PQ208I
A3P1000-1FG256
A2F500M3G-FGG484Q109
A3P060-1FGG144
A2F500M3G-FGG484Q155
A3P1000-FGG256X52
A3P1000-FG144MX6
A3P030-VQ100
A2F200M3F-1PQG208I
A3P060-FGG144
A3P030-1VQG100I
A3P1000-1FG256M
A1425A-PL84I
A3P060-2FGG144I
A2F200M3F-1CSG288
A3P060-1FGG144I
A2F500M3G-1CSG288IQ091
A2F200M3F-FGG256I
A2F500M3G-FGG484Z215
A3P030-1QNG48I
A2F200M3F-FGG256IQ147
A3P030-VQG100ORT
A2F500M3G-FG256M
A3P1000-FGG484T
A3P1000-2PQ208I
A3P060-1VQG100T
A3P060-FGG144T
A3P1000-2FG256I
A3P1000-2FGG256M
A3P1000L-1FG144ID
A2F200M3F-1FG256
A2F500M3G-1FG484M
A2F200M3F-CS288
A3P1000-1FG144
A1020B-2PLG84IAV
A3P1000-1FG144T
A3P1000L-1FGG144I
A2F500M3G-1FG484YI
A3P1000-1FGG256T
A3P1000L-1FGG256I
A3P060-FG144
A2F200M3F-1FG256IX3
A2F200M3F-CSG288

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A3P1000-FG144D
A3P060-VQ100
A3P1000-PQ208I
A3P060-1FG144
A3P1000-1PQG208IX167
A3P1000-1FG484M
A3P1000-2FGG484
A3P060-VQG100IPN54
A3P1000-2FGG144
A2F500M3G-1CSG288
A3P1000L-1FGG144
A2F200M3F-1CS288I
A3P125-1FGG144I
A3P060-TQ144
A3P030-1QNG48
A3P1000-PQG208M
A3P1000-2FG484I
A2F500M3G-FG484
A2F200M3F-CSG288I
A3P030-2VQ100
A3P030-2QNG48
A2F200M3F-PQG208
A1425A-PL84IX218
A2F500M3G-FGG484D
A3P060-VQG100IX430
A2F500M3G-CS288I
A3P1000-FGG256M
A3P1000-1FGG144
A3P1000-1FG144M
A3P1000-WAFERLOT
A2F500M3G-CS288
A3P060-1VQG100
A3P1000-1FGG256M
A3P1000-1FG484
A3P1000L-FG484I
A2F200M3F-FGG484Q148
A3P060-2VQG100
A3P125-1PQG208
A2F500M3G-1CSG288IZ265
A3P015-QNG68I
A3P1000-PQG208IX277
A3P1000-FGG484M
A3P1000L-1FG144I
A2F500M3G-1PQG208
A3P1000L-FGG256I
A3P1000-1FG144I
A1010B-PLG68CAVX3

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

A3P1000-2FGG484M
A3P060-2VQG100I
A2F200M3F-1CS288
A3P1000-FGG256IX377
A2F500M3G-1FG484I
A3P1000L-FGG144
A2F200M3F-FG484IX23
A3P1000-FG144
A3P060-VQG100
A3P1000L-FG256X3
A3P1000-2FG484IX277
A3P125-1FG144I
A3P060-VQG100X7
A2F200M3F-FG256
A3P060-1TQG144I
A3P060-2VQ100I
A2F500M3G-FGG256M
A2F200M3F-PQ208I
A3P125-1FGG144
A2F200M3F-FGG484Q115
A2F500M3G-FGG256I
A2F500M3G-FG484IX323
A2F200M3F-FGG256
A3P1000-FGG484IX377
A2F200M3F-FGG484
A3P1000-FG144T
A3P015-QNG68
A3P1000-1PQ208M
A3P1000-FG484T
A3P060-VQG100X069
A2F200M3F-FG484
A3P1000-FG144MX399
A3P060-1TQG144
A3P125-1FG144
A3P030-1VQG100
A3P1000L-FGG144IX167
A3P1000-1PQG208I
A3P1000L-1FG144
A2F500M3G-1PQG208I
A2F200M3F-FGG256IQ141
A3P125-1FG144T
A2F500M3G-1PQG208IX3
A3P030-2QNG68I
A3P060-2FG144I
A2F500M3G-1FG256YI
A1460A-PQG208IAV
A2F200M3F-1FG484

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A3P1000L-FG144
A2F200M3F-FG256YI
A2F500M3G-FGG484Q108
A2F200M3F-FGG256IQ139
A3P060-1VQ100I
A3P1000-FG144I
A3P060-1VQG100I
A3P1000-FG256T
A3P1000-FGG484AX358
A3P1000-2FG256M
A2F500M3G-1CSG288I
A3P1000-FGG256T
A3P060-2FG144
A2F500M3G-FG484M
A2F500M3G-1FG256M
A3P1000-2FGG144I
A3P1000-2FG144I
A2F500M3G-FG484I
A3P1000-2FGG484I
A3P1000-2FG144
A2F500M3G-1FGG256IX3
A3P060-FG144I
A3P1000-FGG144M
A3P125-1PQG208I
A3P030-2QNG68
A3P1000-1FGG484T
A3P030-VQ100I
A3P060-TQG144I
A2F500M3G-1FG484
A2F500M3G-1FGG256I
A2F200M3F-FG484I
A3P030-1VQ100I
A3P060-VQG100GW
A2F200M3F-1FGG484
A3P030-2VQG100
A2F500M3G-1FGG484I
A2F200M3F-1CSG288I
A3P1000-1FG484I
A2F500M3G-FGG484M
A3P1000L-1PQG208I
A2F500M3G-CSG288I
A3P1000-2FG484
A2F500M3G-PQ208
A3P125-1FGG144T
A2F500M3G-CSG288
A3P060-FG144T
A3P030-VQG100X52

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A2F200M3F-1FGG484I
A3P060-FGG144I
A2F200M3F-FGG484Q097
A3P030-2VQG100I
A3P1000L-FG256I
A3P1000L-1FG256IX3
A3P030-VQG100PX87
A3P030-VQG100PY10
A2F200M3F-FGG256IQ124
A3P060-TQ144I
A3P1000-FG484I
A3P1000L-FG144I
A3P1000-FGG484
A3P1000-FG256IX277
A2F500M3G-FG256
A3P1000-2FG484M
M2S025TS-FGG484H0268
M2S060TS-FGG676IH0267
APA450-FGG256Q300
APA600-FG256IX94
APA450-FGG256Q301
AFS600-FG484IX94
M2S090T-1FGG676S0027
AGLP030V5-VQG128Z316
A3PE3000L-1FGG484MX130
A3PE3000L-PQG208IX6
M2S060TS-FGG484IH0281
M2GL005-VFG400X456
M2S090TS-1FGG676H0280
MPF300T-1FCG784NE
M2S060TS-FGG676S0025
M2S090-1FG484IX6
A54SX16-PQG208X130
A54SX16-1PQG208IX510
A54SX16-PQG208IX130
M2S005S-TQG144H0289
M2S005S-VFG256H0290
M2S005S-TQG144H0291
A3PE3000-2FG484IX45
M2S025TS-FGG484H0282
M2S025TS-VFG400H0283
M2S010TS-VFG400H0284
AX2000-1FG896IX45
M2S060TS-FGG676S0026
M2S060TS-FGG676H0288
M2S060TS-VFG400IH0278
M2S010TS-VFG400H0277

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

M2S005-VFG400X417
M2S025TS-VFG400X416
APA150-FGG144IX3
MPF300T-1FCG1152EX3
M2S090TS-FGG676IH0275
M2S005S-VFG256H0276
M2S025TS-VFG400IH0285
M2S060TS-VFG400IH0270
M2S060TS-FGG676IH0273
M2S090-FG676I
M2S010-VF256
M2S010-FGG484
P1AFS600-FG256I
M2S090-1FGG484I
M2S060TS-FGG676IH0196
M2S025-FG484I
M2S025-VFG400
M2S090TS-FGG484
M2S150T-1FCG1152
M2S025-VFG256Q273
M2S060TS-FGG676H0160
MPFS250T-FCVG784EX52
M2S060-1FG676
M7AFS600-1FG256I
M2S060TS-FGG676IH0111
M2S025TS-1VFG256T2
U1AFS1500-FG256I
M2S060TS-FGG484IH0193
M2S060T-FCSG325
M2S010T-VF256I
MPF100TLS-FCG484I
M2S150TS-FCG1152H0138
M2S060T-1FGG676S0019
M2S060-FGG484I
M2S050-FGG484I
MPF500T-1FCG784I
M2S060TS-FGG676Q173
M2S010TS-VF400I
M2S025-VFG256Q264
MPF200T-1FCG484I
MPF500T-1FCG784E
M2S050-1FGG484I
MPF200TL-FCG484E
M2S150T-FCG1152X417
M2S060-1FGG676
M2S025T-1VF256I
M2S025-VFG256X416

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M2S025TS-VFG256X416
M2S010TS-VFG400H0153
M2S010TS-VFG256IX416
MPFS250T-1FCVG784E
M2S150TS-1FCG1152H0163
M2S090T-1FCS325
M2S060-FGG484X456
M2S060TS-FGG484IH0081
MPF300T-FCVG484I
M2S060T-1FGG484
M2S150TS-1FCV484
M2S060T-1FG676I
M2S010-TQG144S0018
M2S090TS-FGG676IH0231
M2S060TS-VFG400IH0115
M2S010-1VF256I
M2S025T-FCSG325I
M2S060TS-FGG676H0207
M7AFS600-FG256I
M2S090-FGG676X425
M2S050T-1VFG400
MPF200T-1FCSG536T2
MPFS250TL-FCVG484E
M2S025T-1FGG484
M2S090T-1FGG484I
MPF100TS-FCSG325I
M2S090TS-FGG676IX416
M2S025TS-1VFG256
M2S060TS-VFG400IH0213
M2S010T-FGG484X416
M7A3P1000-FGG144I
MPF100TLS-FCSG325I
M2S025TS-VFG256
M7A3P1000-2FG144
MPFS250T-FCVG784I
M2S060T-1FG484M
M2S150TS-FCG1152H0012
MPF200TS-FCSG536I
MPF300XT-1FCG484E
M2S025-VFG256X456
M2S150-1FC1152
MPFS250T-FCG1152ESF
M2S060TS-FGG484IH0028
M2S010T-1FGG484X417
M2S150TS-FCS536I
M2S025-1VFG256
M2S090TS-FG484X416

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M2S090T-FG676
M2S060TS-FGG484H0110
M2S010T-FGG484XZ82
M2S025TS-1VFG256I
MPF100T-1FCVG484E
M2S010TS-VFG256I
MPF200TL-FCVG484I
M2S060TS-1FGG484I
M2S060-FGG676I
M2S010-VFG256S0017
M7A3P1000-FG484
MPF300TL-FCG484E
M2S050T-1FCS325I
M2S090-FGG484
M2S060T-VF400
M2S150TS-1FCSG536
M2S150TS-FC1152
M2S060TS-FGG484IH0254
M2S010T-FG484
M2S010-FCS325X422
M2S050T-1FG484
M2S025T-FG484I
M2S090TS-FCS325IX417
M2S010-FG484
MPF100T-1FCSG325I
M2S050TS-FG484
M2S025TS-VFG400
P1AFS1500-FGG484
M2S150T-1FCVG484I
M2S060TS-FGG484IH0183
M2S090TS-1FGG484I
M2S050TS-1FGG896I
M2S050TS-FGG484
M2S060-VFG400I
M2S025TS-VFG400IX416
M2S025TS-FGG484H0178
M2S060TS-FGG676IH0031
M2S025-1FCSG325I
MPF200TL-FCG784I
MPF300T-1FCG484E
MPF100TS-1FCSG325I
MPF300T-FCG484EX52
M2S010TS-VFG256H0226
P1AFS1500-2FGG484I
M2S090TS-1FCS325IX417
M2S090TS-FGG676IH0122
M2S060-1VF400I

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

M2S060TS-FGG484I
MPF300T-1FCVG484E
M2S150TS-FCSG536I
M2S060T-FGG676Q128
MPF100T-1FCVG484I
M7A3P1000-1FG484I
M2S050T-1FG896I
M2S060T-1FCSG325
M7A3P1000-2PQG208I
MPF300T-FCG484I
M2S060TS-FGG676S0021
MPF500TS-FCG1152I
MPF500T-1FCG1152I
M2S090-1FG676
MPFS250TL-FCSG536E
MPFS250TS-WAFERLOT
M2S060T-1FCS325I
M2S150T-1FCG1152I
M2S050T-1FG484M
M2S090T-1FGG676S0002
MPF200T-FCG484I
MPF100T-FCG484E
M2S010TS-VFG256H0041
M2S150TS-1FCV484I
M2S025-VFG256Z203
MPF300XT-FCG1152E
M2S150-FCSG536
M2S025T-1FCS325
MPF500T-FCG784I
M2S060T-FGG676
M2S010TS-VFG256H0164
M2S060T-FCSG325I
M2S050-1FG484
MPF300TS-FCG784NI
M2S010-FG484I
M2S090TS-1FGG676H0071
M2S025TS-1VFG400I
M2S025TS-FGG484H0203
M2S060T-FGG484IX416
M2S090T-1FGG676Z246
P1AFS600-2FG484I
M2S025TS-1VF400I
M2S010-1TQG144I
MPFS250T-1FCSG536E
M2S060TS-FGG676IH0180
M2S060-FCS325
M2S090T-FCSG325

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M2S060TS-FGG676H0157
M2S050T-FGG896I
M2S050T-1FG896IX417
MPF300T-FCVG484E
M2S010-FGG484X416
M2S025-FG484
M2S010T-FG484I
M2S090-FGG676
M2S060T-FGG676Q174
M2S025T-FGG484
M2S050T-1FG896ESX423
MPF200T-1FCVG484T2
M2S025TS-FGG484I
P1AFS600-2FG484IX297
M2S150TS-WAFERLOTX417
M2S025-FGG484X486
MPF200T-1FCSG325E
M2S090T-FCS325
MPFS250T-FCG1152EES
M2S150TS-FCG1152X416
M2S060TS-FGG676IH0151
M2S150-FCG1152X486
M2S025TS-VFG400IH0172
M2S150-1FCVG484
M2S010TS-VFG256X486
MPF200T-FCSG536T2
M2S010-TQG144Q184
M2S060TS-1FG676
M2S010T-1VF400I
M2S060-FGG676IX486
M2S025-1VFG256Q168
M7A3P1000-1FGG484
MPF300TLS-FCG484I
M2S060TS-FGG676H0255
M2S090-FG484X416
M2S010TS-1VFG256
M2S050T-1FGG896I
P1AFS600-2FG256I
MPF500TL-FCG784I
MPF100TS-FCVG484I
M2S150-FCS536
MPFS250TLS-FCVG484I
M2S060TS-FGG484X486
M2S090TS-1FG676
MPF300TS-FCSG536I
M2S025TS-1FGG484
M2S050T-1FG896

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

M2S025TS-VF400
M7A3P1000-FGG484I
P1AFS600-2FG256IX297
M2S010TS-VFG256H0150
M2S060TS-1VF400
MPFS250TS-1FCVG784I
M2S060TS-1FG484M
M2S150T-FCS536
M2S050-1FCS325
M2S060TS-FGG676IH0202
M2S050-1FGG484
MPF200T-1FCVG484I
M2S060TS-FGG484IH0181
M2S050TS-FG896I
M2S010TS-VFG256H0087
M2S010-FGG484IX418
MPF100T-FCVG484I
M2S060T-1VFG400
M2S010TS-VFG256H0009
MPF100TL-FCSG325E
MPF500TL-FCG1152I
M2S090TS-FCS325I
M2S025TS-FGG484H0139
M2S090T-1FCSG325Q183
M2S010-1TQG144
M2S060TS-FGG484IH0165
M2S150T-FCV484
M2S090-FG484I
M2S060TS-FGG676Q269
MPF500T-FCG1152T2X52
M2S090T-1FGG484IX418
M2S060TS-VFG400IH0286
A40MX04-PLG44MX507
M2S060TS-FGG676S0022
M2S005S-TQG144H0264
A3P060-VQG100X537
U1AFS250-FG256I
U1AFS600-FG256I
U1AFS250-FGG256
U1AFS600-FGG256
U1AFS1500-FG256
U1AFS600-FG256
U1AFS1500-FGG256
U1AFS600-FGG256I
U1AFS1500-FGG256I
U1AFS250-FG256
U1AFS250-FGG256I

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Field Programmable Gate Array (FPGA) products

AFS600-2FG484IX94
AFS600-FGG256IX94
AFS600-2FGG484IX94
A2F500M3G-FGG484X94
A2F500M3G-FGG484IX94
M2S025TS-FGG484IX416
M2S060TS-FGG676IH0266
A3P1000-FG144MX94
M2S025TS-VFG400IH0265
M2S060TS-FGG676H0287
AGLP030V2-VQG128Z315
M2S060TS-VFG400IH0269
M2S025TS-VFG256S0023
A3P1000-FG144MX3
M2S060T-1FGG676S0024
M2S060TS-FGG676IH0271

CCB 4159 Final Notice: Implement Microchip Part Aging Policy, Recertification and Combination rules, Labels and Packing Changes for selected Microsemi Mixed Signal and ASIC(MSA) products

PCN_LIAL-14RZLJ133
CATALOG_PART_NBR
MSA_Products
LX7720MMF
LX7730LMMF
AA614F-01-1416-G-LF
AA514C-01-2628-GLF
AA583A-06-1024
AA614C-01-1416-GLF
AA561B-06-1024
AA626A-01-2564
AA620A-06-1024
AA560D2-01-2628-GLF
AA627B-01-2564
AA626A1-01-2564

CCB 4159
Pre and Post Change Summary
PCN#: LIAL-14RZLJ133



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Change Summary

Part Aging: Change part aging policy to comply with Microchip standard.

Recertification Program: Change recertification program to Microchip standard for commercial products.

Combination Rule: Change combination rule for MSA products.

Label Change

- **Reel/Bag/Inner Carton Label:** Change to Microchip standard inner label
- **Outer Carton Label:** Change to Microchip standard outer carton label
- **Device Code label:** Change company name to Microchip
- **MSL Caution label:** Change label template to Microchip standard
- **ESD Warning label on MBB:** Affix ESD Warning Label on the MBB for class zero product only. For others device refer the ESD caution symbol that pre-printed on the MBB.
- **Inner Carton ESD Sealing Label:** Remove ESD Sealing label
- **MSID Label:** Affix MSID label or pre-printed MSID symbol on the inner carton for moisture sensitive devices.

Change Summary

Packing Material Change

- **Tube Drawing:** Change tube drawing for MTAI final test
- **HIC Card:** Change to 3 dots
- **Desiccant:** Change to 1unit x 2 pouches
- **MBB:** Change dimension to Microchip standard MBB with pre-printed MSL Caution label
- **Inner Carton:** Change dimension and printing to Microchip standard inner carton
- **Outer Carton:** Change dimension to Microchip standard inner carton

Packing Method Change

- **Tray Strapping:** 3 width and 1 length (Longer side)
- **Tube Stacking:** Implement Microchip Standard Tube Stacking
- **Plug color:** 2 types of plug color (Black-Black and White-Black)

CoC Document Change

- Change CoC format to Microchip standard CoC document

Change of Re-Certification Program

Part Aging

PRE-CHANGE

Plastic Package:

Part with a date code up to 4 years aging can be shipped. Part with a date code older than 2 years need to recertified prior to shipment.

Hermetic packages:

No part aging restriction for the shipment.
Part with a date code older than 2 years need to recertified prior to shipment.

POST CHANGE

Product Family	Policy
All Microchip product with exception to those listed below.	Microchip may ship product for up to 24 months from the marked date code. Thereafter, Microchip has a process in place to recertify products, which may include one or more of the following: inspections, retest, rescan, and re-packing of parts, allowing product to be shipped for an additional 24 months. A Certificate of Conformance (C of C) will be included with the shipment.
Systems and Module Products	No age limits
Military and Space Grade Devices	Recertification requirements will vary depending on product-line or may be performed upon customer request. (Note that in some cases, this may incur an additional charge).

Note: For Microchip Direct, Microchip may ship product up to 5 years from the mark date code and no re-certification process applied.

For more information related to Microchip's part aging strategy, please visit the following link on our website: [Component Age Policy](#)

Recertification Program

PRE-CHANGE

Plastic Package:

Part with a date code older than 2 years need to reading HIC If the HIC showing there is penetration of moisture onto MBB so re-bake and re-pack are required.

Hermetic packages:

Part with a date code older than 2 years will be recertified by one or more of the following: re-test, solderability test.

POST CHANGE

Commercial products:

Parts older than 24 months (2 years) old will be recertified prior shipment.

It may include one or more of the following: inspections, retest, rescanning, re-baking and repacking of parts.

Combination Rule

PRE-CHANGE

- 1 Date code
- 1 Country of Origin

POST CHANGE

Commercial products:

For FPGA:

- No change on combination rule.

For MSA:

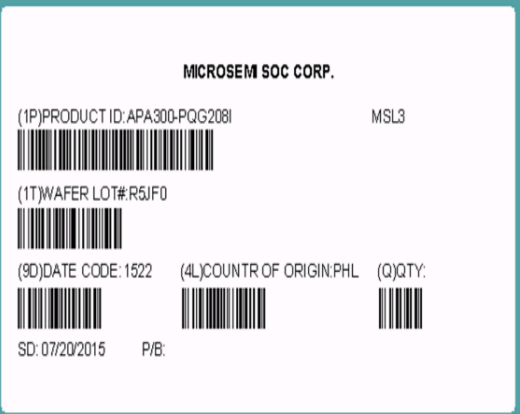
- 1 Device
- 3 Date codes
- No limit to number of production lots follow date code combination rule.
- 1 Assembly Site
- 1 Test Site
- 1 Mask Revision

Labels change

Reel/Bag Label

PRE-CHANGE

MSCS (US) / JSI (HK)



MTHAI (TH)



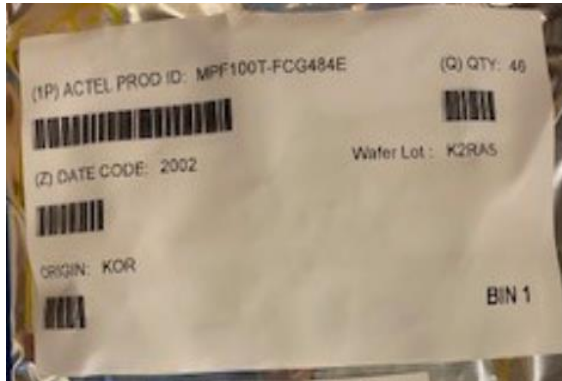
UTAC DG (CN)



Ardentec (TW)



UTAC (SG)

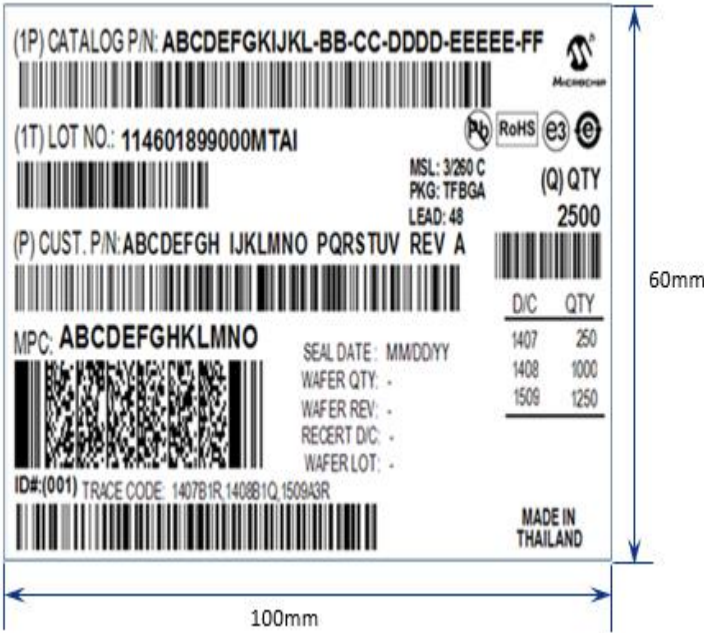


MRC (US)



POST CHANGE

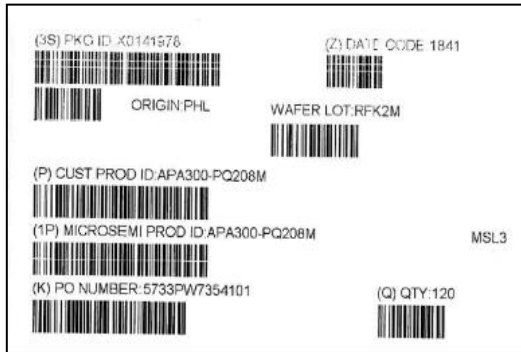
For Commercial products



Inner Carton Label

PRE-CHANGE

MSCS (US) / JSI (HK)



MTHAI (TH)



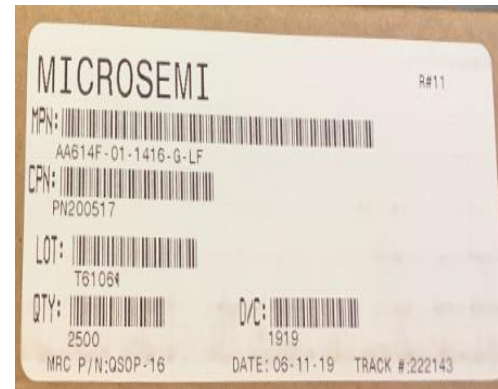
UTAC DG (CN)



Ardentec (TW)



UTAC (SG)

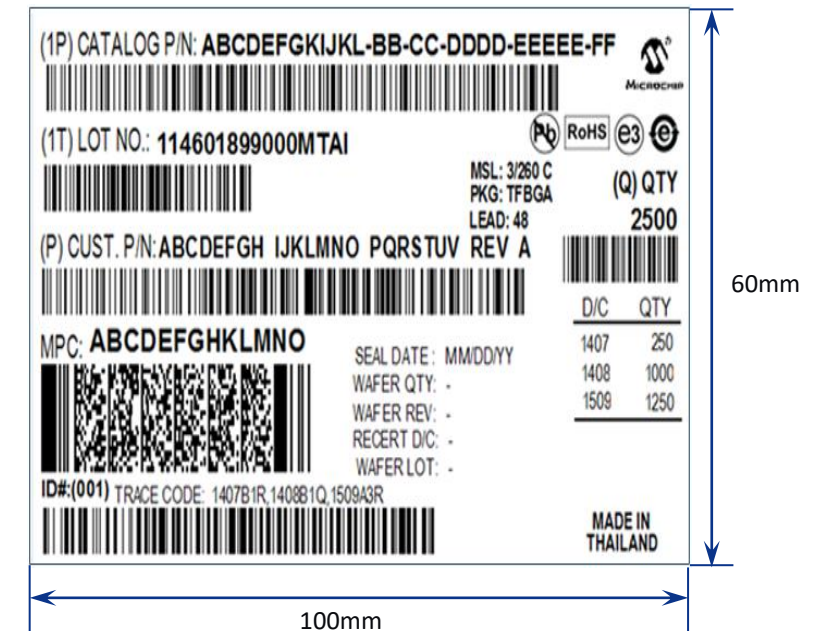


MRC (US)



POST CHANGE

For Commercial products



Outer Carton Label

PRE-CHANGE

Microsemi SoC Corp. 3850 North First Street San Jose CA 95134-1702 US	Ship To: ARROW - NAC A/T-PRIMARY DISTRIBUTION CENTER
RENO NV 89511 USA	
(5S) PKGID: X0141978 	
(K) TRANSID: 5733PW7354101 	(Z) SO NUMBER: S00397285
(P) CUSTOMER PROD. ID: APA300-PQ208M 	
PACKAGE COUNT 1 OF 1	

POST CHANGE

SHIP TO: FUTURE ELECTRONICS ASIA PACIFIC DISTRIBUTION CENTRE 19 LOYANG WAY #01-08/09/10 CHANGI LOGISTICS SINGAPORE	
B – SG – FT4 – S11817205 	
Cust. P/N: 1072574 	
Catalog P/N: RN4870 – V/RM118 	
PO#: CBXK4Y 	SO#: 21170048/2 Qty: 968
	Singapore 12 – 07 – 2019 (mm – dd – yyyy)
Carton 1 of 1 3.6 kgs	

152mm

102mm

Outer Carton Label

PRE-CHANGE			POST CHANGE			Gap	Change
Field Name / Symbol	Human Readable	Barcode	Field Name / Symbol	Human Readable	Barcode		
Company name and Address	Yes	No	-	-	-	Yes	Remove
SHIP TO	Yes	No	SHIP TO	Yes	No	No	-
(5S) PKG ID	Yes	Yes	-	-	-	Yes	Remove
(K) TRANSID	Yes	Yes	-	-	-	Yes	Remove
(Z) SO NUMBER	Yes	Yes	SO#	Yes	Yes	No	-
(P) CUSTOMER PRO ID	Yes	Yes	Cust P/N	Yes	Yes	No	-
PKG COUNT	Yes	No	No of carton	Yes	No	No	-
-	-	-	Shipment No	Yes	Yes	Yes	Add
-	-	-	PO#	Yes	Yes	Yes	Add
-	-	-	Catalog P/N	Yes	Yes	Yes	Add
-	-	-	Qty	Yes	Yes	Yes	Add
-	-	-	(mm-dd-yyyy)	Yes	No	Yes	Add

Outer Carton Label

PRE-CHANGE			POST CHANGE			Gap	Change
Field Name / Symbol	Human Readable	Barcode	Field Name / Symbol	Human Readable	Barcode		
-	-	-	eCAT Symbol	Yes	No	Yes	Add*
-	-	-	Pb Free Symbol	Yes	No	Yes	Add*
-	-	-	RoHS Symbol	Yes	No	Yes	Add*
-	-	-	China RoHS Symbol	Yes	No	Yes	Add*
-	-	-	Ship Number	Yes	Yes	Yes	Add
-	-	-	SO#	Yes	Yes	Yes	Add
-	-	-	2D barcode	No	Yes	Yes	Add
-	-	-	Gross Weight	Yes	No	Yes	Add

*Compliance symbol is applicable for commercial parts only.

Device Code Label

PRE-CHANGE

Kyocera

MICROSEMI

Microsemi P/N : _____
SMD/Customer P/N : _____
Wafer Lot # : _____
Date Code : _____
Serial # : _____
Qty : _____

MICROSEMI

Microsemi P/N : _____
Wafer Lot # : _____
Date Code : _____
Serial # : _____
Qty : _____

MICROSEMI

Microsemi P/N : _____
SMD/Customer P/N : _____
Wafer Lot # : _____
Date Code : _____
Qty : _____

MICROSEMI

Microsemi P/N : _____
Wafer Lot # : _____
Date Code : _____
Qty : _____

POST CHANGE

Change the company name on the label from
“MICROSEMI” to “MICROCHIP”.

MICROCHIP

Microchip P/N : _____
SMD/Customer P/N : _____
Wafer Lot # : _____
Date Code : _____
Serial # : _____
Qty : _____

MICROCHIP

Microchip P/N : _____
Wafer Lot # : _____
Date Code : _____
Serial # : _____
Qty : _____

MICROCHIP

Microchip P/N : _____
SMD/Customer P/N : _____
Wafer Lot # : _____
Date Code : _____
Qty : _____

MICROCHIP

Microchip P/N : _____
Wafer Lot # : _____
Date Code : _____
Qty : _____

MSL Caution Label

PRE-CHANGE

SnPb



PACKAGE with SnPb Terminals

CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL

If blank, see device
barcode label

1.Shelf life in sealed bag: 24 months at < 40°C and < 90% relative humidity (RH)

2.Peak package body temperature: 220°C or 235°C depending on package thickness and volume per IPC/JEDEC J-STD-020

3.After this bag is opened, devices that will be subjected to reflow solder or other high temperature process must be:
Moisture Sensitivity Level (MSL): 3
a) Mounted within 168 hours at factory ambient of ≤ 30°C/60% RH, or
b) Stored per J-STD-033
Moisture Sensitivity Level (MSL): 4
c) Mounted within 72 hours at factory ambient of ≤ 30°C/60% RH, or
d) Stored per J-STD-033

4.Device require bake before mounting, if:
a) Humidity card is >20% when read at 23°C ± 5°C or
b) 3a or 3b (for MSL 3), 3c or 3d (for MSL 4) are not met

5.If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure

Bag Seal Date: _____

Note: Level and Device body temperature defined by IPC/JEDEC J-STD-020

1-04-11313 Figure 3a

LEADED LEAD-FREE



LEADED LEAD-FREE PACKAGE

CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL

If blank, see device
barcode label

1.Shelf life in sealed bag: 24 months at < 40°C and < 90% relative humidity (RH)

2.Peak package body temperature: 245°C or 250°C or 260°C depending on package thickness and volume per IPC/JEDEC J-STD-020

3.After this bag is opened, devices that will be subjected to reflow solder or other high temperature process must be:
Moisture Sensitivity Level (MSL): 3
a) Mounted within 168 hours at factory ambient of ≤ 30°C/60% RH, or
b) Stored per J-STD-033
Moisture Sensitivity Level (MSL): 4
c) Mounted within 72 hours at factory ambient of ≤ 30°C/60% RH, or
d) Stored per J-STD-033

4.Device require bake before mounting, if:
a) Humidity card is >20% when read at 23°C ± 5°C or
b) 3a or 3b (for MSL 3), 3c or 3d (for MSL 4) are not met

5.If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure

Bag Seal Date: _____

Note: Level and Device body temperature defined by IPC/JEDEC J-STD-020

1-04-11313 Figure 3b

ARRAY LEAD-FREE



ARRAY LEAD-FREE PACKAGE

CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL

If blank, see device
barcode label

1.Shelf life in sealed bag: 24 months at < 40°C and < 90% relative humidity (RH)

2.Peak package body temperature: 245°C or 250°C or 260°C depending on package thickness and volume per IPC/JEDEC J-STD-020

3.After this bag is opened, devices that will be subjected to reflow solder or other high temperature process must be:
Moisture Sensitivity Level (MSL): 3
a) Mounted within 168 hours at factory ambient of ≤ 30°C/60% RH, or
b) Stored per J-STD-033
Moisture Sensitivity Level (MSL): 4
c) Mounted within 72 hours at factory ambient of ≤ 30°C/60% RH, or
d) Stored per J-STD-033

4.Device require bake before mounting, if:
a) Humidity card is >20% when read at 23°C ± 5°C or
b) 3a or 3b (for MSL 3), 3c or 3d (for MSL 4) are not met

5.If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure

Bag Seal Date: _____

Note: Level and Device body temperature defined by IPC/JEDEC J-STD-020

1-04-11313 Figure 3c

POST CHANGE



CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

For MSL
see
barcode
label

1. Calculated shelf life in sealed bag: 24 months at < 40°C and < 90% relative humidity (RH).

2. Peak Package body temperature: _____ °C
(If blank, see adjacent barcode label)

3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be:
a) Mounted within the time corresponding the MSL at factory conditions of ≤ 30°C/ 60% RH:
LEVEL 2 - 1 year LEVEL 4 - 72 hours
LEVEL 2a - 4 weeks LEVEL 5 - 48 hours
LEVEL 3 - 168 hours LEVEL 5a - 24 hours
LEVEL 6 - Mandatory bake before use. After bake, must be reflowed within 6 hours.
b) Stored per IPC/JEDEC J-STD-033.

4. Devices require baking, before mounting if:
a) Humidity Indicator Card reads >10% for level 2a - 5a devices or >60% for level 2 devices when read at 23± 5°C
b) 3a or 3b not met.

5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure.

Bag Seal Date: _____
(If blank, see date code on barcode label)

Note: LEVEL and Body temperature defined by IPC/JEDEC J-STD-020

ESD Warning Label for MBB

PRE-CHANGE

Affix ESD Warning Label on the MBB

Class Zero



Others device



POST CHANGE

Affix ESD Warning Label on the MBB for class zero product only. For others device refer the ESD caution symbol that pre-printed on the MBB.

Class Zero

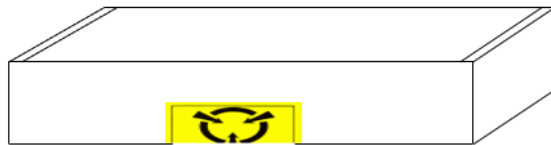


Others device



ESD Sealing Label for Inner carton

PRE-CHANGE



ESD Sealing Label

POST CHANGE

Remove ESD Sealing label due to the Microchip standard inner box have pre-printed ESD caution symbol.

Moisture Sensitivity Identification label (MSID Label)

PRE-CHANGE

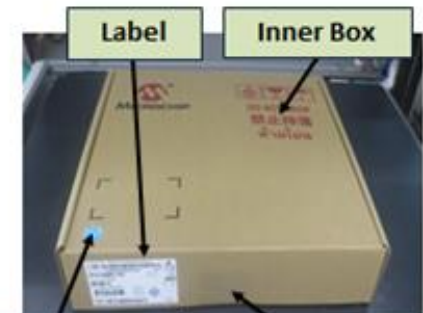
Not apply MSID label on the inner carton.

POST CHANGE

Affix MSID label or pre-printed MSID symbol on the inner carton for moisture sensitive devices.



Moisture Sensitive Label

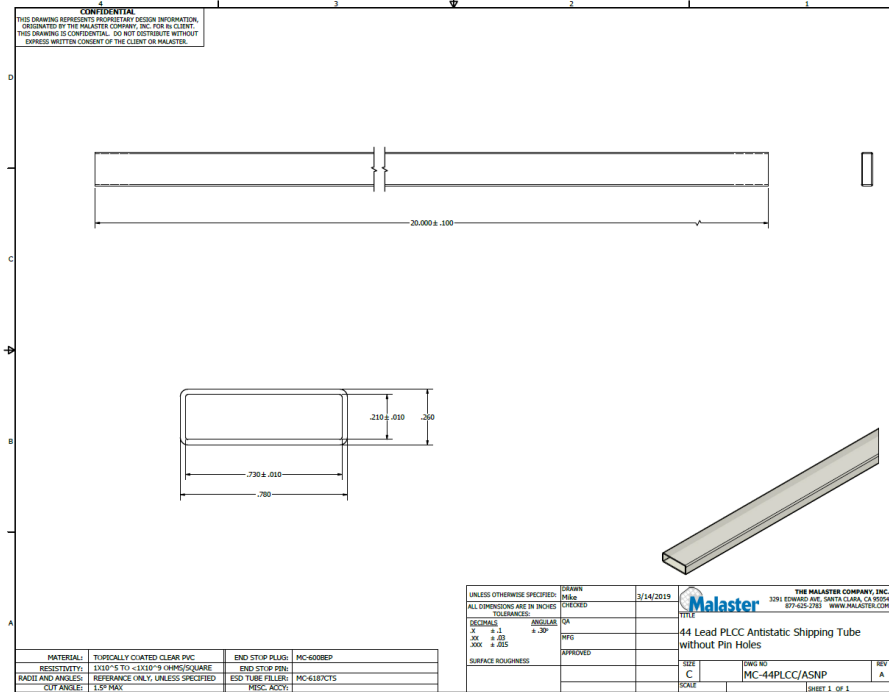


Transparent Tape

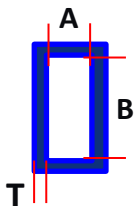
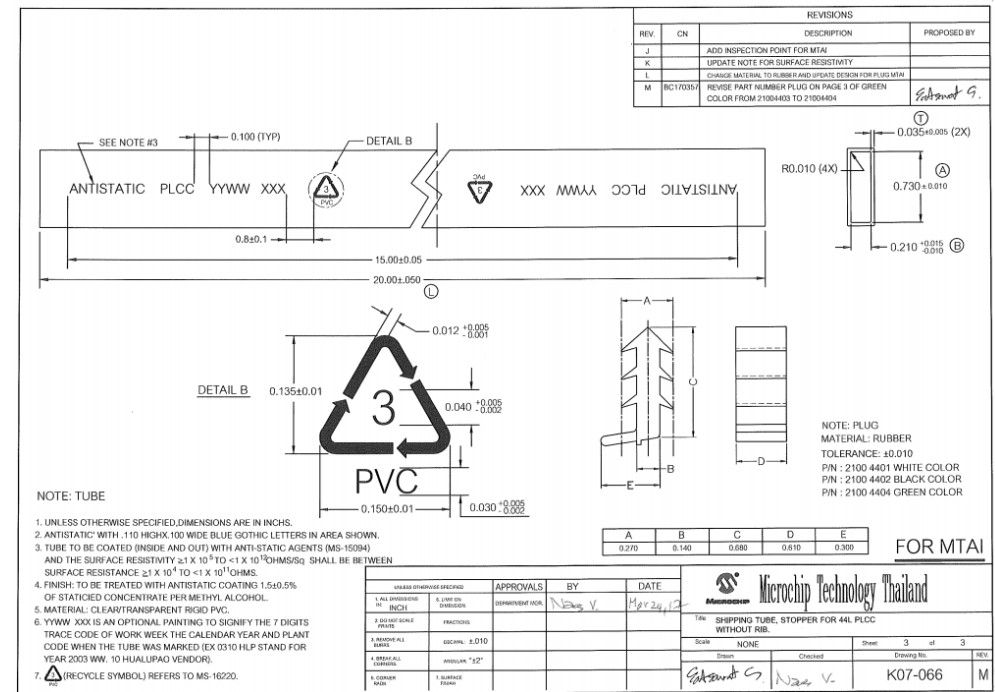
Packing Material Change

44L PLCC Tube Drawing

PRE- CHANGE (FPGA (San Jose))



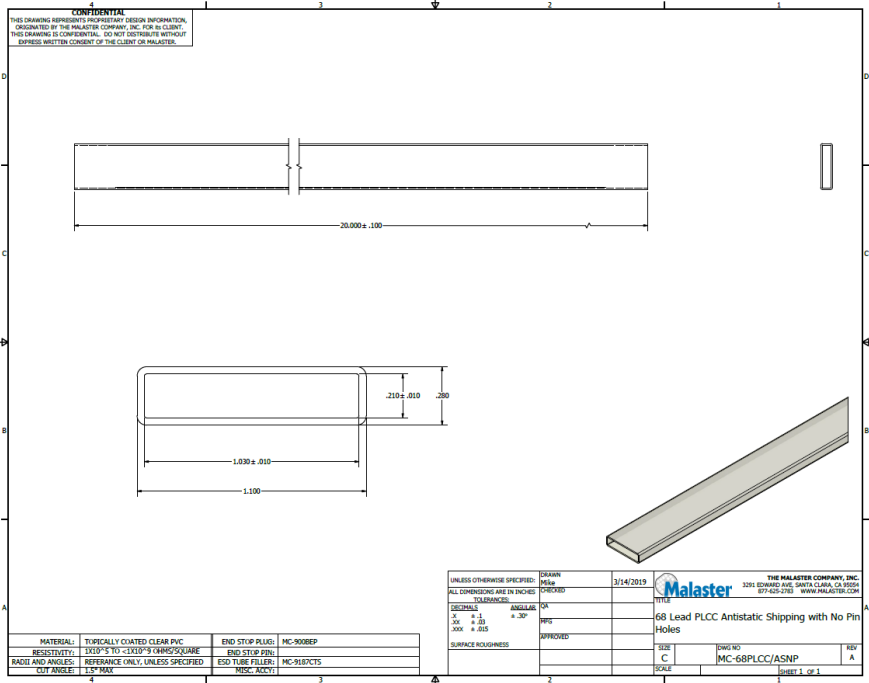
POST CHANGE -(MTAI)



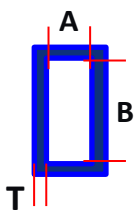
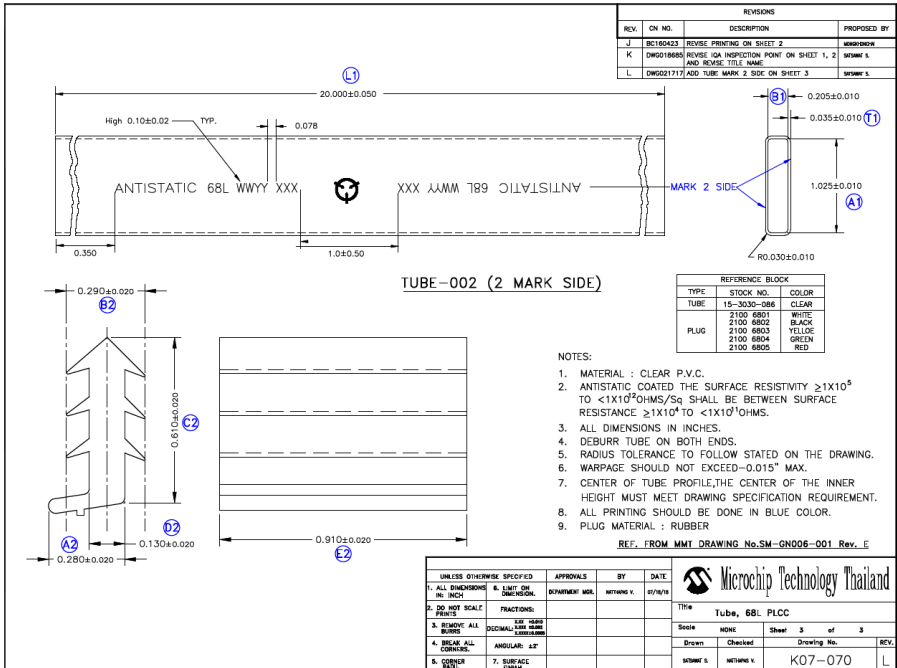
LOCATION	Length (in)	A (in)	B (in)	Thickness (in)	Tube Color	Units/Tube
FPGA	20.00 +/-0.100	0.210 +/-0.010	0.730 +/- 0.010	0.025	Clear	27
MTAI	20.00 +/-0.050	0.210 +0.015/-0.010	0.730 +/-0.010	0.035	Clear	27

68L PLCC Tube Drawing

PRE- CHANGE (FPGA (San Jose)



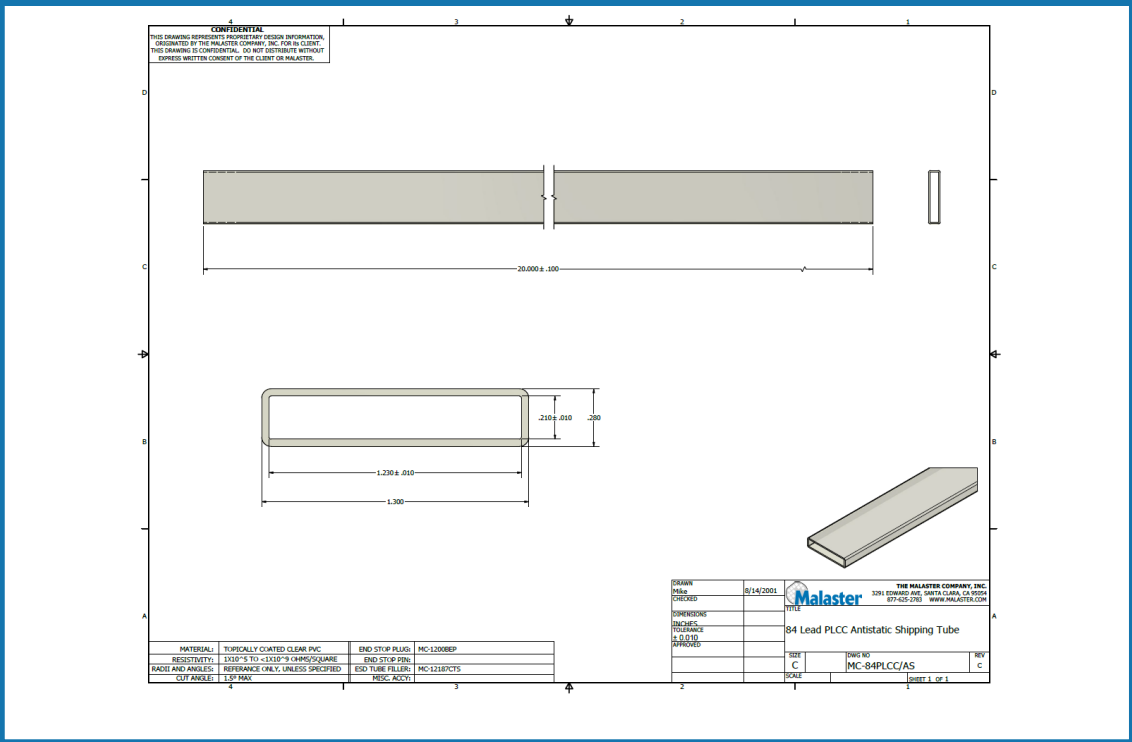
POST CHANGE – (MTAI)



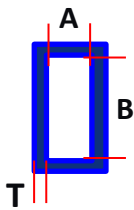
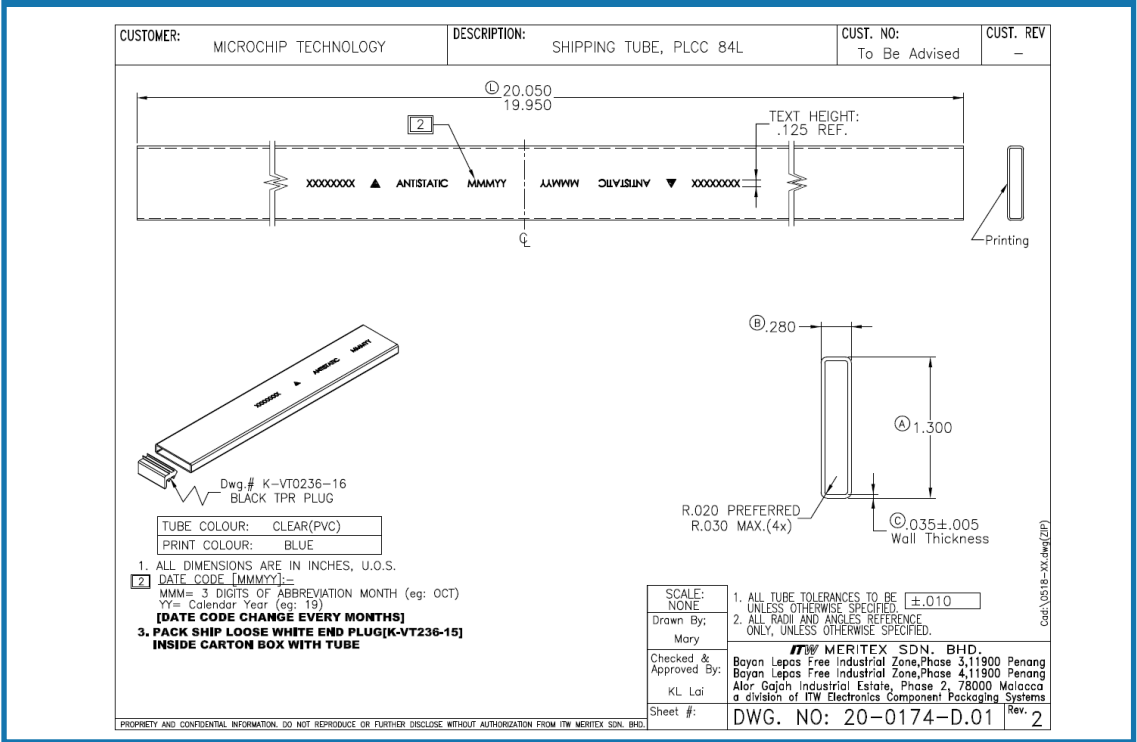
LOCATION	Length (in)	A (in)	B (in)	Thickness (in)	Tube Color	Units/Tube
FPGA	20.00 +/-0.100	0.210 +/-0.010	1.030 +/-0.010	0.035	Clear	19
MTAI	20.00 +/-0.050	0.205 +/-0.010	1.025 +/-0.010	0.035	Clear	19

84L PLCC Tube Drawing

PRE- CHANGE (FPGA (San Jose)



POST CHANGE – (MTAI)



LOCATION	Length (in)	A (in)	B (in)	Thickness (in)	Tube Color	Units/Tube
FPGA	20.00 +/-0.100	0.210 +/-0.010	1.230 +/-0.010	0.035	Clear	16
MTAI	20.00 +/-0.050	0.210 +/- 0.010	1.230 +/-0.010	0.035	Clear	16

Humidity Indicator Card (HIC)

PRE-CHANGE



- 6 Dots (10%, 20%, 30%, 40%, 50%, 60%)
- Cobalt Free

POST CHANGE



- 3 Dots (5%, 10%, 60%)
- Cobalt Free

Desiccant

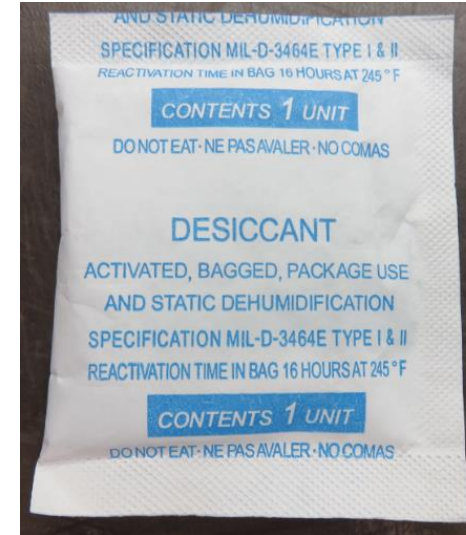
PRE-CHANGE



Compliant with Mil-D-3464, TYPE I and II

Packing Media	Amount of Desiccant per one MBB
Tray	2 Units (2 Units x 1 pouch)
Tube	2 Units (2 Units x 1 pouch)
13" TnR	2 Units (2 Units x 1 pouch)

POST CHANGE



Compliant with Mil-D-3464, TYPE I and II

Packing Media	Amount of Desiccant per one MBB
Tray	2 Units (1 Unit X 2 pouches)
Tube	2 Units (1 Unit X 2 pouches)
13" TnR	2 Units (1 Unit X 2 pouches)

MBB for Tray

PRE-CHANGE



Dimension

254mm x 508mm

POST CHANGE



Seal line
is optional

Preprinted:

- ESD Caution symbol
- MSL Caution label

Dimension

280mm x 560mm

MBB for Tube (PLCC)

PRE-CHANGE



Dimension

254mm x 762mm

POST CHANGE



Dimension

160mm x 650mm

Preprinted:

- ESD Caution symbol
- MSL Caution label

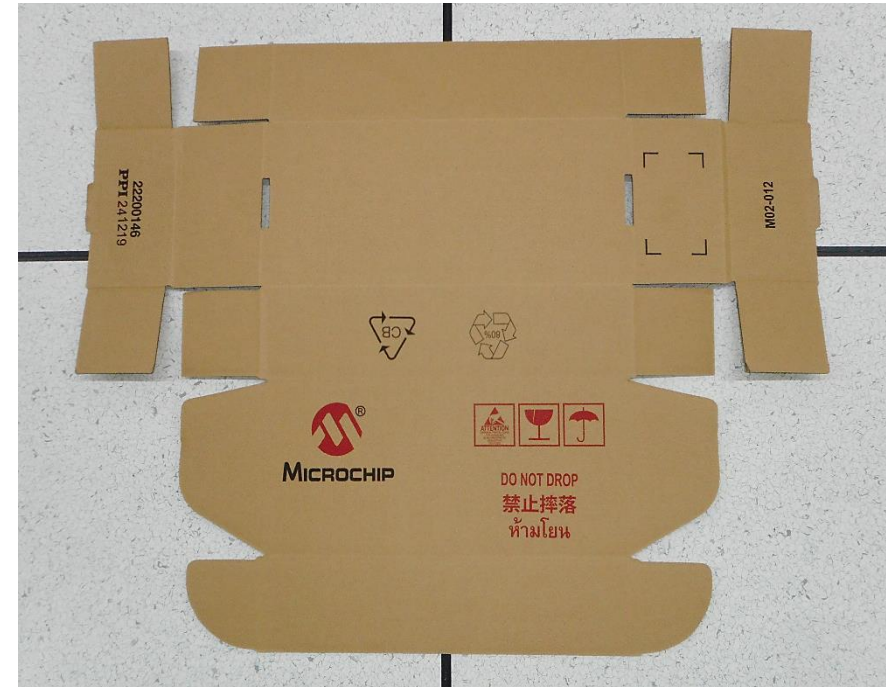
Inner carton for Tray

PRE-CHANGE



Drawing Number	Dimension (Cm)
QFPI	16.83 x 35.9 x 9.53

POST CHANGE



Drawing Number	Dimension (Cm)
M02-012	16.2x37.1x8.8

Outer carton for Tray

PRE-CHANGE

Drawing No	Dimension W x L x H (cm)	Inner : Outer
QFP1	18.3X38.6X10.6	1 : 1
QFP2	36.9X38.6X10.6	2 : 1
QFP4	36.9X38.6X20.7	4 : 1

POST CHANGE

Drawing No	Dimension W x L x H (cm)	Inner : Outer
M01-115	17.9x39.3 x11.4	1 : 1
M01-044 (SM)	37.0x38.0x11.0	2 : 1
M01-045 (S4)	37.0x38.0x22.5	4 : 1
M01-046 (S5)	37.0x39.0x39.0	8 : 1

Inner carton for Tube (PLCC)

PRE-CHANGE



Part Number	Dimension (Cm)
PLCI	14.3 x 56.5 x 7.0

POST CHANGE



Part Number	Dimension (Cm)
M02-010	12.9x56.5x8

Outer carton for Tube (PLCC)

PRE-CHANGE

Drawing No	Dimension W x L x H (cm)	Inner : Outer
PLC1	15.7X59.1X7.6	1 : 1
PLC2	31.6X59.1X8.0	2 : 1
PLC4	31.6X59.1X15.7	4 : 1

POST CHANGE

Drawing No	Dimension W x L x H (cm)	Inner : Outer
M01-022 (PP)	15.5x62.0x14.0	1 : 1
M01-028 (C4)	28x63.5x11	2 : 1
M01-029 (C6)	28x63.5x15.5	3 : 1
M01-030 (C8)	28x63.5x20	4 : 1
M01-040 (S6)	43x59x19	6 : 1

Outer carton for 13" TnR

PRE-CHANGE

No standard outer carton for 13" TnR

POST CHANGE

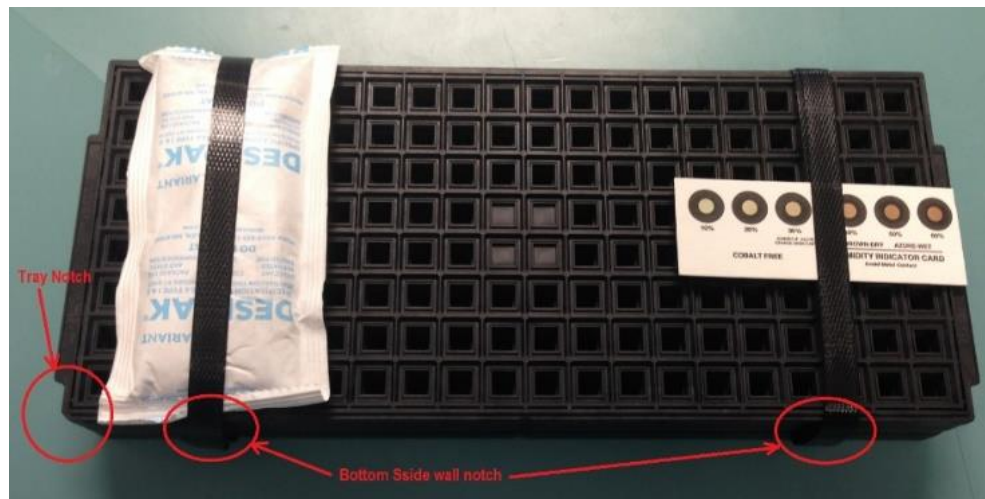
Drawing No	Dimension W x L x H (cm)	Inner : Outer
M01-044 (SM)	37.0x38.0x11.0	1 : 1
M01-045 (S4)	37.0x38.0x22.5	3 : 1
M01-046 (S5)	37.0x39.0x39.0	6 : 1
M01-047 (S3)	42.0x66.0x39.0	11 : 1

Packing Method Change

Tray Strapping Method

PRE-CHANGE

2 width tray strapping



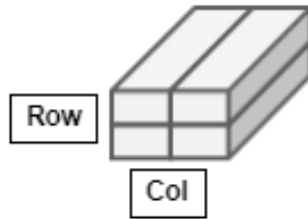
POST CHANGE

3 width and 1 length (Longer side) tray strapping



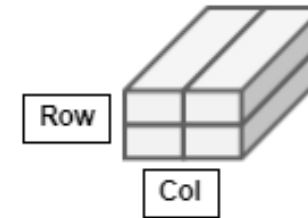
Tube Stacking

PRE-CHANGE



Package	Quantity TUBE per Bundle					
	1-8	9-16	17-24	25-32	33-40	41-48
PLCC 44L	1 col	2 col	3 col	4 col	5 col	6 col
PLCC 68L	1 col	2 col	3 col	4 col	5 col	-
PLCC 84L	1 col	2 col	3 col	4 col	-	-

POST CHANGE



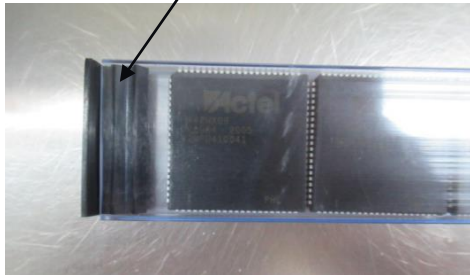
Package	Quantity TUBE per Bundle		
	20	15	10
PLCC 44L	4 col	-	-
PLCC 68L	-	3 col	-
PLCC 84L	-	-	3 col

Plug Color

PRE-CHANGE



Using Black Plug for both sides



POST CHANGE



White Plug to identify
Pin1 Side

Black Plug

CoC document

PRE-CHANGE

Microsemi format with Microsemi logo

POST CHANGE

Microchip format with Microchip logo

END

Frequently Asked Questions (FAQ)

Contacting Microchip: Microchip has Sales Offices Worldwide. You have received this correspondence from a Microchip Inside Sales Representative, please continue to work with him/her to guide you through the transition. Should you need to find your local office, please visit our website at: <https://www.microchip.com/salesdirectory>. Also note that your current Microsemi contacts have moved to the Microchip email system therefore their email address has changed to firstname.lastname@microchip.com. You may also contact the following individuals within your geography:

Americas: Rozita Yajadda (Rozita.yajadda@microchip.com)

Europe: Mary Wilson (Mary.Wilson@microchip.com)

APAC: Nora Lee (Nora.Lee@microchip.com)

World Wide Distribution: Jennifer Innella (Jennifer.Innella@microchip.com)

EM EA Distribution: Jane Afshar (Jane.Afshar@microchip.com)

Asia Distribution: Derek Chan (Derek.Chan@microchip.com)

Open Direct Orders with Microsemi: Open Orders for affected parts will be transferred to the Microchip Systems on or about February 15, 2021. Customers will be contacted by local sales offices prior to the transfer to ensure a smooth transition. All orders will be transferred in US\$ currency. The details of the currency conversion will be outlined by your local ISR contacts closer to the transfer date.

MOQ: Orders must be placed in multiples of tray, tube, bag, reel size, custom pack or pallet. Additionally, there may be a Purchase Order/Order Line minimum. Existing Microsemi orders being converted to Microchip orders will be subject to the Microchip base quantity multiples and Microchip Purchase Order/Order Line item minimum.

Should changes be required when migrating open backlog, each customer will be notified with full details by your local Inside Sales contact.

Order Acknowledgement: Microchip provides Acknowledgements for all new Direct orders entered and for each change made to an existing Direct order. This document is typically provided via email. Once an existing order is transferred from the Microsemi system to the Microchip system an Order Acknowledgement will then be sent. Customers or Distributors that have an EDI connection will receive either an 855 acknowledgement (US & Asia) or ORDRSP acknowledgement (Europe) via EDI.

Cancel/Reschedule:

Microchip can advise reschedule/cancellation terms upon request. These terms will be stated on the order acknowledgment upon confirming the Purchase Order.

Advanced Ship Notice (ASN): When placing a Direct Order with Microchip, customers can elect to receive an Advance Ship Notice. This document advises that your order is prepared to ship to the location identified on your Purchase Order. This option will be discussed with you by your local Microchip Contact prior to the go live date in February.

Managing Product Requirements during the Transition: The Microsemi order entry and shipment systems for items identified in this information packet will transition to Microchip systems on or about February 15, 2021. Until that time, please continue to manage your product requirements as you do today. If changes have been made with your local Representative Sales Office, please see the Microchip section **Contacting Microchip** from above. Microchip will have a 'Quiet Period' that will occur for several days surrounding the final integration so that we can import all existing Purchase Orders into our system. During that time, we will not Accept New Orders, Modify/Cancel Existing Orders, or Ship Product. Please contact your local sales office with any questions or concerns.

Shipping and Invoicing after the transition: After February 15, 2021, all products identified in this phase will be shipped and invoiced from Microchip. Please alert your **Receiving** and **Accounts Payable** departments of this change; in our experience, some clients must cancel existing backlog and then re-issue a new P.O. to Microchip. Over the coming weeks Microchip will contact you to discuss all your needs to ensure there is no interruption in your supply chain.

Vendor/Supplier Code: If your system requires a new code to support order placement to Microchip and receive in Microchip shipments, please arrange as needed.

Shipping Labels, Boxes and Packing Methods: Labels, Boxes and Packing methods will be standardized to Microchip's current processes. Special shipping labels for special products such as programming products, special testing, etc. will adhere to the standard Microchip process over time. See attached Standard Microchip Label Specification and copy of the label for modules for your reference.

Lots, Trace Codes, Date Codes, Part Aging, and Shelf Life: Standard Microchip methods for combining production lots, trace codes and date codes into tubes, trays, and reel media will apply as well as standard Microchip Part Aging and Shelf Life Policies. Microchip quality documents and policies including part aging policy are found on our website. <https://www.microchip.com/quality>

Payment Terms: Standard payment terms are N30

Terms & Conditions: Microchip Sales are subject to the company's Terms and Conditions ("T&C"). Microchip T&C does differ slightly depending on whether the customer is in the European Union or elsewhere in the world and whether they are purchasing Direct or through microchipDIRECT. Microchip Terms and Conditions are attached.

Product/Process Change Notification (PCN) after the transition: The standard Microchip methods for notifying customers about product changes that include PCNs and End of Life (EOL) notices will begin to apply (please note that this process will integrate over multiple phases of select products during this period). Part of the standard method includes a PCN email service that we expect to be available to select Microsemi customer/product combinations soon after each integration of select products. Once available, customers who wish to receive PCN's via email are expected to register for PCN email service on our PCN web page. Information about how and when to register will be provided in separate integration PCNs as the products you are interested in are phased in. The Microsemi PCN system will continue to be used in conjunction with a partial Microchip PCN system until the full Microchip PCN system can support Microsemi products soon after each group of products have been integrated (review how in the Microsemi Integration PCN's below). The Microsemi PCN system supporting integrated groups of products will be terminated soon after the transition to Microchip systems has completed for each product grouping. Information about Microchip's PCN system can be found at this link: <https://www.microchip.com/pcn>

Microsemi Integration PCN's: Until each product grouping has been integrated into Microchip's PCN system all PCN's related to the integration will be distributed using the Microsemi PCN system and can also be found at this Microchip website: <https://www.microchip.com/pcn>. This same PCN distribution process will be used to inform customers to register for the Microchip PCN email distribution process soon after each product grouping has been integrated. Additional integration PCNs for Microsemi products may be issued for the following changes; ordering part numbering convention, shipping labels, shipping boxes, packing methods, part aging/shelf life, top marking, manufacturing site, Bill of Material (BOM), Silicon, and EOL among others.

RoHS Information: Can be found on the Microchip Website under RoHS PB Free, RoHS Device Search. An email will be generated from the system with all of the pertinent information regarding the device search. <http://www.microchip.com/wwwproducts/Rohs/>